#### Technical Data

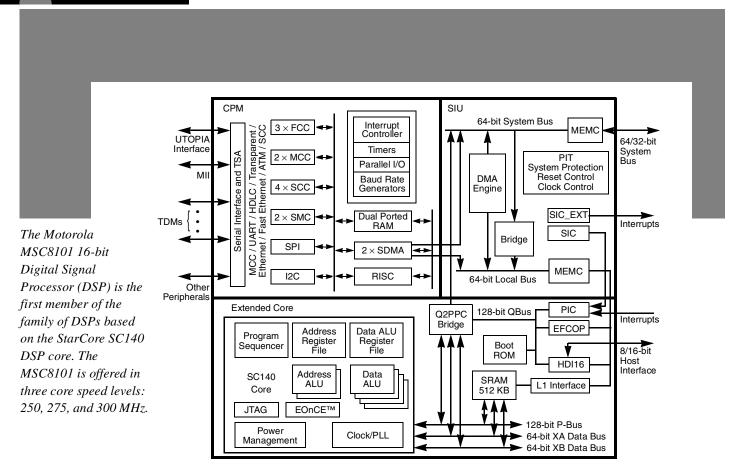
MSC8101/D Rev. 15, 5/2004

Networking Digital Signal Processor

(mask set 2K87M)







### What's New?

Rev. 15 includes the following changes:

- All references to mask set 2K42A were removed.
- Table 2-3 was updated to reflect the latest thermal characteristics.
- Table 2-4 was updated.
- Ordering Information was updated.

Figure 1. MSC8101 Block Diagram

The Motorola MSC8101 DSP is a very versatile device that integrates the high-performance SC140 four-ALU (Arithmetic Logic Unit) DSP core along with 512 KB of internal memory, a Communications Processor Module (CPM), a 64-bit bus, a very flexible System Integration Unit (SIU), and a 16-channel DMA engine on a single device. With its four-ALU core, the MSC8101 can execute up to four multiply-accumulate (MAC) operations in a single clock cycle. The MSC8101 CPM is a 32-bit RISC-based communications protocol engine that can network to Time-Division Multiplexed (TDM) highways, Ethernet, and

Asynchronous Transfer mode (ATM) backbones. The MSC8101 60x-compatible bus interface facilitates its connection to multi-master system architectures. The very large internal memory, 512 KB, reduces the need for external program and data memories. The MSC8101 offers 1500 DSP MMACS (1200 core and 300 EFCOP) performance using an internal 300 MHz clock with a 1.6 V core and independent 3.3 V input/output (I/O). **Figure 1** shows a block diagram of the MSC8101 processor.

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### **Data Sheet Conventions**

pin and pin-out Although the device package does not have pins, the term pins and pin-out are used for convenience and indicate

specific signal locations within the ball-grid array.

OVERBAR

Used to indicate a signal that is active when pulled low (For example, the RESET pin is active when low.)

"asserted"

Means that a high true (active high) signal is high or that a low true (active low) signal is low

"deasserted" Means that a high true (active high) signal is low or that a low true (active low) signal is high

Examples:	Signal/Symbol	Logic State	Signal State	Voltage
	PIN	True	Asserted	$V_{IL}/V_{OL}$
	PIN	False	Deasserted	$V_{IH}/V_{OH}$
	PIN	True	Asserted	$V_{IH}/V_{OH}$
	PIN	False	Deasserted	$V_{IL}/V_{OL}$

Note: Values for  $V_{IL}$ ,  $V_{OL}$ ,  $V_{IH}$ , and  $V_{OH}$  are defined by individual product specifications.

### **MSC8101 Features**

- SC140 Core
  - Architecture optimized for efficient C/C++ code compilation
  - Four 16-bit ALUs and two 32-bit AGUs
  - 1200 DSP MMACS running at 300 MHz
  - Very low power dissipation
  - Variable-Length Execution Set (VLES) execution model
  - JTAG/Enhanced OnCE debug port
- Communications Processor Module (CPM)
  - Programmable protocol machine using a 32-bit RISC engine
  - 155 Mbps ATM interface (including AAL 0/1/2/5)
  - 10/100 Mbit Ethernet interface
  - Up to four E1/T1 interfaces or one E3/T3 interface and one E1/T1 interface
  - HDLC support up to T3 rates, or 256 channels
- 64- or 32-bit Wide Bus Interface
  - Support for bursts for high efficiency
  - Glueless interface to 60x-compatible bus systems
  - Multi-master support
- Enhanced Filter Coprocessor (EFCOP)
  - Independently and concurrently executes long filters (such as echo cancellation)
  - Runs at 250/275/300 MHz and provides 250/275/300 MMACS performance
- Programmable Memory Controller
  - Control for up to eight banks of external memory
  - User-programmable machines (UPM) allowing glueless interface to various memory types (SRAM, DRAM, EPROM, and Flash memory) and other user-definable peripherals
  - Dedicated pipelined SDRAM memory interface
- Large internal SRAM
  - 256K 16-bit words (512 KB)
  - Unified program and data space configurable by the application
  - Word and byte addressable
- · DMA Controller
  - 16 DMA channels, FIFO based, with burst capabilities
  - Sophisticated addressing capabilities
- Small Foot Print Package
  - 17 mm × 17 mm lidded FC-PBGA package
- Very Low Power Consumption
  - Separate power supply for internal logic (1.6 V) and for I/O (3.3 V)
- Enhanced 16-bit Parallel Host Interface (HDI16)
  - Supports a variety of microcontroller, microprocessor, and DSP bus interfaces
- Phase-Lock Loops (PLLs)
  - System PLL
  - CPM DPLLs (SCC and SCM)
- Process Technology
  - Uses 0.13 micron copper interconnect process technology

## **Target Applications**

The MSC8101 targets applications requiring very high performance, very large amounts of internal memory, and such networking capabilities as:

- Third-generation wideband wireless infrastructure systems
- Packet Telephony systems
- Multi-channel modem banks
- Multi-channel xDSL

### **Product Documentation**

The documents listed in **Table 1** are required for a complete description of the MSC8101 and are necessary to design properly with the part. Documentation is available from the following sources (see back cover for detailed information):

- A local Motorola distributor
- A Motorola semiconductor sales office
- A Motorola Literature Distribution Center
- The World Wide Web (WWW)

Table 1. MSC8101 Documentation

Name	Description	Order Number
MSC8101 Technical Data	MSC8101 features list and physical, electrical, timing, and package specifications	MSC8101/D
MSC8101 User's Guide	Detailed functional description of the MSC8101 memory configuration, operation, and register programming	MSC8101UG/D
MSC8101 Pocket Guide	Quick reference information for application development.	MSC8101PG/D
MSC8101 Reference Manual	Detailed description of the MSC8101 processor core and instruction set	MSC8101RM/D
SC140 DSP Core Reference Manual	Detailed description of the SC140 family processor core and instruction set	MNSC140CORE/D
Application Notes	Documents describing specific applications or optimized device operation including code examples	See the MSC8101 product website

### Chapter 1

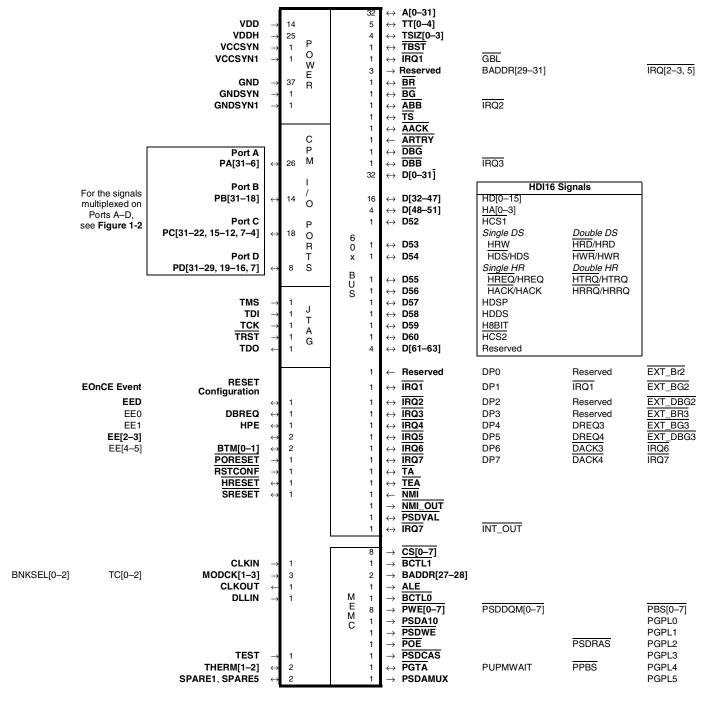
Signal/ Connection Descriptions

## 1.1 Signal Groupings

The MSC8101 external signals are organized into functional groups, as shown in **Table 1-1**, **Figure 1-1**, and **Figure 1-2**. **Table 1-1** lists the functional groups, the number of signal connections in each group, and references the table that gives a detailed listing of multiplexed signals within each group. **Figure 1-1** shows MSC8101 external signals organized by function. **Figure 1-2** indicates how the parallel input/output (I/O) ports signals are multiplexed. Because the parallel I/O design supported by the MSC8101 Communications Processor Module (CPM) is a subset of the parallel I/O signals supported by the MPC8260 device, port pins are not numbered sequentially.

Table 1-1. MSC8101 Functional Signal Groupings

Functional Group	Number of Signal Connections	Detailed Description	
Power (V <sub>CC</sub> , V <sub>DD</sub> , and GND)		80	Table 1-2 on page 1-4
Clock		6	<b>Table 1-3</b> on page 1-5
Reset, Configuration, and EOnCE		11	Table 1-4 on page 1-6
System Bus, HDI16, and Interrupts		133	<b>Table 1-5</b> on page 1-8
Memory Controller		27	<b>Table 1-6</b> on page 1-16
Communications Processor Module (CPM) Input/Output Parallel Ports	Port A	26	<b>Table 1-7</b> on page 1-19
Impurouput Faraner Forts	Port B	14	<b>Table 1-8</b> on page 1-26
	Port C	18	<b>Table 1-9</b> on page 1-31
	Port D	8	<b>Table 1-10</b> on page 1-41
JTAG Test Access Port	5	<b>Table 1-11</b> on page 1-44	
Reserved (denotes connections that are always reser	5	<b>Table 1-12</b> on page 1-45	



Note: Refer to the System Interface Unit (SIU) chapter in the MCS8101 Reference Manual for details on how to configure these pins.

Figure 1-1. MSC8101 External Signals

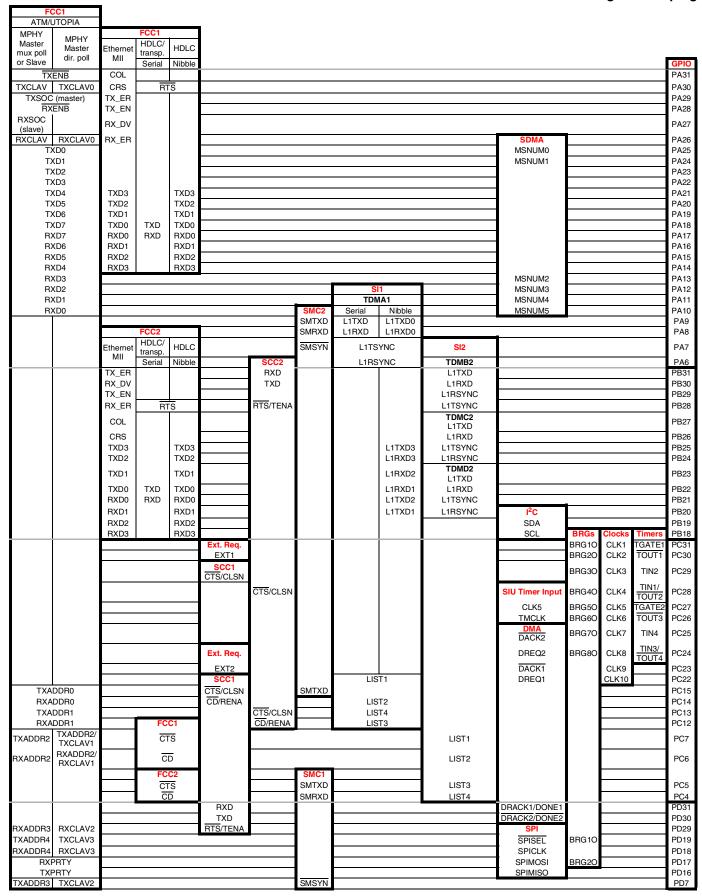


Figure 1-2. CPM Port A-D Pin Multiplexed Functionality

# 1.2 Power Signals

Table 1-2. Power and Ground Signal Inputs

Power Name	Description
V <sub>DD</sub>	Internal Logic Power $V_{DD}$ dedicated for use with the device core. The voltage should be well-regulated and the input should be provided with an extremely low impedance path to the $V_{DD}$ power rail.
V <sub>DDH</sub>	Input/Output Power This source supplies power for the I/O buffers. The user must provide adequate external decoupling capacitors.
V <sub>CCSYN</sub>	System PLL Power  V <sub>CC</sub> dedicated for use with the system Phase Lock Loop (PLL). The voltage should be well-regulated and the input should be provided with an extremely low impedance path to the V <sub>CC</sub> power rail.
V <sub>CCSYN1</sub>	SC140 PLL Power $V_{CC}$ dedicated for use with the SC140 core PLL. The voltage should be well-regulated and the input should be provided with an extremely low impedance path to the $V_{CC}$ power rail.
GND	System Ground  An isolated ground for the internal processing logic. This connection must be tied externally to all chip ground connections, except GND <sub>SYN</sub> and GND <sub>SYN1</sub> . The user must provide adequate external decoupling capacitors.
GND <sub>SYN</sub>	System PLL Ground Ground dedicated for system PLL use. The connection should be provided with an extremely low-impedance path to ground.
GND <sub>SYN1</sub>	SC140 PLL Ground 1 Ground dedicated for SC140 core PLL use. The connection should be provided with an extremely low-impedance path to ground.

# 1.3 Clock Signals

Table 1-3. Clock Signals

Signal Name	Туре	Signal Description
CLKIN	Input	Clock In Primary clock input to the MSC8101 PLL.
MODCK1	Input	Clock Mode Input 1 Defines the operating mode of internal clock circuits.
TC0	Output	Transfer Code 0 Supplies information that can be useful for debugging bus transactions initiated by the MSC8101.
BNKSEL0	Output	Bank Select 0 Selects the SDRAM bank when the MSC8101 is in 60x-compatible bus mode.
MODCK2	Input	Clock Mode Input 2 Defines the operating mode of internal clock circuits.
TC1	Output	Transfer Code 1 Supplies information that can be useful for debugging bus transactions initiated by the MSC8101.
BNKSEL1	Output	Bank Select 1 Selects the SDRAM bank when the MSC8101 is in 60x-compatible bus mode.
MODCK3	Input	Clock Mode Input 3 Defines the operating mode of internal clock circuits.
TC2	Output	Transfer Code 2 Supplies information that can be useful for debugging bus transactions initiated by the MSC8101.
BNKSEL2	Output	Bank Select 2 Selects the SDRAM bank when the MSC8101 is in 60x-compatible bus mode.
CLKOUT	Output	Clock Out The system bus clock.
DLLIN	Input	DLLIN Synchronizes with an external device. Note: When the DLL is disabled, connect this signal to GND.

# 1.4 Reset, Configuration, and EOnCE Event Signals

Table 1-4. Reset, Configuration, and EOnCE Event Signals

Signal Name	Туре	Signal Description
DBREQ	Input	Debug Request Determines whether to go into SC140 Debug mode when PORESET is deasserted.
EE0 <sup>1</sup>		Enhanced OnCE (EOnCE) Event 0 After PORESET is deasserted, you can configure EE0 as an input (default) or an output.
	Input	Debug request, enable Address Event Detection Channel 0, or generate one of the EOnCE events.
	Output	Detection by Address Event Detection Channel 0. Used to trigger external debugging equipment.
HPE	Input	Host Port Enable When this pin is asserted during PORESET, the Host port is enabled, the system data bus is 32 bits wide, and the Host <i>must</i> program the reset configuration word.
EE1 <sup>1</sup>		EOnCE Event 1 After PORESET is deasserted, you can configure EE1 as an input (default) or an output.
	Input	Enable Address Event Detection Channel 1 or generate one of the EOnCE events.
	Output	Debug Acknowledge or detection by Address Event Detection Channel 1. Used to trigger external debugging equipment.
EE2 <sup>1</sup>		EOnCE Event 2 After PORESET is deasserted, you can configure EE2 as an input (default) or an output.
	Input	Enable Address Event Detection Channel 2 or generate one of the EOnCE events or enable the Event Counter.
	Output	Detection by Address Event Detection Channel 2. Used to trigger external debugging equipment.
EE3 <sup>1</sup>		EOnCE Event 3 After PORESET is deasserted, you can configure EE3 as an input (default) or an output. See the Emulation and Debug chapter in the SC140 DSP Core Reference Manual for details on the ERCV Register.
	Input	Enable Address Event Detection Channel 3 or generate one of the EOnCE events.
	Output	EOnCE Receive Register (ERCV) was read by the DSP. Used to trigger external debugging equipment.

 Table 1-4.
 Reset, Configuration, and EOnCE Event Signals (Continued)

Signal Name	Туре	Signal Description	
BTM[0-1]	Input	Boot Mode 0–1 Determines the MSC8101 boot mode when PORESET is deasserted. See the Emulation and Debug chapter in the SC140 DSP Core Reference Manual for details on how to set these pins.	
EE4 <sup>1</sup>		EOnCE Event 4 After PORESET is deasserted, you can configure EE4 as an input (default) or an output. See the Emulation and Debug chapter in the SC140 DSP Core Reference Manual for details on the ETRSMT Register.	
	Input	Enable Address Event Detection Channel 4 or generate one of the EOnCE events	
	Output	EOnCE Transmit Register (ETRSMT) was written by the DSP. Used to trigger external debugging equipment.	
EE5 <sup>1</sup>		EOnCE Event 5 After PORESET is deasserted, you can configure EE5 as an input (default) or an output.	
	Input	Enable Address Event Detection Channel 5.	
	Output	Detection by Address Event Detection Channel 5. Used to trigger external debugging equipment.	
EED <sup>1</sup>		Enhanced OnCE (EOnCE) Event Detection After PORESET is deasserted, you can configure EED as an input (default) or output:	
	Input	Enable the Data Event Detection Channel.	
	Output	Detection by the Data Event Detection Channel. Used to trigger external debugging equipment.	
PORESET	Input	Power-On Reset When asserted, this line causes the MSC8101 to enter power-on reset state.	
RSTCONF	Input	Reset Configuration Used during reset configuration sequence of the chip. A detailed explanation of its function is provided in the "Power-On Reset Flow" and "Hardware Reset Configuration" sections of the MSC8101 Reference Manual.	
HRESET	Input	Hard Reset When asserted, this open-drain line causes the MSC8101 to enter hard reset state.	
SRESET	Input	Soft Reset When asserted, this open-drain line causes the MSC8101 to enter soft reset state.	
Note: See the <i>Emulation and Debug</i> chapter in the <i>SC140 DSP Core Reference Manual</i> for details on how to configure these pins.			

## 1.5 System Bus, HDI16, and Interrupt Signals

The system bus, HDI16, and interrupt signals are grouped together because they use a common set of signal lines. Individual assignment of a signal to a specific signal line is configured through registers in the System Interface Unit (SIU) and the Host Interface (HDI16). Table 1-5 describes the signals in this group.

Note:

To boot from the host interface, the HDI16 must be enabled by pulling up the HPE signal line during PORESET. If the HPE signal is pulled up, the configuration word must then be loaded from the host. The configuration word must set the Internal Space Port Size bit in the Bus Control Register (BCR[ISPS]) to change the system data bus width from 64 bits to 32 bits and reassign the upper 32 bits to their HDI16 functions. Never set the Host Port Enable (HEN) bit in the Host Port Control Register (HPCR) to enable the HDI16, unless the bus size is first changed from 64 bits to 32 bits by setting the BCR[ISPS] bit. Otherwise, unpredictable operation may occur.

Although there are eight interrupt request (IRQ) connections to the core processor, there are multiple external lines that can connect to these internal signal lines. After reset, the default configuration includes two  $\overline{IRQ1}$  and two  $\overline{IRQ7}$  input lines. The designer must select one line for each required interrupt and reconfigure the other external signal line or lines for alternate functions.

Table 1-5. System Bus, HDI16, and Interrupt Signals

Signal	Data Flow	Description
A[0-31]	Input/Output	Address Bus  When the MSC8101 is in external master bus mode, these pins function as the address bus. The MSC8101 drives the address of its internal bus masters and responds to addresses generated by external bus masters. When the MSC8101 is in Internal Master Bus mode, these pins are used as address lines connected to memory devices and are controlled by the MSC8101 memory controller.
TT[0-4]	Input/Output	Bus Transfer Type The bus master drives these pins during the address tenure to specify the type of transaction.
TSIZ[0-3]	Input/Output	Transfer Size The bus master drives these pins with a value indicating the number of bytes transferred in the current transaction.
TBST	Input/Output	Bus Transfer Burst The bus master asserts this pin to indicate that the current transaction is a burst transaction (transfers four quad words).
ĪRQ1	Input	Interrupt Request 1 <sup>1</sup> One of eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.
GBL	Input/Output	Global <sup>1</sup> When a master within the chip initiates a bus transaction, it drives this pin. When an external master initiates a bus transaction, it should drive this pin. Assertion of this pin indicates that the transfer is global and it should be snooped by caches in the system.

 Table 1-5.
 System Bus, HDI16, and Interrupt Signals (Continued)

Signal	Data Flow	Description
Reserved	Output	The primary configuration is reserved.
BADDR29	Output	Burst Address 29 <sup>1</sup> One of five outputs of the memory controller. These pins connect directly to memory devices controlled by the MSC8101 memory controller.
ĪRQ2	Input	Interrupt Request 2 <sup>1</sup> One of eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.
Reserved	Output	The primary configuration is reserved.
BADDR30	Output	Burst Address 30 <sup>1</sup> One of five outputs of the memory controller. These pins connect directly to memory devices controlled by the MSC8101 memory controller.
ĪRQ3	Input	Interrupt Request 3 <sup>1</sup> One of eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.
Reserved	Output	The primary configuration is reserved.
BADDR31	Output	Burst Address 31 <sup>1</sup> One of five outputs of the memory controller. These pins connect directly to memory devices controlled by the MSC8101 memory controller.
ĪRQ5	Input	Interrupt Request 5 <sup>1</sup> One of eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.
BR	Input/Output Output	Bus Request <sup>2</sup> An output when an external arbiter is used. The MSC8101 asserts this pin to request ownership of the bus.
	Input	An input when an internal arbiter is used. An external master should assert this pin to request bus ownership from the internal arbiter.
BG	Input/Output Output	Bus Grant <sup>2</sup> An output when an internal arbiter is used. The MSC8101 asserts this pin to grant bus ownership to an external bus master.
	Input	An input when an external arbiter is used. The external arbiter should assert this pin to grant bus ownership to the MSC8101.
ABB	Input/Output Output	Address Bus Busy <sup>1</sup> The MSC8101 asserts this pin for the duration of the address bus tenure. Following an address acknowledge (AACK) signal, which terminates the address bus tenure, the MSC8101 deasserts ABB for a fraction of a bus cycle and then stops driving this pin.
	Input	The MSC8101 does not assume bus ownership as long as it senses that this pin is asserted by an external bus master.
ĪRQ2	Input	Interrupt Request 2 <sup>1</sup> One of the eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.

 Table 1-5.
 System Bus, HDI16, and Interrupt Signals (Continued)

Signal	Data Flow	Description
TS	Input/Output	Bus Transfer Start Signals the beginning of a new address bus tenure. The MSC8101 asserts this signal when one of its internal bus masters (SC140 core or DMA) begins an address tenure. When the MSC8101 senses this pin being asserted by an external bus master, it responds to the address bus tenure as required (snoop if enabled, access internal MSC8101 resources, memory controller support).
AACK	Input/Output	Address Acknowledge A bus slave asserts this signal to indicate that it identified the address tenure. Assertion of this signal terminates the address tenure.
ARTRY	Input	Address Retry Assertion of this signal indicates that the bus transaction should be retried by the bus master. The MSC8101 asserts this signal to enforce data coherency with its internal cache and to prevent deadlock situations.
DBG	Input/Output Output	Data Bus Grant <sup>2</sup> An output when an internal arbiter is used. The MSC8101 asserts this pin as an output to grant data bus ownership to an external bus master.
	Input	An input when an external arbiter is used. The external arbiter should assert this pin as an input to grant data bus ownership to the MSC8101.
DBB	Input/Output Output	Data Bus Busy <sup>1</sup> The MSC8101 asserts this pin as an output for the duration of the data bus tenure. Following a TA, which terminates the data bus tenure, the MSC8101 deasserts DBB for a fraction of a bus cycle and then stops driving this pin.
	Input	The MSC8101 does not assume data bus ownership as long as it senses DBB is asserted by an external bus master.
ĪRQ3	Input	Interrupt Request 3 <sup>1</sup> One of the eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.
D[0-31]	Input/Output	Data Bus Most Significant Word In write transactions the bus master drives the valid data on this bus. In read transactions the slave drives the valid data on this bus. In Host Port Disabled mode, these 32 bits are part of the 64-bit data bus. In Host Port Enabled mode, these bits are used as the bus in 32-bit mode.
D[32-47]	Input/Output	Data Bus Bits 32–47 In write transactions the bus master drives the valid data on this bus. In read transactions the slave drives the valid data on this bus.
HD[0-15]	Input/Output	Host Data <sup>2</sup> When the HDI16 interface is enabled, these signals are lines 0-15 of the bidirectional tri-state data bus.
D[48–51]	Input/Output	Data Bus Bits 48–51 In write transactions the bus master drives the valid data on these pins. In read transactions the slave drives the valid data on these pins.
HA[0-3]	Input	Host Address Line 0–3 <sup>3</sup> When the HDI16 interface bus is enabled, these lines address internal host registers.

 Table 1-5.
 System Bus, HDI16, and Interrupt Signals (Continued)

Signal	Data Flow	Description
D52	Input/Output	Data Bus Bit 52 In write transactions the bus master drives the valid data on this pin. In read transactions the slave drives the valid data on this pin.
HCS1	Input	Host Chip Select <sup>3</sup> When the HDI16 interface is enabled, this is one of the two chip-select pins. The HDI16 chip select is a logical OR of HCS1 and HCS2.
D53	Input/Output	Data Bus Bit 53 In write transactions the bus master drives the valid data on this pin. In read transactions the slave drives the valid data on this pin.
HRW	Input	Host Read Write Select <sup>3</sup> When the HDI16 interface is enabled in Single Strobe mode, this is the read/write input (HRW).
HRD/HRD	Input	Host Read Strobe <sup>3</sup> When the HDI16 is programmed to interface with a double data strobe host bus, this pin is the read data strobe Schmitt trigger input (HRD/HRD). The polarity of the data strobe is programmable.
D54	Input/Output	Data Bus Bit 54 In write transactions the bus master drives the valid data on this pin. In read transactions the slave drives the valid data on this pin.
HDS/HDS	Input	Host Data Strobe <sup>3</sup> When the HDI16 is programmed to interface with a single data strobe host bus, this pin is the data strobe Schmitt trigger input (HDS/HDS). The polarity of the data strobe is programmable.
HWR/HWR	Input	Host Write Data Strobe <sup>3</sup> When the HDI16 is programmed to interface with a double data strobe host bus, this pin is the write data strobe Schmitt trigger input (HWR/HWR). The polarity of the data strobe is programmable.
D55	Input/Output	Data Bus Bit 55 In write transactions the bus master drives the valid data on this pin. In read transactions the slave drives the valid data on this pin.
HREQ/HREQ	Output	Host Request <sup>3</sup> When the HDI16 is programmed to interface with a single host request host bus, this pin is the host request output (HREQ/HREQ). The polarity of the host request is programmable. The host request may be programmed as a driven or open-drain output.
HTRQ/HTRQ	Output	Transmit Host Request <sup>3</sup> When the HDI16 is programmed to interface with a double host request host bus, this pin is the transmit host request output (HTRQ/HTRQ). The signal can be programmed as driven or open drain. The polarity of the host request is programmable.

 Table 1-5.
 System Bus, HDI16, and Interrupt Signals (Continued)

Signal	Data Flow	Description		
D56	Input/Output	Data Bus Bit 56 In write transactions the bus master drives the valid data on this pin. In read transactions the slave drives the valid data on this pin.		
HACK/HACK	Output	Host Acknowledge <sup>3</sup> When the HDI16 is programmed to interface with a single host request host bus, this pin is the host acknowledge Schmitt trigger input (HACK). The polarity of the host acknowledge is programmable.		
HRRQ/HRRQ	Output	Receive Host Request <sup>3</sup> When the HDI16 is programmed to interface with a double host request host bus, this pin is the receive host request output (HRRQ/HRRQ). The signal can be programmed as driven or open drain. The polarity of the host request is programmable.		
D57	Input/Output	Data Bus Bit 57 In write transactions the bus master drives the valid data on this pin. In read transactions the slave drives the valid data on this pin.		
HDSP	Input	Host Data Strobe Polarity <sup>3</sup> When the HDI16 interface is enabled, this pin is the host data strobe polarity (HDSP).		
D58	Input/Output	Data Bus Bit 58 In write transactions the bus master drives the valid data on this pin. In read transactions the slave drives the valid data on this pin.		
HDDS	Input	Host Dual Data Strobe <sup>3</sup> When the HDI16 interface is enabled, this pin is the host dual data strobe (HDDS).		
D59	Input/Output	Data Bus Bit 59 In write transactions the bus master drives the valid data on this pin. In read transactions the slave drives the valid data on this pin.		
H8BIT	Input	H8BIT <sup>3</sup> When the HDI16 interface is enabled, this bit determines if the interface is in 8-bit or 16-bit mode.		
D60	Input/Output	Data Bus Bit 60 In write transactions the bus master drives the valid data on this pin. In read transactions the slave drives the valid data on this pin.		
HCS2	Input	Host Chip Select <sup>3</sup> When the HDI16 interface is enabled, this is one of the two chip-select pins. The HDI16 chip select is a logical OR of HCS1 and HCS2.		
D[61–63]	Input/Output	Data Bus Bits 61–63 Used only in 60x-mode-only mode. In write transactions the bus master drives the valid data on this bus. In read transactions the slave drives the valid data on this bus.		
Reserved		These dedicated signals are reserved when the HDI16 is enabled. <sup>3</sup>		

 Table 1-5.
 System Bus, HDI16, and Interrupt Signals (Continued)

Signal	Data Flow	Description
Reserved	Input	The primary configuration is reserved.
DP0	Input/Output	Data Parity 0 <sup>1</sup> The agent that drives the data bus also drives the data parity signals. The value driven on the data parity zero pin should give odd parity (odd number of ones) on the group of signals that includes data parity 0 and D[0–7].
EXT_BR2	Input	External Bus Request 2 <sup>1,2</sup> An external master asserts this pin to request bus ownership from the internal arbiter.
ĪRQ1	Input	Interrupt Request 1 <sup>1</sup> One of eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.
DP1	Input/Output	Data Parity 1 <sup>1</sup> The agent that drives the data bus also drives the data parity signals. The value driven on the data parity one pin should give odd parity (odd number of ones) on the group of signals that includes data parity 1 and D[8–15].
EXT_BG2	Output	External Bus Grant 2 <sup>1,2</sup> The MSC8101 asserts this pin to grant bus ownership to an external bus master.
ĪRQ2	Input	Interrupt Request 2 <sup>1</sup> One of eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.
DP2	Input/Output	Data Parity 2 <sup>1</sup> The agent that drives the data bus also drives the data parity signals. The value driven on the data parity two pin should give odd parity (odd number of ones) on the group of signals that includes data parity 2 and D[16–23].
EXT_DBG2	Output	External Data Bus Grant 2 <sup>1,2</sup> The MSC8101 asserts this pin to grant data bus ownership to an external bus master.
ĪRQ3	Input	Interrupt Request 3 <sup>1</sup> One of eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.
DP3	Input/Output	Data Parity 3 <sup>1</sup> The agent that drives the data bus also drives the data parity signals. The value driven on the data parity three pin should give odd parity (odd number of ones) on the group of signals that includes data parity 3 and D[24–31].
EXT_BR3	Input	External Bus Request 3 <sup>1,2</sup> An external master asserts this pin to request bus ownership from the internal arbiter.

 Table 1-5.
 System Bus, HDI16, and Interrupt Signals (Continued)

Signal	Data Flow	Description			
ĪRQ4	Input	Interrupt Request 4 <sup>1</sup> One of eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.			
DP4	Input/Output	Data Parity 4 <sup>1</sup> The agent that drives the data bus also drives the data parity signals. The value driven on the data parity four pin should give odd parity (odd number of ones) on the group of signals that includes data parity 4 and D[32–39].			
DREQ3	Input	DMA Request 3 <sup>1</sup> An external peripheral uses this pin to request DMA service.			
EXT_BG3	Output	External Bus Grant 3 <sup>1,2</sup> The MSC8101 asserts this pin to grant bus ownership to an external bus master.			
ĪRQ5	Input	Interrupt Request 5 <sup>1</sup> One of eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.			
DP5	Input/Output	Data Parity 5 <sup>1</sup> The agent that drives the data bus also drives the data parity signals. The value driven on the data parity five pin should give odd parity (odd number of ones) on the group of signals that includes data parity 5 and D[40–47].			
DREQ4	Input	<b>DMA Request 4</b> <sup>1</sup> An external peripheral uses this pin to request DMA service.			
EXT_DBG3	Output	External Data Bus Grant 3 <sup>1,2</sup> The MSC8101 asserts this pin to grant data bus ownership to an external bus master.			
ĪRQ6	Input	Interrupt Request 6 <sup>1</sup> One of eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.			
DP6	Input/Output	Data Parity 6 <sup>1</sup> The agent that drives the data bus also drives the data parity signals. The value driven on the data parity six pin should give odd parity (odd number of ones) on the group of signals that includes data parity 6 and D[48–55].			
DACK3	Output	DMA Acknowledge 3 <sup>1</sup> The DMA drives this output to acknowledge the DMA transaction on the bus.			
ĪRQ7	Input	Interrupt Request 7 <sup>1</sup> One of eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.			
DP7	Input/Output	Data Parity 7 <sup>1</sup> The master or slave that drives the data bus also drives the data parity signals. The value driven on the data parity seven pin should give odd parity (odd number of ones) on the group of signals that includes data parity 7 and D[56–63].			
DACK4	Output	DMA Acknowledge <sup>1</sup> The DMA drives this output to acknowledge the DMA transaction on the bus.			
TA	Input/Output	Transfer Acknowledge Indicates that a data beat is valid on the data bus. For single beat transfers, assertion of TA indicates the termination of the transfer. For burst transfers, TA is asserted four times to indicate the transfer of four data beats with the last assertion indicating the termination of the burst transfer.			

**Table 1-5.** System Bus, HDI16, and Interrupt Signals (Continued)

Signal	Data Flow	Description	
TEA	Input/Output	Transfer Error Acknowledge Indicates a bus error. masters within the MSC8101 monitor the state of this pin. The MSC8101 internal bus monitor can assert this pin if it identifies a bus transfer that is hung.	
NMI	Input	Non-Maskable Interrupt When an external device asserts this line, the MSC8101 NMI input is asserted.	
NMI_OUT	Output	Non-Maskable Interrupt Driven from the MSC8101 internal interrupt controller. Assertion of this output indicates that a non-maskable interrupt, pending in the MSC8101 internal interrupt controller, is waiting to be handled by an external host.	
PSDVAL	Input/Output	Data Valid Indicates that a data beat is valid on the data bus. The difference between the T pin and PSDVAL is that the TA pin is asserted to indicate data transfer termination while the PSDVAL signal is asserted with each data beat movement. Thus, when TA is asserted, PSDVAL is asserted, but when PSDVAL is asserted, TA is not necessarily asserted. For example when the SDMA initiates a double word (2x6-bits) transfer to a memory device that has a 32-bit port size, PSDVAL is asserted three times without TA, and finally both pins are asserted to terminate the transfer	
ĪRQ7	Input	Interrupt Request 7 <sup>1</sup> One of eight external lines that can request a service routine, via the internal interrupt controller, from the SC140 core.	
INT_OUT	Output	Interrupt Output <sup>1</sup> Driven from the MSC8101 internal interrupt controller. Assertion of this output indicates that an unmasked interrupt is pending in the MSC8101 internal interrupt controller.	

#### Notes:

- 1. See the System Interface Unit (SIU) chapter in the MCS8101 Reference Manual for details on how to configure these pins.
- When used as the bus control arbiter for the system bus, the MSC8101 can support up to three external bus masters. Each master uses its own set of Bus Request, Bus Grant, and Data Bus Grant signals (BR/BG/DBG, EXT\_BR2/EXT\_BG2/EXT\_DBG2, and EXT\_BR3/EXT\_BG3/EXT\_DBG3). Each of these signal sets must be configured to indicate whether the external master is or is not a MSC8101 master device. See the Bus Configuration Register (BCR) description in the *System Interface Unit (SIU)* chapter in the *MCS8101 Reference Manual* for details on how to configure these pins. The second and third set of pins is defined by EXT\_xxx to indicate that they can only be used with external master devices. The first set of pins (BR/BG/DBG) have a dual function. When the MSC8101 is not the bus arbiter, these signals (BR/BG/DBG) are used by the MSC8101 to obtain master control of the bus.
- 3. See the *Host Interface (HDI16)* chapter in the *MCS8101 Reference Manual* for details on how to configure these pins.

# 1.6 Memory Controller Signals

Refer to the *Memory Controller* chapter in the *MSC8101 Reference Manual (MSC8101RM/D)* for detailed information about configuring these signals.

Table 1-6. Memory Controller Signals

Signal	Data Flow	Description		
CS[0-7]	Output	Chip Select Enable specific memory devices or peripherals connected to MSC8101 buses.		
BCTL1	Output	Buffer Control 1 Controls buffers on the data bus. Usually used with BCTL0. The exact function of this pin is defined by the value of SIUMCR[BCTLC]. See the System Interface Unit (SIU) chapter in the MS8101 Technical Reference manual for details.		
BADDR[27-28]	Output	Burst Address 27–28 Two of five outputs of the memory controller. These pins connect directly to memory devices controlled by the MSC8101 memory controller.		
ALE	Output	Address Latch Enable Controls the external address latch used in external master bus configuration.		
BCTL0	Output	Buffer Control 0 Controls buffers on the data bus. The exact function of this pin is defined by the value of SIUMCR[BCTLC]. See the System Interface Unit (SIU) chapter in the MS8101 Technical Reference manual for details.		
PWE[0-7]	Output	Bus Write Enable Outputs of the bus General-Purpose Chip-select Machine (GPCM). These pins select byte lanes for write operations.		
PSDDQM[0-7]	Output	Bus SDRAM DQM Outputs of the SDRAM control machine. These pins select specific byte lanes of SDRAM devices.		
PBS[0-7]	Output	Bus UPM Byte Select Outputs of the User-Programmable Machine (UPM) in the memory controller. These pins select specific byte lanes during memory operations. The timing of these pins is programmed in the UPM. The actual driven value depends on the address and size of the transaction and the port size of the accessed device.		
PSDA10	Output	Bus SDRAM A10 Output from the bus SDRAM controller. This pin is part of the address when a row address is driven. It is part of the command when a column address is driven.		
PGPL0	Output	Bus UPM General-Purpose Line 0 One of six general-purpose output lines of the UPM. The values and timing of this pin are programmed in the UPM.		
PSDWE	Output	Bus SDRAM Write Enable Output from the bus SDRAM controller. This pin should connect to the SDRAM WE input signal.		
PGPL1	Output	Bus UPM General-Purpose Line 1 One of six general-purpose output lines from the UPM. The values and timing of this pin are programmed in the UPM.		

Table 1-6. Memory Controller Signals (Continued)

Signal	Data Flow	Description
POE	Output	Bus Output Enable Output of the bus GPCM. Controls the output buffer of memory devices during read operations.
PSDRAS	Output	Bus SDRAM RAS Output from the bus SDRAM controller. This pin should connect to the SDRAM Row Address Strobe (RAS) input signal.
PGPL2	Output	Bus UPM General-Purpose Line 2 One of six general-purpose output lines from the UPM. The values and timing of this pin are programmed in the UPM.
PSDCAS	Output	Bus SDRAM CAS Output from the bus SDRAM controller. This pin should connect to the SDRAM Column Address Strobe (CAS) input signal.
PGPL3	Output	Bus UPM General-Purpose Line 3 One of six general-purpose output lines from the UPM. The values and timing of this pin are programmed in the UPM.
PGTA	Input	GPCM TA  Terminates transactions during GPCM operation. Requires an external pull up resistor for proper operation.
PUPMWAIT	Input	Bus UPM Wait Input to the UPM. An external device can hold this pin high to force the UPM to wait until the device is ready for the operation to continue.
PPBS	Output	Bus Parity Byte Select In systems in which data parity is stored in a separate chip, this output is the byte-select for that chip.
PGPL4	Output	Bus UPM General-Purpose Line 4 One of six general-purpose output lines from the UPM. The values and timing of this pin are programmed in the UPM.
PSDAMUX	Output	Bus SDRAM Address Multiplexer Controls the SDRAM address multiplexer when the MSC8101 is in External Master mode.
PGPL5	Output	Bus UPM General-Purpose Line 5 One of six general-purpose output lines from the UPM. The values and timing of this pin are programmed in the UPM.

## 1.7 Communications Processor Module (CPM) Ports

The MSC8101 CPM supports a subset of signals included in the MPC8260. The following sections describe the functionality of the signals in the MSC8101.

- The MSC8101 CPM includes the following set of communication controllers:
- Two full-duplex Fast Serial Communications Controllers (FCCs) that support:
  - Asynchronous Transfer Mode (ATM) through a UTOPIA 8 interface (FCC1 only)—The MSC8101 can operate as one of the following:
    - UTOPIA slave device
    - UTOPIA multi-PHY master device using direct polling for up to 4 PHY devices
    - UTOPIA multi-PHY master device using multiplex polling that can address up to 31 PHY devices at addresses 0–30 (address 31 is reserved as a null port).
  - IEEE 802.3/Fast Ethernet through a Media-Independent Interface (MII)
  - High-Level Data Link Control (HDLC) Protocol:
    - Serial mode—Transfers data one bit at a time
    - Nibble mode—Transfers data four bits at a time
  - Transparent mode serial operation
- One FCC that operates with the TSA only
- Two Multi-Channel Controllers (MCCs) that together can handle up to 256 HDLC/transparent channels at 64 Kbps each, multiplexed on up to four TDM interfaces
- Two full-duplex serial communications controllers (SCCs) that support the following protocols:
  - IEEE 802.3/Fast Ethernet through a Media-Independent Interface (MII)
  - HDLC Protocol:
    - Serial mode—Transfers data one bit at a time
    - Nibble mode—Transfers data four bits at a time
  - Synchronous Data Link Control (SDLC)
  - LocalTalk (HDLC-based local area network protocol)
  - Universal Asynchronous Receiver/Transmitter (UART)
  - Synchronous UART (1x clock mode)
  - Binary Synchronous (BISYNC) communication
  - Transparent mode serial operation
- Two additional SCCs that operate with the TSA only
- Two full-duplex Serial Management Controllers (SMCs) that support the following protocols:
  - General Circuit Interface (GCI)/Integrated Services Digital Network (ISDN) monitor and C/I channels (TSA only)
  - UART
  - Transparent mode serial operation
- Serial Peripheral Interface (SPI) support for master or slave operation
- Inter-Integrated Circuit (I<sup>2</sup>C) bus controller
- Time-Slot Assigner (TSA) that supports multiplexing from any of the SCCs, FCCs, SMCs, and two
  MCCs onto four time-division multiplexed (TDM) interfaces. The TSA uses two Serial Interfaces (SII
  and SI2). SII uses TDMA1 which supports both serial and nibble mode. SI2 does not support nibble
  mode and includes TDMB2, TDMC2, and TDMD2 which operate only in serial mode.

The individual sets of externals signals associated with a specific protocol and data transfer mode are multiplexed across any or all of the ports, as shown in **Figure 1-2**. The following sections provide detailed descriptions of the signals supported by Ports A–Port D.

# 1.7.1 Port A Signals

Table 1-7. Port A Signals

Name		<b>.</b>	
General- Purpose I/O	Peripheral Controller: Dedicated Signal Protocol	Dedicated I/O Data Direction	Description
PA31	FCC1: TXENB UTOPIA master	Output	FCC1: UTOPIA Master Transmit Enable In the ATM UTOPIA interface supported by FCC1, TXENB is asserted by the MSC8101 (UTOPIA master PHY) when there is valid transmit cell data (TXD[0–7]).
	FCC1: TXENB UTOPIA slave	Input	FCC1: UTOPIA Slave Transmit Enable In the ATM UTOPIA interface supported by FCC1, TXENB is asserted by an external UTOPIA master PHY when there is valid transmit cell data (TXD[0-7]).
	FCC1: COL MII	Input	FCC1: Media Independent Interface Collision Detect In the MII interface supported by FCC1, COL is asserted by an external fast Ethernet PHY.
PA30	FCC1: TXCLAV UTOPIA slave	Output	FCC1: UTOPIA Slave Transmit Cell Available In the ATM UTOPIA interface supported by FCC1, TXCLAV is asserted by the MSC8101 (UTOPIA slave PHY) when the MSC8101 can accept one complete ATM cell.
	FCC1: TXCLAV UTOPIA master, or	Input	FCC1: UTOPIA Master Transmit Cell Available In the ATM UTOPIA interface supported by FCC1, TXCLAV is asserted by an external UTOPIA slave PHY to indicate that it can accept one complete ATM cell.
	FCC1: TXCLAV0 UTOPIA master, Multi-PHY, direct polling	Input	FCC1: UTOPIA Master Transmit Cell Available Multi-PHY Direct Polling In the ATM UTOPIA interface supported by FCC1, TXCLAV0 is asserted by an external UTOPIA slave PHY using direct polling to indicate that it can accept one complete ATM cell.
	FCC1: RTS HDLC, Serial and Nibble	Output	FCC1: Request To Send In the standard modem interface signals supported by FCC1 (RTS, CTS, and CD). RTS is asynchronous with the data. RTS is typically used in conjunction with CD. The MSC8101 FCC1 transmitter requests the receiver to send data by asserting RTS low. The request is accepted when CTS is returned low.
	FCC1: CRS MII	Input	FCC1: Media Independent Interface Carrier Sense In the MII interface supported by FCC1. CRS is asserted by an external fast Ethernet PHY. It indicates activity on the cable.
PA29	FCC1: TXSOC UTOPIA master	Output	FCC1: UTOPIA Transmit Start of Cell In the ATM UTOPIA interface supported by FCC1. TXSOC is asserted by the MSC8101 (UTOPIA master PHY) when TXD[0-7] contains the first valid byte of the cell.
	FCC1: TX_ER MII	Output	FCC1: Media Independent Interface Transmit Error In the MII interface supported by FCC1. TX_ER is asserted by the MSC8101 to force propagation of transmit errors.

Table 1-7. Port A Signals (Continued)

	Name		
General- Purpose I/O	Peripheral Controller: Dedicated Signal Protocol	Dedicated I/O Data Direction	Description
PA28	FCC1: RXENB UTOPIA master	Output	FCC1: UTOPIA Master Receive Enable In the ATM UTOPIA interface supported by FCC1. (UTOPIA master) RXENB is asserted by the MSC8101 (UTOPIA master PHY) to indicate that RXD[0–7] and RXSOC are to be sampled at the end of the next cycle. RXD[0–7] and RXSOC are enabled only in cycles following those with RXENB asserted.
	FCC1: RXENB UTOPIA slave	Input	FCC1: UTOPIA Master Receive Enable In the ATM UTOPIA interface supported by FCC1. (UTOPIA slave) RXENB is an input asserted by an external PHY to indicate that RXD[0–7] and RXSOC is to be sampled at the end of the next cycle. RXD[0–7] and RXSOC are enabled only in cycles following those with RXENB asserted.
	FCC1: TX_EN MII	Output	FCC1: Media Independent Interface Transmit Enable In the MII interface supported by FCC1. TX_EN is asserted by the MSC8101 when transmitting data.
PA27	FCC1: RXSOC UTOPIA slave	Output	Asserted by the MSC8101 (UTOPIA slave) for an external PHY when RXD[0–7] contains the first valid byte of the cell.
	FCC1: RX_DV MII	Input	FCC1: Media Independent Interface Receive Data Valid In the MII interface supported by FCC1. RX_DV is an input asserted by an external fast Ethernet PHY. RX_DV indicates that valid data is being sent. The presence of carrier sense but not RX_DV indicates reception of broken packet headers, probably due to bad wiring or a bad circuit.
PA26	FCC1: RXCLAV UTOPIA slave	Output	FCC1: UTOPIA Slave Receive Cell Available In the ATM UTOPIA interface supported by FCC1. RXCLAV is asserted by the MSC8101 (UTOPIA slave PHY) when one complete ATM cell is available for transfer.
	FCC1: RXCLAV UTOPIA master, or	Input	FCC1: UTOPIA Master Receive Cell Available In the ATM UTOPIA interface supported by FCC1. RXCLAV is asserted by an external PHY when one complete ATM cell is available for transfer.
	RXCLAV0 UTOPIA master, Multi-PHY, direct polling	Input	FCC1: UTOPIA Master Receive Cell Available 0 Direct Polling In the ATM UTOPIA interface supported by FCC1, RXCLAV0 is asserted by an external PHY when one complete ATM cell is available for transfer.
	FCC1: RX_ER MII	Input	FCC1: Media Independent Interface Receive Error In the MII interface and supported by FCC1. RX_ER is asserted by an external fast Ethernet PHY. This signal indicates a receive error, which often indicates bad wiring.

Table 1-7. Port A Signals (Continued)

Name			
General- Purpose I/O	Peripheral Controller: Dedicated Signal Protocol	Dedicated I/O Data Direction	Description
PA25	FCC1: TXD0 UTOPIA	Output	FCC1: UTOPIA Transmit Data Bit 0 In the ATM UTOPIA interface supported by FCC1. The MSC8101 outputs ATM cell octets (UTOPIA interface data) on TXD[0–7]. TXD7 is the most significant bit. TXD0 is the least significant bit. When no ATM data is available, idle cells are inserted. A cell is 53 bytes.
	SDMA: MSNUM0	Output	Module Serial Number Bit 0 MSNUM[0-4] of is the sub-block code of the current peripheral controller using SDMA. MSNUM5 indicates which section, transmit (0) or receive (1), is active during the transfer.
PA24	FCC1: TXD1 UTOPIA	Output	FCC1: UTOPIA Transmit Data Bit 1 In the ATM UTOPIA interface supported by FCC1. The MSC8101 outputs ATM cell octets (UTOPIA interface data) on TXD[0–7]. TXD7 is the most significant bit. TXD0 is the least significant bit. When no ATM data is available, idle cells are inserted. A cell is 53 bytes.
	SDMA: MSNUM1	Output	Module Serial Number Bit 1 MSNUM[0-4] of is the sub-block code of the current peripheral controller using SDMA. MSNUM5 indicates which section, transmit (0) or receive (1), is active during the transfer.
PA23	FCC1: TXD2 UTOPIA	Output	FCC1: UTOPIA Transmit Data Bit 2  TXD[0-7] is part of the ATM UTOPIA interface supported by FCC1. The MSC8101 outputs ATM cell octets (UTOPIA interface data) on TXD[0-7]. TXD7 is the most significant bit. TXD0 is the least significant bit. When no ATM data is available, idle cells are inserted. A cell is 53 bytes.
PA22	FCC1: TXD3 UTOPIA	Output	FCC1: UTOPIA Transmit Data Bit 3  TXD[0-7] is part of the ATM UTOPIA interface supported by FCC1. The MSC8101 outputs ATM cell octets (UTOPIA interface data) on TXD[0-7]. TXD7 is the most significant bit. TXD0 is the least significant bit. When no ATM data is available, idle cells are inserted. A cell is 53 bytes.
PA21	FCC1: TXD4 UTOPIA	Output	FCC1: UTOPIA Transmit Data Bit 4  TXD[0-7] is part of the ATM UTOPIA interface supported by FCC1. The MSC8101 outputs ATM cell octets (UTOPIA interface data) on TXD[0-7]. TXD7 is the most significant bit. TXD0 is the least significant bit. When no ATM data is available, idle cells are inserted. A cell is 53 bytes.
	FCC1: TXD3  MII and HDLC nibble	Output	FCC1: MII and HDLC Nibble Transmit Data Bit 3 TXD[3–0] supports MII and HDLC nibble modes in FCC1. TXD3 is the most significant bit. TXD0 is the least significant bit.

Table 1-7. Port A Signals (Continued)

	Name		
General- Purpose I/O	Peripheral Controller: Dedicated Signal Protocol	I/O Data Direction	Description
PA20	FCC1: TXD5 UTOPIA	Output	FCC1: UTOPIA Transmit Data Bit 5  TXD[0-7] is part of the ATM UTOPIA interface supported by FCC1. The MSC8101 outputs ATM cell octets (UTOPIA interface data) on TXD[0-7]. TXD7 is the most significant bit. TXD0 is the least significant bit. When no ATM data is available, idle cells are inserted. A cell is 53 bytes.
	FCC1: TXD2 MII and HDLC nibble	Output	FCC1: MII and HDLC Nibble Transmit Data Bit 2 TXD[3–0] is supported by MII and HDLC nibble modes in FCC1. TXD3 is the most significant bit. TXD0 is the least significant bit.
PA19	FCC1: TXD6 UTOPIA	Output	FCC1: UTOPIA Transmit Data Bit 6  TXD[0-7] is part of the ATM UTOPIA interface supported by FCC1. The MSC8101 outputs ATM cell octets (UTOPIA interface data) on TXD[0-7]. TXD7 is the most significant bit. TXD0 is the least significant bit. When no ATM data is available, idle cells are inserted. A cell is 53 bytes.
	FCC1: TXD1 MII and HDLC nibble	Output	FCC1: MII and HDLC Nibble Transmit Data Bit 1 TXD[3–0] is supported by MII and HDLC transparent nibble modes in FCC1. TXD3 is the most significant bit. TXD0 is the least significant bit.
PA18	FCC1: TXD7 UTOPIA	Output	FCC1: UTOPIA Transmit Data Bit 7.  TXD[0-7] is part of the ATM UTOPIA interface supported by FCC1. The MSC8101 outputs ATM cell octets (UTOPIA interface data) on TXD[0-7]. TXD7 is the most significant bit. TXD0 is the least significant bit. When no ATM data is available, idle cells are inserted. A cell is 53 bytes.
	FCC1: TXD0 MII and HDLC nibble	Output	FCC1: MII and HDLC Nibble Transmit Data Bit 0 TXD[3-0] is supported by MII and HDLC nibble modes in FCC1. TXD3 is the most significant bit. TXD0 is the least significant bit.
	FCC1: TXD HDLC serial and transparent	Output	FCC1: HDLC Serial and Transparent Transmit Data Bit The TXD serial bit is supported by HDLC serial and transparent modes in FCC1.
PA17	FCC1: RXD7 UTOPIA	Input	FCC1: UTOPIA Receive Data Bit 7.  RXD[0–7] is part of the ATM UTOPIA interface supported by FCC1. The MSC8101 inputs ATM cell octets (UTOPIA interface data) on RXD[0–7]. RXD7 is the most significant bit. RXD0 is the least significant bit. When no ATM data is available, idle cells are inserted. A cell is 53 bytes. To support Multi-PHY configurations, RXD[0–7] is tri-stated, enabled only when RXENB is asserted.
	FCC1: RXD0 MII and HDLC nibble	Input	FCC1: MII and HDLC Nibble Receive Data Bit 0 RXD[3–0] is supported by MII and HDLC nibble mode in FCC1. RXD3 is the most significant bit. RXD0 is the least significant bit.
	FCC1: RXD HDLC serial and transparent	Input	FCC1: HDLC Serial and Transparent Receive Data Bit The RXD serial bit is supported by HDLC and transparent by FCC1.

Table 1-7. Port A Signals (Continued)

	Name		
General- Purpose I/O	Peripheral Controller: Dedicated Signal Protocol	I/O Data Direction	Description
PA16	FCC1: RXD6 UTOPIA	Input	FCC1: UTOPIA Receive Data Bit 6.  RXD[0–7] is part of the ATM UTOPIA interface supported by FCC1. The MSC8101 inputs ATM cell octets (UTOPIA interface data) on RXD[0–7]. RXD7 is the most significant bit. RXD0 is the least significant bit. When no ATM data is available, idle cells are inserted. A cell is 53 bytes. To support Multi-PHY configurations, RXD[0–7] is tri-stated, enabled only when RXENB is asserted.
	FCC1: RXD1 MII and HDLC nibble	Input	FCC1: MII and HDLC Nibble Receive Data Bit 1 RXD[3–0] is supported by MII and HDLC nibble mode in FCC1. RXD3 is the most significant bit. RXD0 is the least significant bit.
PA15	FCC1: RXD5 UTOPIA	Input	FCC1: UTOPIA Receive Data Bit 5 In the ATM UTOPIA interface supported by FCC1. The MSC8101 inputs ATM cell octets (UTOPIA interface data) on RXD[0–7]. RXD7 is the most significant bit. RXD0 is the least significant bit. When no ATM data is available, idle cells are inserted. A cell is 53 bytes. To support Multi-PHY configurations, RXD[0–7] is tri-stated, enabled only when RXENB is asserted.
	RXD2 MII and HDLC nibble	Input	FCC1: MII and HDLC Nibble Receive Data Bit 2 RXD[3–0] is supported by MII and HDLC nibble mode in FCC1. RXD3 is the most significant bit. RXD0 is the least significant bit.
PA14	FCC1: RXD4 UTOPIA	Input	FCC1: UTOPIA Receive Data Bit 4. In the ATM UTOPIA interface supported by FCC1. The MSC8101 inputs ATM cell octets (UTOPIA interface data) on RXD[0–7]. RXD7 is the most significant bit. RXD0 is the least significant bit. When no ATM data is available, idle cells are inserted. A cell is 53 bytes. To support Multi-PHY configurations, RXD[0–7] is tri-stated, enabled only when RXENB is asserted.
	FCC1: RXD3 MII and HDLC nibble	Input	FCC1: MII and HDLC Nibble Receive Data Bit 3 RXD[3–0] is supported by MII and HDLC nibble mode in FCC1. RXD3 is the most significant bit. RXD0 is the least significant bit.
PA13	FCC1: RXD3 UTOPIA	Input	FCC1: UTOPIA Receive Data Bit 3 In the ATM UTOPIA interface supported by FCC1. The MSC8101 inputs ATM cell octets (UTOPIA interface data) on RXD[0–7]. RXD7 is the most significant bit. RXD0 is the least significant bit. A cell is 53 bytes. To support Multi-PHY configurations, RXD[0–7] is tri-stated, enabled only when RXENB is asserted.
	SDMA: MSNUM2	Output	Module Serial Number Bit 2 MSNUM[0-4] is the sub-block code of the current peripheral controller using SDMA. MSNUM5 indicates which section, transmit (0) or receive (1), is active during the transfer.

Table 1-7. Port A Signals (Continued)

	Name		
General- Purpose I/O	Peripheral Controller: Dedicated Signal Protocol	Dedicated I/O Data Direction	Description
PA12	FCC1: RXD2 UTOPIA	Input	In the ATM UTOPIA Receive Data Bit 2 In the ATM UTOPIA interface supported by FCC1. The MSC8101 inputs ATM cell octets (UTOPIA interface data) on RXD[0–7]. RXD7 is the most significant bit. RXD0 is the least significant bit. A cell is 53 bytes. To support Multi-PHY configurations, RXD[0–7] is tri-stated, enabled only when RXENB is asserted.
	SDMA: MSNUM3	Output	Module Serial Number Bit 3 MSNUM[0-4] of is the sub-block code of the current peripheral controller using SDMA. MSNUM5 indicates which section, transmit (0) or receive (1), is active during the transfer.
PA11	FCC1: RXD1 UTOPIA	Input	FCC1: UTOPIA RX Receive Data Bit 1 In the ATM UTOPIA interface supported by FCC1. The MSC8101 inputs ATM cell octets (UTOPIA interface data) on RXD[0–7]. RXD7 is the most significant bit. RXD0 is the least significant bit. A cell is 53 bytes. To support Multi-PHY configurations, RXD[0–7] is tri-stated, enabled only when RXENB is asserted.
	SDMA: MSNUM4	Output	Module Serial Number Bit 4 MSNUM[0-4] of is the sub-block code of the current peripheral controller using SDMA. MSNUM5 indicates which section, transmit (0) or receive (1) is active during the transfer.
PA10	FCC1: RXD0 UTOPIA	Input	FCC1: UTOPIA RX Receive Data Bit 0 In the ATM UTOPIA interface supported by FCC1. The MSC8101 inputs ATM cell octets (UTOPIA interface data) on RXD[0–7]. RXD7 is the most significant bit. RXD0 is the least significant bit. A cell is 53 bytes. To support Multi-PHY configurations, RXD[0–7] is tri-stated, enabled only when RXENB is asserted.
	SDMA: MSNUM5	Output	Module Serial Number Bit 5 MSNUM[0-4] of is the sub-block code of the current peripheral controller using SDMA. MSNUM5 indicates which section, transmit (0) or receive (1), is active during the transfer.
PA9	SMC2: SMTXD	Output	SMC2: Serial Management Transmit Data Supported by SMC2. The SMC interface consists of SMTXD, SMRXD, SMSYN, and a clock. Not all signals are used for all applications. SMCs are full-duplex ports that supports three protocols or modes: UART, transparent, or general-circuit interface (GCI). See also PC15.
	SI1 TDMA1: L1TXD0 TDM nibble	Output	Time-Division Multiplexing A1: Layer 1 Transmit Data Bit 0 In the TDMA1 interface supported by SI1. L1TXD3 is the most significant bit. L1TXD0 is the least significant bit in nibble mode. TDMA1 transmits nibble data out L1TXD[0-3].

Table 1-7. Port A Signals (Continued)

Name		D. B. di	
General- Purpose I/O	Peripheral Controller: Dedicated Signal Protocol	Dedicated I/O Data Direction	Description
PA8	SMC2: SMRXD	Input	SMC2: Serial Management Receive Data Supported by SMC2. The SMC interface consists of SMTXD, SMRXD, SMSYN, and a clock. Not all signals are used for all applications. SMCs are full-duplex ports that supports three protocols or modes: UART, transparent, or general-circuit interface (GCI).
	SI1 TDMA1: L1RXD0 TDM nibble	Input	Time-Division Multiplexing A1: Layer 1 Nibble Receive Data Bit 0 In the TDMA1 interface supported by SI1. L1RXD3 is the most significant bit. L1RXD0 is the least significant bit in nibble mode. TDMA1 receives nibble data from L1RXD[0–3].
	SI1 TDMA1: L1RXD TDM serial	Input	Time-Division Multiplexing A1: Layer 1 Serial Receive Data In the TDMA1 interface supported by SI1. TDMA1 receives serial data from L1RXD.
PA7	SMC2: SMSYN	Input	SMC2: Serial Management Synchronization The SMC interface consists of SMTXD, SMRXD, SMSYN, and a clock. Not all signals are used for all applications. SMCs are full-duplex ports that supports three protocols or modes: UART, transparent, or general-circuit interface (GCI).
	SI1 TDMA1: L1TSYNC TDM nibble and TDM serial	Input	Time-Division Multiplexing A1: Layer 1 Transmit Synchronization In the TDMA1 interface supported by SI1, this is the synchronizing signal for the transmit channel. See the Serial Interface with Time-Slot Assigner chapter in the MSC8101 Technical Reference manual.
PA6	SI1 TDMA1: L1RSYNC TDM nibble and TDM serial	Input	Time-Division Multiplexing A1: Layer 1 Receive Synchronization.  In the TDMA1 interface supported by SI1, this is the synchronizing signal for the receive channel.

# 1.7.2 Port B Signals

Table 1-8. Port B Signals

Name		D. die ete d	
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	Dedicated I/O Data Direction	Description
PB31	FCC2: TX_ER MII	Output	FCC2: Media Independent Interface Transmit Error In the MII interface supported by FCC2. TX_ER is asserted by the MSC8101 to force propagation of transmit errors.
	SCC2: RXD	Input	SCC2: Receive Data Supported by SCC2. SCC2 receives serial data from RXD.
	SI2 TDMB2: L1TXD TDM serial	Output	Time-Division Multiplexing B2: Layer 1 Transmit Data In the TDMB2 interface supported by SI2. L1TXD supports serial mode. TDMB2 transmits serial data out of L1TXD.
PB30	SCC2: TXD	Output	SCC2: Transmit Data. Supported by SCC2. SCC2 transmits serial data out of TXD.
	FCC2: RX_DV	Input	FCC2: Media Independent Interface Receive Data Valid In the MII interface supported by FCC2, RX_DV is asserted by an external fast Ethernet PHY. RX_DV indicates that valid data is being sent. The presence of carrier sense, but not RX_DV, indicates reception of broken packet headers, probably due to bad wiring or a bad circuit.
	SI2 TDMB2: L1RXD TDM serial	Input	Time-Division Multiplexing B2: Layer 1 Receive Data In the TDMB2 interface supported by SI2. L1RXD supports serial mode. TDMB2 receives serial data from L1RXD.
PB29	FCC2: TX_EN MII	Output	FCC2: Media Independent Interface Transmit Enable In the MII interface supported by FCC2. TX_EN is asserted by the MSC8101 when transmitting data.
	SI2 TDMB2: L1RSYNC TDM serial	Input	Time-Division Multiplexing B2: Layer 1 Receive Synchronization In the TDMB2 interface supported by SI2, this is the synchronizing signal for the receive channel.

Table 1-8. Port B Signals (Continued)

Name		Dadiastad	
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	Dedicated I/O Data Direction	Description
PB28	FCC2: RTS HDLC serial, HDLC nibble, and transparent	Output	PCC2: Request to Send  One of the standard modem interface signals supported by FCC2 (RTS, CTS, and CD). RTS is asynchronous with the data. RTS is typically used in conjunction with CD. The MSC8101 FCC2 transmitter requests the receiver to send data by asserting RTS low. The request is accepted when CTS is returned low.
	FCC2: RX_ER MII	Input	FCC2: Media Independent Interface Receive Error In the MII interface supported by FCC2, RX_ER is asserted by an external fast Ethernet PHY. This signal indicates a receive error, which often indicates bad wiring.
	SCC2: RTS, TENA	Output	SCC2: Request to Send, Transmit Enable Typically used in conjunction with CD supported by SCC2. The MSC8101 SCC2 transmitter requests the receiver to send data by asserting RTS low. The request is accepted when CTS is returned low. TENA is the signal used in Ethernet mode.
	SI2 TDMB2: L1TSYNC TDM serial	Input	Time-Division Multiplexing B2: Layer 1 Transmit Synchronization In the TDMB2 interface supported by SI2, this is the synchronizing signal for the transmit channel. See the Serial Interface with Time-Slot Assigner chapter in the MSC8101 Technical Reference manual.
PB27	FCC2: COL MII	Input	FCC2: Media Independent Interface Collision Detect In the MII interface supported by FCC2. COL is asserted by an external fast Ethernet PHY.
	SI2 TDMC2: L1TXD TDM serial	Output	Time-Division Multiplexing C2: Layer 1 Transmit Data In the TDMC2 interface supported by SI2. L1TXD supports serial mode. TDMC2 transmits serial data out of L1TXD.
PB26	FCC2: CRS MII	Input	FCC2: Media Independent Interface Carrier Sense Input In the MII interface, CRS is asserted by an external fast Ethernet PHY. This signal indicates activity on the cable.
	SI2 TDMC2: L1RXD TDM serial	Input	Time-Division Multiplexing C2: Layer 1 Receive Data In the TDMC2 interface supported by SI2. L1RXD supports serial mode. TDMC2 receives serial data from L1RXD.

Table 1-8. Port B Signals (Continued)

Name		B	
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	Dedicated I/O Data Direction	Description
PB25	FCC2: TXD3 MII and HDLC nibble	Output	FCC2: MII and HDLC Nibble Transmit Data Bit 3 Supported by MII and HDLC nibble mode in FCC2. TXD3 is the most significant bit. TXD0 is the least significant bit.
	SI1 TDMA1: L1TXD3 TDM nibble	Output	Time-Division Multiplexing A1: Nibble Layer 1 Transmit Data Bit 3  TDMA1 transmits nibble data out of L1TXD[0–3]. L1TXD3 is the most significant bit and L1TXD0 is the least significant bit in nibble mode.
	SI2 TDMC2: L1TSYNC TDM serial	Input	Time-Division Multiplexing C2: Layer 1 Transmit Synchronization In the TDMC2 interface supported by SI2, this is the synchronizing signal for the transmit channel. See the Serial Interface with Time-Slot Assigner chapter in the MSC8101 Technical Reference manual.
PB24	FCC2: TXD2 MII and HDLC nibble	Output	FCC2: MII and HDLC Nibble: Transmit Data Bit 2 Supported by MII and HDLC nibble mode in FCC2. TXD3 is the most significant bit. TXD0 is the least significant bit.
	SI1 TDMA1: L1RXD3 nibble	Input	Time-Division Multiplexing A1: Nibble Layer 1 Receive Data Bit 3  TDMA1 receives nibble data into L1RXD[0–3]. L1RXD3 is the most significant bit and L1RXD0 is the least significant bit in nibble mode.
	SI2 TDMC2: L1RSYNC serial	Input	Time-Division Multiplexing C2: Layer 1 Receive Synchronization In the TDMC2 interface supported by SI2, this is the synchronizing signal for the receive channel.
PB23	FCC2: TXD1 MII and HDLC nibble	Output	FCC2: MII and HDLC Nibble: Transmit Data Bit 1 Supported by MII and HDLC nibble mode in FCC2. TXD3 is the most significant bit. TXD0 is the least significant bit.
	SI1 TDMA1: L1RXD2 TDM nibble	Input	Time-Division Multiplexing A1: Nibble Layer 1 Receive Data Bit 2 In the TDMA1 interface supported by SI1. TDMA1 supports bit and nibble modes. L1RXD3 is the most significant bit. L1RXD0 is the least significant bit in nibble mode. TDMA1 receives nibble data from L1RXD[0–3].
	SI2 TDMD2: L1TXD TDM serial	Output	Time-Division Multiplexing D2: Layer 1 Transmit Data In the TDMD2 interface supported by SI2. L1TXD supports serial mode. TDMA1 transmits serial data out of L1TXD.

Table 1-8. Port B Signals (Continued)

Name		Dadiastad	
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	I/O Data Direction	Description
PB22	FCC2: TXD0 MII and HDLC nibble	Output	FCC2: MII and HDLC Nibble Transmit Data Bit 0 TXD[0–3] is supported by MII and HDLC nibble mode in FCC2. TXD3 is the most significant bit. TXD0 is the least significant bit.
	FCC2: TXD HDLC serial and transparent	Output	FCC2: HDLC Serial and Transparent Transmit Data TXD is supported by HDLC serial mode and transparent mode in FCC2.
	SI1 TDMA1: L1RXD1 TDM nibble	Input	Time-Division Multiplexing A1: Nibble Layer 1 Receive Data Bit 1 In the TDMA1 interface supported by SI1. TDMA1 supports bit and nibble modes. L1RXD3 is the most significant bit. L1RXD0 is the least significant bit in nibble mode. TDMA1 receives nibble data from L1RXD[0–3].
	SI2 TDMD2: L1RXD TDM serial	Input	Time-Division Multiplexing D2: Layer 1 Receive Data In the TDMD2 interface supported by SI2. TDMD2 supports serial mode. TDMD2 receives serial data from L1RXD.
PB21	FCC2: RXD0 MII and HDLC nibble	Input	FCC2: MII and HDLC Nibble Receive Data Bit 0 RXD[0-3] is supported by MII and HDLC nibble mode in FCC2. RXD3 is the most significant bit. RXD0 is the least significant bit.
	FCC2: RXD HDLC serial and transparent	Input	FCC2: HDLC Serial and Transparent Receive Data Supported by HDLC serial mode and transparent mode in FCC2.
	SI1 TDMA1: L1TXD2 TDM nibble	Output	Time-Division Multiplexing A1: Nibble Layer 1 Transmit Data Bit 2 In the TDMA1 interface supported by SI1. TDMA1 supports bit and nibble modes. L1TXD3 is the most significant bit. L1TXD0 is the least significant bit in nibble mode. TDMA1 transmits nibble data out of L1TXD[0–3].
	SI2 TDMD2: L1TSYNC TDM serial	Input	Time-Division Multiplexing D2: Layer 1 Transmit Synchronize Data In the TDMD2 interface supported by SI2, this is the synchronizing signal for the transmit channel. See the Serial Interface with Time-Slot Assigner chapter in the MSC8101 Technical Reference manual.

Table 1-8. Port B Signals (Continued)

Name		5 "	
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	Dedicated I/O Data Direction	Description
PB20	FCC2: RXD1 MII and HDLC nibble	Input	FCC2: MII and HDLC Nibble: Receive Data Bit 1 RXD[0-3] is supported by MII and HDLC nibble mode in FCC2. RXD3 is the most significant bit. RXD0 is the least significant bit.
	SI1 TDMA1: L1TXD1 TDM nibble	Output	Time-Division Multiplexing A1: Nibble Layer 1 Transmit Data Bit 1 In the TDMA1 interface supported by SI1. TDMA1 supports bit and nibble modes. L1TXD3 is the most significant bit. L1TXD0 is the least significant bit in nibble mode. TDMA1 transmits nibble data out of L1TXD[0–3].
	SI2 TDMD2: L1RSYNC TDM serial	Input	Time-Division Multiplexing D2: Layer 1 Receive Synchronize Data In the TDMD2 interface supported by SI2, this is the synchronizing signal for the receive channel.
PB19	FCC2: RXD2 MII and HDLC nibble	Input	FCC2: MII and HDLC Nibble Receive Data Bit 2 RXD[0-3] is supported by MII and HDLC nibble mode in FCC2. RXD3 is the most significant bit. RXD0 is the least significant bit.
	I <sup>2</sup> C: SDA	Input/ Output	I <sup>2</sup> C: Inter-Integrated Circuit Serial Data The I <sup>2</sup> C interface comprises two signals: serial data (SDA) and serial clock (SDA). The I <sup>2</sup> C controller uses a synchronous, multimaster bus that can connect several integrated circuits on a board. Clock rates run up to 520 kHz@25 MHz system clock.
PB18	FCC2: RXD3 MII and HDLC nibble	Input	FCC2: MII and HDLC Nibble Receive Data Bit 3 RXD[0-3] is supported by MII and HDLC nibble mode in FCC2. RXD3 is the most significant bit. RXD0 is the least significant bit.
	I <sup>2</sup> C: SCL	Input/ Output	I <sup>2</sup> C: Inter-Integrated Circuit Serial Clock The I <sup>2</sup> C interface comprises two signals: serial data (SDA) and serial clock (SDA). The I <sup>2</sup> C controller uses a synchronous, multimaster bus that can connect several integrated circuits on a board. Clock rates run up to 520 kHz@25 MHz system clock.

# 1.7.3 Port C Signals

Table 1-9. Port C Signals

Name		Dadiant	
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	I/O Data Direction	Description
PC31	BRG1O	Output	Baud-Rate Generator 1 Output The CPM supports up to 8 BRGs. The BRGs can be used internally by the bank-of-clocks selection logic and/or provide an output to one of the 8 BRG pins. BRG1O can be the internal input to the SIU timers. When CLK5 is selected (see PC27 below), it is the source for BRG1O which is the default input for the SIU timers. See the <i>System Interface Unit (SIU)</i> chapter in the <i>MSC8101 Technical Reference</i> manual for additional information. If CLK5 is not enabled, BRG1O uses an internal input. If TMCLK is enabled (see PC26 below), the BRG1O input to the SIU timers is disabled.
	CLK1	Input	Clock 1 The CPM supports up to 10 clock input pins. The clocks are sent to the bank-of-clocks selection logic, where they can be routed to the controllers.
	TIMER1/2: TGATE1	Input	Timer 1/2: Timer Gate 1 The timers can be gated/restarted by an external gate signal. There are two gate signals: TGATE1 controls timer 1 and/or 2 and TGATE2 controls timer 3 and/or 4.
PC30	BRG2O	Output	Baud-Rate Generator 2 Output The CPM supports up to 8 BRGs. The BRGs can be used internally by the bank-of-clocks selection logic and/or provide an output to one of the 8 BRG pins.
	CLK2	Input	Clock 2 The CPM supports up to 10 clock input pins. The clocks are sent to the bank-of-clocks selection logic, where they can be routed to the controllers.
	Timer1: TOUT1	Output	Timer 1: Timer Out 1  The timers (Timer[1–4]) can output a signal on a timer output (TOUT[1–4]) when the reference value is reached. This signal can be an active-low pulse or a toggle of the current output. The output can also connect internally to the input of another timer, resulting in a 32-bit timer.
	EXT1	Input	External Request 1  External request input line 1 asserts an internal request to the CPM processor. The signal can be programmed as level- or edge-sensitive, and also has programmable priority. Refer to the RISC Controller Configuration Register (RCCR) description in the Chapter 17 of the MSC8101 Reference Manual for programming information. There are no current microcode applications for this request line. It is reserved for future development.

Table 1-9. Port C Signals (Continued)

Name			
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	I/O Data Direction	Description
PC29	BRG3O	Output	Baud-Rate Generator 3 Output The CPM supports up to 8 BRGs. The BRGs can be used internally by the bank-of-clocks selection logic and/or provide an output to one of the 8 BRG pins.
	CLK3	Input	Clock 3 The CPM supports up to 10 clock input pins. The clocks are sent to the bank-of-clocks selection logic, where they can be routed to the controllers.
	TIN2	Input	Timer Input 2  A timer can have one of the following sources: another timer, system clock, system clock divided by 16 or a timer input. The CPM supports up to 4 timer inputs. The timer inputs can be captured on the rising, falling or both edges.
	SCC1: CTS, CLSN	Input	SCC1: Clear to Send, Collision Typically used in conjunction with RTS. The MSC8101 SCC1 transmitter sends out a request to send data signal (RTS). The request is accepted when CTS is returned low. CLSN is the signal used in Ethernet mode. See also PC15.
PC28	BRG4O	Output	Baud-Rate Generator 4 Output The CPM supports up to 8 BRGs. The BRGs can be used internally by the bank-of-clocks selection logic and/or provide an output to one of the 8 BRG pins.
	CLK4	Input	Clock 4 The CPM supports up to 10 clock input pins. The clocks are sent to the bank-of-clocks selection logic, where they can be routed to the controllers.
	TIN1	Input	Timer Input 1 A timer can have one of the following sources: another timer, system clock, system clock divided by 16 or a timer input. The CPM supports up to 4 timer inputs. The timer inputs can be captured on the rising, falling or both edges.
	Timer2: TOUT2	Output	Timer 2: Timer Output 2  The timers (Timer[1–4]) can output a signal on a timer output (TOUT[1–4]) when the reference value is reached. This signal can be an active-low pulse or a toggle of the current output. The output can also be connected internally to the input of another timer, resulting in a 32-bit timer.
	SCC2: CTS, CLSN	Input	SCC2: Clear to Send, Collision Typically used in conjunction with RTS. The MSC8101 SCC2 transmitter sends out a request to send data signal (RTS). The request is accepted when CTS is returned low. CLSN is the signal used in Ethernet mode. See also PC13.

Table 1-9. Port C Signals (Continued)

	Name		
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	Dedicated I/O Data Direction	Description
PC27	BRG5O	Output	Baud-Rate Generator 5 Output The CPM supports up to 8 BRGs. The BRGs can be used internally by the bank-of-clocks selection logic and/or provide an output to one of the 8 BRG pins.
	CLK5	Input	Clock 5 When selected, CLK5 is a source for the SIU timers via BRG1O. See the System Interface Unit (SIU) chapter in the MSC8101 Technical Reference manual for additional information. If CLK5 is not enabled, BRG1O uses an internal input. If TMCLK is enabled (see PC26 below), the BRG1O input to the SIU timers is disabled.
	TIMER3/4: TGATE2	Input	Timer 3/4: Timer Gate 2 The timers can be gated/restarted by an external gate signal. There are two gate signals: TGATE1 controls timer 1 and/or 2 and TGATE2 controls timer 3 and/or 4.
PC26	BRG6O	Output	Baud-Rate Generator 6 Output The CPM supports up to 8 BRGs. The BRGs can be used internally by the bank-of-clocks selection logic and/or provide an output to one of the 8 BRG pins.
	CLK6	Input	Clock 6 The CPM supports up to 10 clock input pins. The clocks are sent to the bank-of-clocks selection logic, where they can be routed to the controllers.
	Timer3: TOUT3	Output	Timer 3: Timer Out 3 The timers (Timer[1–4]) can output a signal on a timer output (TOUT[1–4]) when the reference value is reached. This signal can be an active-low pulse or a toggle of the current output. The output can also connect internally to the input of another timer, resulting in a 32-bit timer.
	TMCLK	Input	Timer Clock When selected, TMCLK is the designated input to the SIU timers. When TMCLK is configured as the input to the SIU timers, the BRG1O input is disabled. See the System Interface Unit (SIU) chapter in the MSC8101 Technical Reference manual for additional information.

Table 1-9. Port C Signals (Continued)

	Name		
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	I/O Data Direction	Description
PC25	BRG7O	Output	Baud-Rate Generator 7 Output The CPM supports up to 8 BRGs. The BRGs can be used internally by the bank-of-clocks selection logic and/or provide an output to one of the 8 BRG pins.
	CLK7	Input	Clock 7 The CPM supports up to 10 clock input pins. The clocks are sent to the bank-of-clocks selection logic, where they can be routed to the controllers.
	TIN4	Input	Timer Input 4  A timer can have one of the following sources: another timer, system clock, system clock divided by 16 or a timer input. The CPM supports up to 4 timer inputs. The timer inputs can be captured on the rising, falling or both edges.
	DMA: DACK2	Output	DMA: Data Acknowledge 2  DACK2, DREQ2, DRACK2 and DONE2 belong to the SIU  DMA. DONE2 and DRACK2 are signals on the same pin and therefore cannot be used simultaneously. There are two sets of DMA pins associated with the PIO ports.
PC24	BRG8O	Output	Baud-Rate Generator 8 Output The CPM supports up to 8 BRGs. The BRGs can be used internally by the bank-of-clocks selection logic and/or provide an output to one of the 8 BRG pins.
	CLK8	Input	Clock 8 The CPM supports up to 10 clock input pins. The clocks are sent to the bank-of-clocks selection logic, where they can be routed to the controllers.
	TIN3	Input	Timer Input 3  A timer can have one of the following sources: another timer, system clock, system clock divided by 16, or a timer input.  The CPM supports up to four timer inputs. The timer inputs can be captured on the rising, falling, or both edges.
	Timer4: TOUT4	Output	Timer 4: Timer Out 4  The timers (Timer1-4]) can output a signal on a timer output (TOUT[1-4]) when the reference value is reached. This signal can be an active-low pulse or a toggle of the current output. The output can also be connected internally to the input of another timer, resulting in a 32-bit timer.
	DMA: DREQ2	Input	DMA: Data Request 2  DACK2, DREQ2, DRACK2, and DONE2 belong to the SIU  DMA. DONE2 and DRACK2 are signals on the same pin and therefore cannot be used simultaneously. There are two sets of DMA pins associated with the PIO ports.

Table 1-9. Port C Signals (Continued)

	Name		
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	I/O Data Direction	Description
PC23	CLK9	Input	Clock 9 The CPM supports up to 10 clock input pins. The clocks are sent to the bank-of-clocks selection logic, where they can be routed to the controllers.
	DMA: DACK1	Output	DMA: Data Acknowledge 1 DACK1, DREQ1, DRACK1, and DONE1 belong to the SIU DMA. DONE1 and DRACK1 are signals on the same pin and therefore cannot be used simultaneously. There are two sets of DMA pins associated with the PIO ports.
	EXT2	Input	External Request 2  External request input line 2 asserts an internal request to the CPM processor. The signal can be programmed as level- or edge-sensitive, and also has programmable priority. Refer to the RISC Controller Configuration Register (RCCR) description in the Chapter 17 of the MSC8101 Reference Manual for programming information. There are no current microcode applications for this request line. It is reserved for future development.
PC22	SI1: L1ST1	Output	Serial Interface 1: Layer 1 Strobe 1 In the time-slot assigner supported by SI1. The MSC8101 time-slot assigner supports up to four strobe outputs that can be asserted on a bit or byte basis. The strobe outputs are useful for interfacing to other devices that do not support the multiplexed interface or for enabling/disabling three-state I/O buffers in a multiple-transmitter architecture. These strobes can also generate output wave forms for such applications as stepper-motor control.
	CLK10	Input	Clock 10 The CPM supports up to 10 clock input pins. The clocks are sent to the bank-of-clocks selection logic, where they can be routed to the controllers.
	DMA: DREQ1	Input/ Output	DMA: Request 1  DACK1, DREQ1, DRACK1, and DONE1 belong to the SIU  DMA. DONE1 and DRACK1 are signals on the same pin and therefore cannot be used simultaneously. There are two sets of DMA pins associated with the PIO ports.

Table 1-9. Port C Signals (Continued)

	Name		
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	I/O Data Direction	Description
PC15	SMC2: SMTXD	Output	SMC2: Serial Management Transmit Data Supported by SMC2. The SMC interface consists of SMTXD, SMRXD, SMSYN, and a clock. Not all signals are used for all applications. SMCs are full-duplex ports that support three protocols or modes: UART, transparent, or general-circuit interface (GCI). See also PA9.
	SCC1: CTS/CLSN	Input	SCC1: Clear To Send, Collision Typically used in conjunction with RTS. The MSC8101 SCC1 transmitter sends out a request to send data signal (RTS). The request is accepted when CTS is returned low. CLSN is the signal used in Ethernet mode. See also PC29.
	FCC1: TXADDR0 UTOPIA master	Output	FCC1: UTOPIA Master Transmit Address Bit 0 In the ATM UTOPIA master interface supported by FCC1, this is transmit address bit 0.
	FCC1: TXADDR0 UTOPIA slave	Input	FCC1: UTOPIA Slave Transmit Address Bit 0 In the ATM UTOPIA slave interface supported by FCC1, this is transmit address bit 0.
PC14	SI1: L1ST2	Output	Serial Interface 1: Layer 1 Strobe 2 In the time-slot assigner supported by SI1. The MSC8101 time-slot assigner supports up to four strobe outputs that can be asserted on a bit or byte basis. The strobe outputs are useful for interfacing to other devices that do not support the multiplexed interface or for enabling/disabling three-state I/O buffers in a multiple-transmitter architecture. These strobes can also be generate output wave forms for such applications as stepper-motor control.
	SCC1: CD, RENA	Input	SCC1: Carrier Detect, Receive Enable Typically used in conjunction with RTS supported by SCC1. The MSC8101 SCC1 transmitter requests the receiver to send data by asserting RTS low. The request is accepted when CTS is returned low.
	FCC1: RXADDR0 UTOPIA master	Output	FCC1: UTOPIA Multi-PHY Master Receive Address Bit 0 In the ATM UTOPIA master interface supported by FCC1, this is receive address bit 0.
	FCC1: RXADDR0 UTOPIA slave	Input	FCC1: UTOPIA Multi-PHY Slave Receive Address Bit 0 In the ATM UTOPIA slave interface supported by FCC1, this is receive address bit 0.

Table 1-9. Port C Signals (Continued)

Name			
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	I/O Data Direction	Description
PC13	SI1: L1ST4	Output	Serial Interface 1: Layer 1 Strobe 4 In the time-slot assigner supported by SI1. The MSC8101 time-slot assigner supports up to four strobe outputs that can be asserted on a bit or byte basis. The strobe outputs are useful for interfacing to other devices that do not support the multiplexed interface or for enabling/disabling three-state I/O buffers in a multiple-transmitter architecture. These strobes can also generate output wave forms for such applications as stepper-motor control.
	SCC2: CTS,CLSN	Input	SCC2: Clear to Send, Collision Typically used in conjunction with RTS. The MSC8101 SCC2 transmitter sends out a request to send data signal (RTS). The request is accepted when CTS is returned low. CLSN is the signal used in Ethernet mode. See also PC28.
	FCC1:TXADDR1 UTOPIA master	Output	FCC1: UTOPIA Multi-PHY Master Transmit Address Bit 1 In the ATM UTOPIA master interface supported by FCC1, this is transmit address bit 1.
	FCC1: TXADDR1 UTOPIA slave	Input	FCC1: UTOPIA Multi-PHY Slave Transmit Address Bit 1 In the ATM UTOPIA slave interface supported by FCC1, this is transmit address bit 1.
PC12	SI1: L1ST3	Output	Serial Interface 1: Layer 1 Strobe 3 In the time-slot assigner supported by SI1. The MSC8101 time-slot assigner supports up to four strobe outputs that can be asserted on a bit or byte basis. The strobe outputs are useful for interfacing to other devices that do not support the multiplexed interface or for enabling/disabling three-state I/O buffers in a multiple-transmitter architecture. These strobes can also generate output wave forms for such applications as stepper-motor control.
	SCC2: CD, RENA	Input	SCC2: Carrier Detect, Request Enable Typically used in conjunction with RTS supported by SCC2. The MSC8101 SCC2 transmitter requests to the receiver that it sends data by asserting RTS low. The request is accepted when CTS is returned low.
	FCC1: RXADDR1 UTOPIA master	Output	FCC1: UTOPIA Multi-PHY Master Receive Address Bit 1 In the ATM UTOPIA master interface supported by FCC1, this is receive address bit 1.
	FCC1: RXADDR1 UTOPIA slave	Input	FCC1: UTOPIA Multi-PHY Slave Receive Address Bit 1 In the ATM UTOPIA slave interface supported by FCC1, this is receive address bit 1.

Table 1-9. Port C Signals (Continued)

	Name		
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	Dedicated I/O Data Direction	Description
PC7	SI2: L1ST1	Output	Serial Interface 2: Strobe 1 In the time-slot assigner supported by SI2. The MSC8101 time-slot assigner supports up to four strobe outputs that can be asserted on a bit or byte basis. The strobe outputs are useful for interfacing to other devices that do not support the multiplexed interface or for enabling/disabling three-state I/O buffers in a multiple-transmitter architecture. These strobes can also generate output wave forms for such applications as stepper-motor control.
	FCC1: CTS HDLC serial, HDLC nibble, and transparent	Input	FCC1: Clear To Send  In the standard modem interface signals supported by FCC1 (RTS, CTS, and CD). CTS is asynchronous with the data.
	FCC1: TXADDR2 UTOPIA master	Output	FCC1: UTOPIA Multi-PHY Master Transmit Address Bit 2 In the ATM UTOPIA master interface supported by FCC1, this is transmit address bit 2.
	FCC1: TXADDR2 UTOPIA slave	Input	FCC1: UTOPIA Multi-PHY Slave Transmit Address Bit 2 In the ATM UTOPIA slave interface supported by FCC1 using multiplexed polling, this is transmit address bit 2.
	FCC1: TXCLAV1 UTOPIA multi-PHY master, direct polling	Input	FCC1: UTOPIA Multi-PHY Master Transmit Cell Available 1 Direct Polling In the ATM UTOPIA master interface supported by FCC1 using direct polling, TXCLAV1 is asserted by an external UTOPIA slave PHY to indicate that it can accept one complete ATM cell.

Table 1-9. Port C Signals (Continued)

	Name	<b>.</b>	
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	Dedicated I/O Data Direction	Description
PC6	SI2: L1ST2	Output	Serial Interface 2: Layer 1 Strobe 2 In the time-slot assigner supported by SI2. The MSC8101 time-slot assigner supports up to four strobe outputs that can be asserted on a bit or byte basis. The strobe outputs are useful for interfacing to other devices that do not support the multiplexed interface or for enabling/disabling three-state I/O buffers in a multiple-transmitter architecture. These strobes can also generate output wave forms for such applications as stepper-motor control.
	FCC1: CD HDLC serial, HDLC nibble, and transparent	Input	FCC1: Carrier Detect  In the standard modem interface signals supported by FCC1 (RTS, CTS, and CD). CD is an input asynchronous with the data.
	FCC1: RXADDR2 UTOPIA master	Output	FCC1: UTOPIA Multi-PHY Master Receive Address Bit 2 In the ATM UTOPIA master interface supported by FCC1, this is receive address bit 2.
	FCC1: RXADDR2 UTOPIA slave	Input	FCC1: UTOPIA Slave Receive Address Bit 2 In the ATM UTOPIA slave interface supported by FCC1 using multiplexed polling, this is receive address bit 2.
	FCC1: RXCLAV1 UTOPIA multi-PHY master, direct polling	Input	FCC1: UTOPIA Multi-PHY Master Receive Cell Available 1 Direct Polling In the ATM UTOPIA master interface supported by FCC1 using direct polling, RXCLAV1 is asserted by an external PHY when one complete ATM cell is available for transfer.
PC5	SMC1: SMTXD	Output	SMC1: Transmit Data Supported by SMC1. The SMC interface consists of SMTXD, SMRXD, SMSYN, and a clock. Not all signals are used for all applications. SMCs are full-duplex ports that supports three protocols or modes: UART, transparent, or general-circuit interface (GCI).
	SI2: L1ST3	Output	Serial Interface 2: Layer 1 Strobe 3 In the time-slot assigner supported by SI2. The MSC8101 time-slot assigner supports up to four strobe outputs that can be asserted on a bit or byte basis. The strobe outputs are useful for interfacing to other devices that do not support the multiplexed interface or for enabling/disabling three-state I/O buffers in a multiple-transmitter architecture. These strobes can also generate output wave forms for such applications as stepper-motor control.
	FCC2: CTS HDLC serial, HDLC nibble, and transparent	Input	FCC2: Clear To Send In the standard modem interface signals supported by FCC2 (RTS, CTS, and CD). CTS is asynchronous with the data.

Table 1-9. Port C Signals (Continued)

	Name	Dedicated I/O Data Direction	
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol		Description
PC4	SMC1: SMRXD	Input	SMC1: Receive Data Supported by SMC1. The SMC interface consists of SMTXD, SMRXD, SMSYN, and a clock. Not all signals are used for all applications. SMCs are full-duplex ports that supports three protocols or modes: UART, transparent, or general-circuit interface (GCI).
	SI2: L1ST4	Output	Serial Interface 2: Layer 1 Strobe 4 In the time-slot assigner supported by SI2. The MSC8101 time-slot assigner supports up to four strobe outputs that can be asserted on a bit or byte basis. The strobe outputs are useful for interfacing to other devices that do not support the multiplexed interface or for enabling/disabling three-state I/O buffers in a multiple-transmitter architecture. These strobes can also generate output wave forms for such applications as stepper-motor control.
	FCC2: CD HDLC serial, HDLC nibble, and transparent	Input	FCC2: Carrier Detect  In the standard modem interface signals supported by FCC2 (RTS, CTS and CD). CD is asynchronous with the data.

# 1.7.4 Port D Signals

Table 1-10. Port D Signals

	Name		
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	I/O Data Direction	Description
PD31	SCC1: RXD	Input	SCC1: Receive Data Supported by SCC1. SCC1 receives serial data from RXD.
	DMA: DRACK1	Output	DMA: Data Request Acknowledge 1 DACK1, DREQ1, DRACK1, and DONE1 belong to the SIU DMA. DONE1 and DRACK1 are signals on the same pin and therefore cannot be used simultaneously. There are two sets of DMA pins associated with the PIO ports.
	DMA: DONE1	Input/ Output	DMA: Done 1  DACK1, DREQ1, DRACK1, and DONE1 belong to the SIU  DMA. DONE1 and DRACK1 are signals on the same pin and therefore cannot be used simultaneously. There are two sets of DMA pins associated with the PIO ports.
PD30	SCC1: TXD	Output	SCC1: Transmit Data Supported by SCC1. SCC1 transmits serial data out of TXD.
	DMA: DRACK2	Output	DMA: Data Request Acknowledge 2  DACK2, DREQ2, DRACK2, and DONE2 belong to the SIU  DMA. DONE2 and DRACK2 are signals on the same pin and therefore cannot be used simultaneously. There are two sets of DMA pins associated with the PIO ports.
	DMA: DONE2	Input/ Output	DMA: Done 2  DACK2, DREQ2, DRACK2, and DONE2 belong to the SIU  DMA. DONE2 and DRACK2 are signals on the same pin and therefore cannot be used simultaneously. There are two sets of DMA pins associated with the PIO ports.
PD29	SCC1: RTS, TENA	Output	SCC1: Request to Send, Transmit Enable Typically used in conjunction with CD supported by SCC2. The MSC8101 SCC1 transmitter requests the receiver to send data by asserting RTS low. The request is accepted when CTS is returned low. TENA is the signal used in Ethernet mode.
	FCC1: RXADDR3 UTOPIA master	Output	FCC1: UTOPIA Multi-PHY Master Receive Address Bit 3 In the ATM UTOPIA master interface supported by FCC1 using multiplexed polling, this is receive address bit 3.
	FCC1: RXADDR3 UTOPIA slave	Input	FCC1: UTOPIA Slave Receive Address Bit 3 In the ATM UTOPIA slave interface supported by FCC1 using multiplexed polling, this is receive address bit 3.
	FCC1: RXCLAV2 UTOPIA multi-PHY master, direct polling	Input	FCC1: UTOPIA Multi-PHY Master Receive Cell Available 2 Direct Polling In the ATM UTOPIA master interface supported by FCC1 using direct polling, RXCLAV2 is asserted by an external PHY when one complete ATM cell is available for transfer.

 Table 1-10.
 Port D Signals (Continued)

	Name		
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	Dedicated I/O Data Direction	Description
PD19	FCC1: TXADDR4 UTOPIA master	Output	FCC1: Multi-PHY Master Transmit Address Bit 4 Multiplexed Polling In the ATM UTOPIA master interface supported by FCC1 using multiplexed polling, this is transmit address bit 4.
	FCC1: TXADDR4 UTOPIA slave	Input	FCC1: UTOPIA Slave Transmit Address Bit 4 In the ATM UTOPIA slave interface supported by FCC1 using multiplexed polling, this is transmit address bit 4.
	FCC1: TXCLAV3 UTOPIA multi-PHY master, direct polling	Input	FCC1: UTOPIA Multi-PHY master Transmit Cell Available 3 Direct Polling In the ATM UTOPIA master interface supported by FCC1 using direct polling, TXCLAV3 is asserted by an external UTOPIA slave PHY to indicate that it can accept one complete ATM cell.
	BRG1O	Output	Baud Rate Generator 1 Output The CPM supports up to 8 BRGs. The BRGs can be used internally by the bank-of-clocks selection logic and/or provide an output to one of the 8 BRG pins. BRG10 can be the internal input to the SIU timers. When CLK5 is selected (see PC27 above), it is the source for BRG10 which is the default input for the SIU timers. See the System Interface Unit (SIU) chapter in the MSC8101 Technical Reference manual for additional information. If CLK5 is not enabled, BRG10 uses an internal input. If TMCLK is enabled (see PC26 above), the BRG10 input to the SIU timers is disabled.
	SPI: SPISEL	Input	SPI: Select The SPI interface comprises four signals: master out slave in (SPIMOSI), master in slave out (SPIMISO), clock (SPICLK) and select (SPISEL). The SPI can be configured as a slave or master in single- or multiple-master environments. SPISEL is the enable input to the SPI slave. In a multimaster environment, SPISEL (always an input) detects an error when more than one master is operating. SPI masters must output a slave select signal to enable SPI slave devices by using a separate general-purpose I/O signal. Assertion of an SPI SPISEL while it is master causes an error.

Table 1-10. Port D Signals (Continued)

	Name		
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	Dedicated I/O Data Direction	Description
PD18	FCC1: RXADDR4 UTOPIA master	Output	FCC1: UTOPIA Master Receive Address Bit 4 In the ATM UTOPIA master interface supported by FCC1 using multiplexed polling, this is receive address bit 4.
	FCC1: RXADDR4 UTOPIA slave	Input	FCC1: UTOPIA Slave Receive Address Bit 4 In the ATM UTOPIA slave interface supported by FCC1, this is the receive address bit 4.
	FCC1: RXCLAV3 UTOPIA multi-PHY master, direct polling	Input	FCC1: UTOPIA Multi-PHY Master Receive Cell Available 3 Direct Polling In the ATM UTOPIA master interface supported by FCC1 using direct polling, RXCLAV3 is asserted by an external PHY when one complete ATM cell is available for transfer.
	SPI: SPICLK	Input/ Output	SPI: Clock The SPI interface comprises four signals: master out slave in (SPIMOSI), master in slave out (SPIMISO), clock (SPICLK) and select (SPISEL). The SPI can be configured as a slave or master in single- or multiple-master environments. SPICLK is a gated clock, active only during data transfers. Four combinations of SPICLK phase and polarity can be configured. When the SPI is a master, SPICLK is the clock output signal that shifts received data in from SPIMISO and transmitted data out to SPIMOSI.
PD17	BRG2O	Output	Baud Rate Generator 2 Output The CPM supports up to 8 BRGs. The BRGs can be used internally to the MSC8101 and/or provide an output to one of the 8 BRG pins.
	FCC1: RXPRTY UTOPIA	Input	FCC1: UTOPIA Receive Parity In the ATM UTOPIA interface supported by FCC1, this is the odd parity bit for RXD[0-7].
	SPI: SPIMOSI	Input/ Output	SPI: Master Output Slave Input The SPI interface comprises our signals: master out slave in (SPIMOSI), master in slave out (SPIMISO), clock (SPICLK) and select (SPISEL). The SPI can be configured as a slave or master in single- or multiple-master environments. When the SPI is a slave, SPICLK is the clock input that shifts received data in from SPIMOSI and transmitted data out through SPIMISO.
PD16	FCC1: TXPRTY UTOPIA	Output	FCC1: UTOPIA Transmit Parity In the ATM UTOPIA interface supported by FCC1, this is the odd parity bit for TXD[0–7].
	SPI: SPIMISO	Input/ Output	SPI: Master Input Slave Output The SPI interface comprises four signals: master out slave in (SPIMOSI), master in slave out (SPIMISO), clock (SPICLK), and select (SPISEL). The SPI can be configured as a slave or master in single- or multiple-master environments. When the SPI is a slave, SPICLK is the clock input that shifts received data in from SPIMOSI and transmitted data out through SPIMISO.

 Table 1-10.
 Port D Signals (Continued)

Name		Dedicated	
General- Purpose I/O	Peripheral Controller: Dedicated I/O Protocol	I/O Data Direction	Description
PD7	SMC1: SMSYN	Input	SMC1: Serial Management Synchronization Supported by SMC1. SMSYN is an input. The SMC interface consists of SMTXD, SMRXD, SMSYN and a clock. Not all signals are used for all applications. SMCs are full-duplex ports that supports three protocols or modes: UART, transparent or general-circuit interface (GCI).
	FCC1: TXADDR3 UTOPIA master	Output	FCC1: UTOPIA Master Transmit Address Bit 3 In the ATM UTOPIA master interface supported by FCC1 using multiplexed polling, this is transmit address bit 3.
	FCC1: TXADDR3 UTOPIA slave	Input	FCC1: UTOPIA Slave Transmit Cell Available 2 In the ATM UTOPIA slave interface supported by FCC1 using multiplexed polling, this is transmit address bit 3.
	FCC1: TXCLAV2 UTOPIA multi-PHY master, direct polling	Input	FCC1: UTOPIA Multi-PHY Master Transmit Cell Available 2 Direct Polling In the ATM UTOPIA master interface supported by FCC1 using direct polling, TXCLAV2 is asserted by an external UTOPIA slave PHY to indicate that it can accept one complete ATM cell.

## 1.8 JTAG Test Access Port Signals

The MSC8101 supports the standard set of Test Access Port (TAP) signals defined by IEEE 1149.1 Standard Test Access Port and Boundary-Scan Architecture specification and described in **Table 1-11**.

Table 1-11. JTAG Test Access Port Signals

Signal Name	Туре	Signal Description
TCK	Input	Test Clock—A test clock signal for synchronizing JTAG test logic.
TDI	Input	<b>Test Data Input</b> —A test data serial signal for test instructions and data. TDI is sampled on the rising edge of TCK and has an internal pull-up resistor.
TDO	Output	<b>Test Data Output</b> —A test data serial signal for test instructions and data. TDO can be tri-stated. The signal is actively driven in the shift-IR and shift-DR controller states and changes on the falling edge of TCK.
TMS	Input	<b>Test Mode Select</b> —Sequences the test controller's state machine, is sampled on the rising edge of TCK, and has an internal pull-up resistor.
TRST	Input	<b>Test Reset</b> —Asynchronously initializes the test controller, has an internal pull-up resistor, and must be asserted after power up.

# 1.9 Reserved Signals

Table 1-12. Reserved Signals

Signal Name	Туре	Signal Description
TEST	Input	Test Used for manufacturing testing. You must connect this input to GND.
THERM[1-2]	_	Leave disconnected.
SPARE1, 5	_	Spare Pins Leave disconnected for backward compatibility with future revisions of this device.

#### **Reserved Signals**

Specifications

#### Introduction 2.1

This document contains detailed information on power considerations, DC/AC electrical characteristics, and AC timing specifications for the MSC8101 communications processor, mask set 2K87M. For additional information, see the MSC8101 Reference Manual.

### 2.2 Absolute Maximum Ratings

#### **CAUTION**

This device contains circuitry protecting against damage due to high static voltage or electrical fields; however, normal precautions should be taken to avoid exceeding maximum voltage ratings. Reliability is enhanced if unused inputs are tied to an appropriate logic voltage level (for example, either GND or V<sub>CC</sub>).

In calculating timing requirements, adding a maximum value of one specification to a minimum value of another specification does not yield a reasonable sum. A maximum specification is calculated using a worst case variation of process parameter values in one direction. The minimum specification is calculated using the worst case for the same parameters in the opposite direction. Therefore, a "maximum" value for a specification never occurs in the same device with a "minimum" value for another specification; adding a maximum to a minimum represents a condition that can never exist.

**Table 2-1** describes the maximum electrical ratings for the MSC8101.

Symbol Rating Value Unit Core supply voltage<sup>3</sup> ٧  $V_{DD}$ -0.2 to 1.7 PLL supply voltage<sup>3</sup> -0.2 to 1.7 ٧  $V_{CCSYN}$ I/O supply voltage3 -0.2 to 3.6V  $V_{DDH}$ Input voltage<sup>3</sup>  $V_{\text{IN}}$ (GND - 0.2) to 3.6 ٧  $^{\circ}\text{C}$ Maximum operating temperature range<sup>4</sup>  $T_{J}$ -40 to 120 °C Storage temperature range  $T_{STG}$ -55 to +150

**Table 2-1.** Absolute Maximum Ratings<sup>2</sup>

Notes:

- Functional operating conditions are given in Table 2-2.
- Absolute maximum ratings are stress ratings only, and functional operation at the maximum is not guaranteed. Stress beyond the listed limits may affect device reliability or cause permanent damage.
- The input voltage must not exceed the I/O supply V<sub>DDH</sub> by more than 2.5 V at any time, including during power-on reset. In turn, V<sub>DDH</sub> can exceed V<sub>DD</sub>/V<sub>CCSYN</sub> by more than 3.3 V during power-on reset, but for no more than 100 ms.  $V_{DDH}$  should not exceed  $V_{DD}/V_{CCSYN}$  by more than 2.1 V during normal operation. V<sub>DD</sub>/V<sub>CCSYN</sub> must not exceed V<sub>DDH</sub> by more than 0.4 V at any time, including during power-on reset. See Section 4.2, Electrical Design Considerations, on page 4-2 for more information.
- Section 4.1, Thermal Design Considerations, on page 4-1 includes a formula for computing the chip junction temperature (T<sub>.1</sub>).

## 2.3 Recommended Operating Conditions

**Table 2-2** lists recommended operating conditions. Proper device operation outside of these conditions is not guaranteed.

Table 2-2. Recommended Operating Conditions

Rating	Symbol	Value	Unit
SC140 Core supply voltage	V <sub>DD</sub>	250/275 MHz: 1.5 to 1.7 300 MHz: 1.55 to 1.7	V V
PLL supply voltage	V <sub>CCSYN</sub>	250/275 MHz: 1.5 to 1.7 300 MHz: 1.55 to 1.7	V V
I/O supply voltage	V <sub>DDH</sub>	3.135 to 3.465	V
Input voltage	V <sub>IN</sub>	-0.2 to V <sub>DDH</sub> + 0.2	V
Operating temperature range	T <sub>J</sub>	250/275 MHz: -40 to 105 300 MHz: -40 to 75	°C

## 2.4 Thermal Characteristics

**Table 2-3** describes thermal characteristics of the MSC8101.

Table 2-3. Thermal Characteristics

Characteristic	Symbol	Lidded F	Unit		
	<b>5</b> ,5.	Natural Convection	200 ft/min (1 m/s) airflow	) 	
Junction-to-ambient, single-layer board 1, 2	$R_{\theta JA}$ or $\theta_{JA}$	50	37	°C/W	
Junction-to-ambient, four-layer board <sup>1, 3</sup>	$R_{\theta JA}$ or $\theta_{JA}$	22	18	°C/W	
Junction-to-board <sup>3</sup>	$R_{\theta JB}$ or $\theta_{JB}$	15		°C/W	
Junction-to-case <sup>4</sup>	$R_{\theta JC}$ or $\theta_{JC}$	TBD		°C/W	

Notes:

- Junction temperature is a function of on-chip power dissipation, package thermal resistance, mounting site (board) temperature, ambient temperature, air flow, power dissipation of other components on the board, and board thermal resistance.
- 2. Per SEMI G38-87 and EIA/JESD51-2 with the single layer board horizontal.
- 3. Per JEDEC JESD51-6 with the board (JESD51-9) horizontal.
- 4. Thermal resistance between the die and the printed circuit board per JEDEC JESD 51-8. Board temperature is measured on the top surface of the board near the package.
- 5. Thermal resistance between the die and the case top surface without thermal grease. TBD = to be determined. If a thin (less than 50 micron) thermal grease interface is established to a heat sink from the lid, the junction to sink thermal resistance is about 0.7 °C/W.

See Section 4.1, Thermal Design Considerations, on page 4-1 for details on these characteristics.

### 2.5 DC Electrical Characteristics

This section describes the DC electrical characteristics for the MSC8101. The measurements in **Table 2-4** assume the following system conditions:

- $T_J = 0 100 \, ^{\circ}C$
- $V_{DD} = 1.6 \text{ V} \pm 5\% \text{ V}_{DC}$
- $V_{DDH} = 3.3 \text{ V} \pm 5\% \text{ V}_{DC}$
- GND =  $0 V_{DC}$

Note: The leakage current is measured for nominal  $V_{DDH}$  and  $V_{DD}$  or both  $V_{DDH}$  and  $V_{DD}$  must vary in the same direction (for example, both  $V_{DDH}$  and  $V_{DD}$  vary by  $\pm$  5 percent).

Table 2-4. DC Electrical Characteristics

Characteristic	Symbol	Min	Max	Unit
Input high voltage, all inputs except CLKIN	V <sub>IH</sub>	2.0	3.465	V
Input low voltage	V <sub>IL</sub>	GND	0.8	V
CLKIN input high voltage	V <sub>IHC</sub>	2.5	3.465	V
CLKIN input low voltage <sup>1</sup>	V <sub>ILC</sub>	GND	0.8	V
Input leakage current, V <sub>IN</sub> = V <sub>DDH</sub>	I <sub>IN</sub>	_	10	μA
Tri-state (high impedance off state) leakage current, $V_{\rm IN} = V_{\rm DDH}$	I <sub>OZ</sub>	_	10	μΑ
Signal low input current <sup>2</sup> , V <sub>IL</sub> = 0.4 V	ΙL	_	-4.0	mA
Signal high input current <sup>2</sup> , V <sub>IH</sub> = 2.0 V	I <sub>H</sub>	_	4.0	mA
Output high voltage, I <sub>OH</sub> = -2 mA, except open drain pins	V <sub>OH</sub>	2.4	_	V
Output low voltage, I <sub>OL</sub> = 3.2 mA	V <sub>OL</sub>	_	0.4	V

**Notes:** 1. The optimum CLKIN duty cycle is obtained when:  $V_{ILC} = V_{DDH} - V_{IHC}$ .

2. Not tested. Guaranteed by design.

Table 2-5. Typical Power Dissipation

Characteristic	Symbol	Typical	Unit
Core power dissipation at 300 MHz	P <sub>CORE</sub>	450	mW
CPM power dissipation at 200 MHz	P <sub>CPM</sub>	320	mW
SIU power dissipation at 100 MHz	P <sub>SIU</sub>	80	mW
Core leakage power	P <sub>LCO</sub>	3	mW
CPM leakage power	P <sub>LCP</sub>	6	mW
SIU leakage power	P <sub>LSI</sub>	2	mW

### 2.6 Clock Configuration

The following sections provide a general description of clock configuration.

#### 2.6.1 Valid Clock Modes

**Table 2-6** shows the maximum frequency values for each rated core frequency (250, 275, or 300 MHz). The user must ensure that maximum frequency values are not exceeded.

Characteristic **Maximum Frequency in MHz** 250 275 300 Core Frequency CPM Frequency (CPMCLK) 166.67 183.33 200 Bus Frequency (BCLK) 83.33 91.67 100 Serial Communication Controller Clock Frequency (SCLK) 83.33 91.67 100 Baud Rate Generator Clock Frequency (BRGCLK) 83.33 91.67 100 External Clock Output Frequency (CLKOUT) 83.33 91.67 100

Table 2-6. Maximum Frequencies

Six bit values map the MSC8101 clocks to one of the valid configuration mode options. Each option determines the CLKIN, SC140 core, system bus, SCC clock, CPM, and CLKOUT frequencies. The six bit values are derived from three dedicated input pins (MODCK[1–3]) and three bits from the hard reset configuration word (MODCK\_H). To configure the SPLL pre-division factor, SPLL multiplication factor, and the frequencies for the SC140 core, SCC clocks, CPM parallel I/O ports, and system buses, the MODCK[1–3] pins are sampled and combined with the MODCK\_H values when the internal power-on reset (internal PORESET) is deasserted. Clock configuration changes only when the internal PORESET signal is deasserted. The following factors are configured:

- SPLL pre-division factor (SPLL PDF)
- SPLL multiplication factor (SPLL MF)
- Bus post-division factor (Bus DF)
- CPM division factor (CPM DF)
- Core division factor (Core DF)
- CPLL pre-division factor (CPLL PDF)
- CPLL multiplication factor (CPLL MF)

The SCC division factor (SCC DF) is fixed at 4. The BRG division factor (BRG DF) is configured through the System Clock Control Register (SCCR) and can be 4, 16 (default after reset), 64, or 256.

**Note:** Refer to AN2306/D Clock Mode Selection for MSC8101 and MSC8103 Mask Set 2K87M for details on clock configuration.

### 2.6.2 Clocks Programming Model

This section describes the clock registers in detail. The registers discussed are as follows:

- System Clock Control Register (SCCR)
- System Clock Mode Register (SCMR)

#### 2.6.2.1 System Clock Control Register

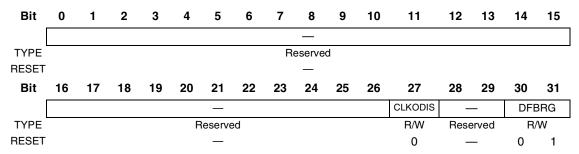


Figure 2-1. System Clock Control Register (SCCR)—0x10C80

The SCCR is memory-mapped into the SIU register map of the MSC8101.

Name	Defa	ults			
Bit No.	PORESET	Hard Reset	Description		Settings
— 0–26			Reserved. Write to 0 fro future compatibility	<b>'</b> .	
CLKODIS 27	0	Unaffected	CLKOUT Disable Disables the CLKOUT signal. The value of CLKOUT when disabled is indeterminate (can be 1 or 0).	0	CLKOUT enabled (default) CLKOUT disabled
— 28–29	_	_	Reserved. Write to 0 fro future compatibility	<i>'</i> .	
<b>DFBRG</b> 30–31	01	Unaffected	Division Factor for the BRG Clock Defines the BRGCLK frequency. Changing this value does not result in a loss of lock condition.	00 01 10 11	Divide by 4 Divide by 16 (default value) Divide by 64 Divide by 256

Table 2-7. SCCR Bit Descriptions

### 2.6.2.2 System Clock Mode Register

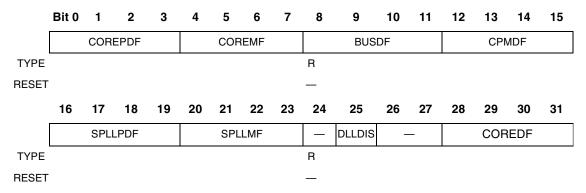


Figure 2-2. System Clock Mode Register (SCMR)—0x10C88

SCMR is a read-only register that is updated during power-on reset (PORESET) and provides the mode control signals to the PLLs, DLL, and clock logic. This register reflects the currently defined configuration settings. For details of the available setting options, see *AN2306/D*.

Table 2-8. SCMR Field Descriptions

Table 2-6. Sown Fleid Descriptions							
Name	Defaults		Description	0-44			
Bit No.	PORESET	Hard Reset	Description	Settings			
COREPDF 0-3	Configuration Pins	Unaffected	Core PLL Pre-Division Factor	0000 CPLL PDF = 1 0001 CPLL PDF = 2 0010 CPLL PDF = 3 0011 CPLL PDF = 4 All other combinations not used.			
COREMF 4–7	Configuration Pins	Unaffected	Core Multiplication Factor	0101 CPLL MF = 10 0110 CPLL MF = 12 0111 CPLL MF = 14 All other combinations not used.			
<b>BUSDF</b> 8–11	Configuration Pins	Unaffected	60x-compatible Bus Division Factor	0001 Bus DF = 2 0010 Bus DF = 3 0011 Bus DF = 4 0100 Bus DF = 5 0101 Bus DF = 6 All other combinations not used.			
<b>CPMDF</b> 12–15	Configuration Pins	Unaffected	CPM Division Factor	0000 CPM DF = 1 0001 CPM DF = 2 0010 CPM DF = 3 All other combinations not used.			
<b>SPLLPDF</b> 16–19	Configuration Pins	Unaffected	SPLL Pre-Division Factor	0000         SPLL PDF = 1           0001         SPLL PDF = 2           0010         SPLL PDF = 3           0011         SPLL PDF = 4           0100         SPLL PDF = 5           0101         SPLL PDF = 6           All other combinations not used			
<b>SPLLMF</b> 20–23	Configuration Pins	Unaffected	SPLL Multiplication Factor	0101 SPLL MF = 10 0110 SPLL MF = 12 0111 SPLL MF = 14 1000 SPLL MF = 16 1001 SPLL MF = 18 1010 SPLL MF = 20 1011 SPLL MF = 22 1100 SPLL MF = 24 1101 SPLL MF = 26 1110 SPLL MF = 28 1111 SPLL MF = 30 All other combinations not used			
 24	_		Reserved				
DLLDIS 25	Configuration Pins	Unaffected	DLL Disable	0 DLL operation is enabled 1 DLL is disabled			
— 26–27	_	_	Reserved				
28–31	Configuration Pins	Unaffected	Core Division Factor	0000         CORE DF = 1           0001         CORE DF = 2           0010         CORE DF = 3           0011         CORE DF = 4           0100         CORE DF = 5           0101         CORE DF = 6           All other combinations not used.			

# 2.7 AC Timings

The following sections include illustrations and tables of clock diagrams, signals, and parallel I/O outputs and inputs. AC timings are based on a 50 pF load, except where noted otherwise, and 50  $\Omega$  transmission line.

### 2.7.1 Output Buffer Impedances

Table 2-9. Output Buffer Impedances

Output Buffers	Typical Impedance ( $\Omega$ )		
System Bus	35		
Memory Controller	35		
Parallel I/O	55		
<b>Note:</b> These are typical values at 65°C. The impedance may vary by ±25% depending on device process a operating temperature.			

### 2.7.2 Clocking and Timing Characteristics

Table 2-10. System Clock Parameters

Characteristic	Minimum	Maximum	Unit
Phase Jitter between BCLK and DLLIN	_	0.5	ns
CLKIN frequency <sup>1,2</sup>	18	75	MHz
CLKIN slope	_	5	ns
DLLIN slope	_	2	ns
CLKOUT frequency jitter	_	(0.01/CLKOUT) + CLKIN jitter	ns
Delay between CLKOUT and DLLIN	_	5	ns

Notes: 1. Low CLKIN frequency causes poor PLL performance. Choose a CLKIN frequency high enough to keep the frequency after the predivider (SPLLMFCLK) higher than 18 MHz.

2. CLKIN should have a 50%  $\pm$  5% duty cycle.

Table 2-11. Clock Ranges

		Maximum Rated Core Frequency				
Clock	Symbol	All	Max. Values for SC140 Clock Rating			
		Min	250 MHz	275 MHz	300 MHz	
Input Clock	CLKIN	18 MHz	83.3	91.67 MHz	100 MHz	
SPLL MF Clock	SPLLMFCLK	18 MHz	31.25	34.38 MHz	37.5 MHz	
Bus/Output	BCLK CLKOUT	18 MHz	83.3 MHz	91.67 MHz	100 MHz	
Serial Communications Controller	SCLK	35 MHz	83.3 MHz	91.67 MHz	100 MHz	
Communications Processor Module	CPMCLK	70 MHz	166.7 MHz	183.3 MHz	200 MHz	
SC140 Core	DSPCLK	72 MHz	250 MHz	275 MHz	300 MHz	

		-	,			
		Maximum Rated Core Frequency				
Clock	Symbol	All	Max. Values	for SC140 Clo	ck Rating of:	
		Min	250 MHz	275 MHz	300 MHz	
Baud Rate Generator	BRGCLK					
• For BRG DF = 4		36 MHz	83.3 MHz	91.67 MHz	100 MHz	
<ul> <li>For BRG DF = 16 (default)</li> </ul>		9 MHz	20.83 MHz	22.91 MHz	25 MHz	
• For BRG DF = 64		2.25 MHz	5.21 MHz	5.73 MHz	6.25 MHz	
<ul> <li>For BRG DF = 256</li> </ul>		562.5 KHz	1.3 MHz	1.43 MHz	1.56 MHz	

Table 2-11. Clock Ranges (Continued)

### 2.7.3 Reset Timing

The MSC8101 has several inputs to the reset logic:

- Power-on reset (PORESET)
- External hard reset (HRESET)
- External soft reset (SRESET)

Asserting an external PORESET causes concurrent assertion of an internal PORESET signal, HRESET, and SRESET. When the external PORESET signal is deasserted, the MSC8101 samples several configuration pins:

- RSTCONF—determines whether the MSC8101 is a master (0) or slave (1) device
- DBREQ—determines whether to operate in normal mode (0) or invoke the SC140 debug mode (1)
- HPE—disable (0) or enable (1) the host port (HDI16)
- BTM[0–1]—boot from external memory (00) or the HDI16 (01)

All these reset sources are fed into the reset controller, which takes different actions depending on the source of the reset. The reset status register indicates the last sources to cause a reset. **Table 2-12** describes reset causes.

Name	Direction	Description
Power-on reset (PORESET)	Input	PORESET initiates the power-on reset flow that resets all the MSC8101s and configures various attributes of the MSC8101, including its clock mode.
Hard reset (HRESET)	Input/Output	The MSC8101 can detect an external assertion of HRESET only if it occurs while the MSC8101 is not asserting reset. During HRESET, SRESET is asserted. HRESET is an open-drain pin.
Soft reset (SRESET)	Input/Output	The MSC8101 can detect an external assertion of SRESET only if it occurs while the MSC8101 is not asserting reset. SRESET is an open-drain pin.

Table 2-12. Reset Causes

### 2.7.3.1 Reset Operation

The reset control logic determines the cause of a reset, synchronizes it if necessary, and resets the appropriate logic modules. The memory controller, system protection logic, interrupt controller, and parallel I/O pins are initialized only on hard reset. Soft reset initializes the internal logic while maintaining the system configuration. The MSC8101 has three mechanisms for reset configuration: host reset configuration, hardware reset configuration, and reduced reset configuration.

#### 2.7.3.2 Power-On Reset Flow

Asserting the  $\overline{\mathsf{PORESET}}$  external pin initiates the power-on reset flow.  $\overline{\mathsf{PORESET}}$  should be asserted externally for at least 16 input clock cycles after external power to the MSC8101 reaches at least 2/3  $V_{CC}$ . As **Table 2-13** shows, the MSC8101 has five configuration pins, four of which are multiplexed with the SC140 core EONCE Event (EE[0–1], EE[4–5]) pins and the fifth of which is the  $\overline{\mathsf{RSTCONF}}$  pin. These pins are sampled at the rising edge of  $\overline{\mathsf{PORESET}}$ . In addition to these configuration pins, three (MODCK[1–3]) pins are sampled by the MSC8101. The signals on these pins and the MODCK\_H value in the Hard Reset Configuration Word determine the PLL locking mode, by defining the ratio between the DSP clock, the bus clocks, and the CPM clock frequencies.

Table 2-13. External Configuration Signals

Pin	Description		Settings
RSTCONF	Reset Configuration Input line sampled by the MSC8101 at the rising edge of PORESET.	0	Reset Configuration Master. Reset Configuration Slave.
DBREQ/ EE0	EONCE Event Bit 0 Input line sampled after SC140 core PLL locks. Holding EE0 high when PORESET is deasserted puts the SC140 core into Debug mode.	0	SC140 core starts the normal processing mode after reset. SC140 core enters Debug mode immediately after reset.
HPE/EE1	Host Port Enable Input line sampled at the rising edge of PORESET. If asserted, the Host port is enabled, the system data bus is 32-bit wide, and the Host <i>must</i> program the reset configuration word.	0	Host port disabled (hardware reset configuration enabled). Host port enabled.
BTM[0-1]/ EE[4-5]	Boot Mode Input lines sampled at the rising edge of PORESET, which determine the MSC8101 Boot mode.	00 01 10 11	MSC8101 boots from external memory. MSC8101 boots from HDI16. Reserved. Reserved.

Table 2-14. Reset Timing

No.	Characteristics	Expression	Min	Max	Unit
1	Required external PORESET duration minimum  CLKIN = 18 MHz  CLKIN = 75 MHz	16 / CLKIN	888.8 213.3		ns ns
2	Delay from deassertion of external PORESET to deassertion of internal PORESET  • CLKIN = 18 MHz  • CLKIN = 75 MHz	1024 / CLKIN		.89 .65	μs μs
3	Delay from deassertion of internal PORESET to SPLL lock  • SPLLMFCLK = 18 MHz  • SPLLMFCLK = 25 MHz	800 / SPLLMFCLK	44.4 32.0		μs μs
4	Delay from SPLL lock to DLL lock  DLL enabled  BCLK = 18 MHz  BCLK = 75 MHz  DLL disabled	3073 / BLCK —	40	).72 .97 .0	μs μs ns
5	Delay from SPLL lock to HRESET deassertion  • DLL enabled  — BCLK = 18 MHz  — BCLK = 75 MHz  • DLL disabled  — BCLK = 18 MHz  — BCLK = 75 MHz	3585 / BLCK 512 / BLCK	47 28	9.17 7.5 3.4 83	µв µв µв

No.	Characteristics	Expression	Min	Max	Unit
6	Delay from SPLL lock to SRESET deassertion				
	DLL enabled	3588 / BLCK			
	— BCLK = 18 MHz		199	.33	μs
	— BCLK = 75 MHz		47	.84	μs
	DLL disabled	515 / BLCK			
	— BCLK = 18 MHz		28	.61	μs
	— BCLK = 75 MHz		6.	87	μs

Table 2-14. Reset Timing (Continued)

#### 2.7.3.3 Host Reset Configuration

Host reset configuration allows the host to program the reset configuration word via the Host port after PORESET is deasserted, as described in the *MSC8101 Reference Manual*. The MSC8101 samples the signals described in **Table 2-13** one the rising edge of PORESET when the signal is deasserted.

If HPE is sampled high, the host port is enabled. In this mode the RSTCONF pin *must* be pulled up. The device extends the internal PORESET until the host programs the reset configuration word register. The host must write four 8-bit half-words to the Host Reset Configuration Register address to program the reset configuration word, which is 32 bits wide. For more information, see the *MSC8101 Reference Manual*. The reset configuration word is programmed before the internal PLL and DLL in the MSC8101 are locked. The host must program it after the rising edge of the PORESET input. In this mode, the host must have its own clock that does not depend on the MSC8101 clock. After the PLL and DLL are locked, HRESET remains asserted for another 512 bus clocks and is then released. The SRESET is released three bus clocks later (see Figure 2-3).

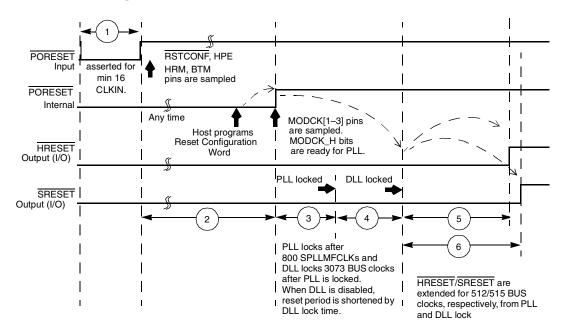


Figure 2-3. Host Reset Configuration Timing

#### 2.7.3.4 Hardware Reset Configuration

Hardware reset configuration is enabled if HPE is sampled low at the rising edge of PORESET. The value driven on RSTCONF while PORESET changes from assertion to deassertion determines the MSC8101 configuration. If RSTCONF is deasserted (driven high) while PORESET changes, the MSC8101 acts as a configuration slave. If RSTCONF is asserted (driven low) while PORESET changes, the MSC8101 acts as a configuration master. Section 2.7.3.4, *Hardware Reset Configuration*, explains the configuration sequence and the terms "configuration master" and "configuration slave."

Directly after the deassertion of PORESET and choice of the reset operation mode as configuration master or configuration slave, the MSC8101 starts the configuration process. The MSC8101 asserts HRESET and SRESET throughout the power-on reset process, including configuration. Configuration takes 1024 CLOCKIN cycles, after which MODCK[1–3] are sampled to determine the MSC8101's working mode.

Next, the MSC8101 halts until the SPLL locks. The SPLL locks according to MODCK[1–3], which are sampled, and to MODCK\_H taken from the Reset Configuration Word. SPLL locking time is 800 reference clocks, which is the clock at the output of the SPLL Pre-divider. After the SPLL is locked, all the clocks to the MSC8101 are enabled. If the DLLDIS bit in the reset configuration word is reset, the DLL starts the locking process after the SPLL is locked. During PLL and DLL locking, HRESET and SRESET are asserted. HRESET remains asserted for another 512 BUS clocks and is then released. The SRESET is released three bus clocks later. If the DLLDIS bit in the reset configuration word is set, the DLL is bypassed and there is no locking process, thus saving the DLL locking time. **Figure 2-4** shows the power-on reset flow.

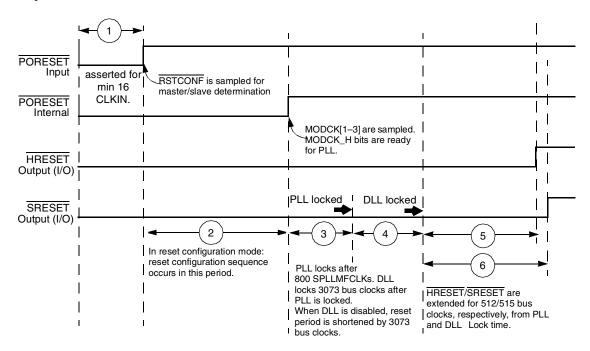


Figure 2-4. Hardware Reset Configuration Timing

### 2.7.4 System Bus Access Timing

#### 2.7.4.1 Core Data Transfers

Generally, all MSC8101 bus and system output signals are driven from the rising edge of the reference clock (REFCLK), which is DLLIN or, if the DLL is disabled, CLKOUT. Memory controller signals, however, trigger on four points within a REFCLK cycle. Each cycle is divided by four internal ticks: T1, T2, T3, and T4. T1 always occurs at the rising edge of REFCLK (and T3 at the falling edge), but the spacing of T2 and T4 depends on the PLL clock ratio selected, as **Table 2-15** shows.

DLL Cleak Datio	Tick Spacing (T1 Occurs at the Rising Edge of REFCLK)				
PLL Clock Ratio	T2	Т3	Т4		
1:2, 1:3, 1:4, 1:5, 1:6	1/4 REFCLK	1/2 REFCLK	3/4 REFCLK		
1:2.5	3/10 REFCLK	1/2 REFCLK	8/10 REFCLK		
1:3.5	4/14 REFCLK	1/2 REFCLK	11/14 REFCLK		

Table 2-15. Tick Spacing for Memory Controller Signals

Figure 2-5 is a graphical representation of Table 2-15.

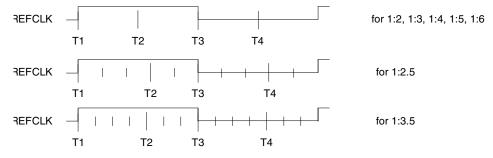


Figure 2-5. Internal Tick Spacing for Memory Controller Signals

**Note:** The UPM machine and GPCM machine outputs change on the internal tick determined by the memory controller programming; the AC specifications are relative to the internal tick. SDRAM machine outputs change only on the REFCLK rising edge.

Table 2-16. AC Timing for SIU Inputs

No.	Characteristic	Value <sup>2</sup>	Units
10	Hold time for all signals after the 50% level of the REFCLK rising edge	0.5	ns
11a	ABB/AACK setup time before the 50% level of the REFCLK rising edge	3.5	ns
11b	DBG/DBB/BR/TC setup time before the 50% level of the REFCLK rising edge	5.0	ns
11c	ARTRY setup time before the 50% level of the REFCLK rising edge	4.0	ns
11d	TA setup time before the 50% level of the REFCLK rising edge  Pipeline mode  Non-pipeline mode	3.5 4.0	ns ns
11e	TEA setup time before the 50% level of the REFCLK rising edge  Pipeline mode  Non-pipeline mode	4.0 3.0	ns ns
11f	PSDVAL setup time before the 50% level of the REFCLK rising edge  • Pipeline mode  • Non-pipeline mode	3.5 3.5	ns ns
11g	TS setup time before the 50% level of the REFCLK rising edge	5.0	ns
11h	BG setup time before the 50% level of the REFCLK rising edge	4.5	ns
12	Data bus setup time before the 50% level of the REFCLK rising edge in Normal  • Pipeline mode  • Non-pipeline mode	2.5 5.0	ns ns
13	Data bus setup time before the 50% level of the REFCLK rising edge in ECC and PARITY modes  • Pipeline mode  • Non-pipeline mode	2.5 8.0	ns ns
14	DP setup time before the 50% level of the REFCLK rising edge  • Pipeline mode  • Non-pipeline mode	4.0 9.0	ns ns
15a	Address bus setup time before the 50% level of the REFCLK rising edge  • Extra cycle mode (SIUBCR[EXDD] = 0)  • Non-extra cycle mode (SIUBCR[EXDD] = 1)	5.0 8.0	ns ns
15b	Address attributes: TT/TBST/TSIZ/GBL setup time before the 50% level of the REFCLK rising edge  Extra cycle mode (SIUBCR[EXDD] = 0)  Non-extra cycle mode (SIUBCR[EXDD] = 1)	5.0 5.5	ns ns
16 <sup>1</sup>	PUPMWAIT/IRQ signals Setup time before the 50% level of the REFCLK rising edge	3.0	ns

Notes:

- The setup time for these signals is for synchronous operation. Any setup time can be used for asynchronous operation.
- Input specifications are measured from the 50% level of the rising edge of REFCLK to the 50% level of the signal. Timings are measured at the pin.

Table 2-17. AC Timing for SIU Outputs

Na	Obavaataviatia	Min	Maximum <sup>2</sup>		Heita
No.	Characteristic	Min.	30 pF	50 pF	Units
31a	TA delay from the 50% level of the REFCLK rising edge Pipeline mode Non-pipeline mode	1.0 1.0	5.0 4.0	6.5 5.5	ns ns
31b	TEA delay from the 50% level of the REFCLK rising edge  Pipeline mode  Non-pipeline mode	1.0 1.0	3.0 3.5	4.5 5.0	ns ns
31c	PSDVAL delay from the 50% level of the REFCLK rising edge  • Pipeline mode  • Non-pipeline mode	1.0 1.0	4.0 3.5	5.5 5.0	ns ns
32a	Address bus delay from the 50% level of the REFCLK rising edge  • Multi master mode (SIUBCR[EBM] = 1)  • Single master mode (SIUBCR[EBM] = 0)	1.0 1.0	6.3 5.5	7.8 7.0	ns ns
32b	Address attributes: TT/TBST/TSIZ/GBL delay from the 50% level of the REFCLK rising edge	1.0	5.5	7.0	ns
32c	BADDR delay from the 50% level of the REFCLK rising edge	1.0	3.5	5.0	ns
33a	Data bus delay from the 50% level of the REFCLK rising edge  • Pipeline mode  • Non-pipeline mode	1.0 1.0	5.0 6.0	6.5 7.5	ns ns
33b	DP delay from the 50% level of the REFCLK rising edge  Pipeline mode  Non-pipeline mode	1.0 1.0	4.0 6.5	5.5 8.0	ns ns
34	Memory controller signals/ALE delay from the 50% level of the REFCLK rising edge	1.0	5.5	7.0	ns
35a	DBG/BR/DBB delay from the 50% level of the REFCLK rising edge	1.0	4.0	5.5	ns
35b	AACK/ABB/CS delay from the 50% level of the REFCLK rising edge	1.0	4.5	6.0	ns
35c	BG delay from the 50% level of the REFCLK rising edge	1.0	4.0	5.5	ns
35d	TS delay from the 50% level of the REFCLK rising edge	1.0	3.5	5.0	ns
36	Delay from the 50% level of the REFCLK rising edge for all other signals	1.0	4.5	6.0	ns

#### Notes: 1.

- 1. The maximum bus frequency depends on the mode:
  - In 60x-compatible mode connected to another MSC8101 device, the frequency is determined by adding the input and output longest timing values, which results in a frequency of 75 MHz for 30 pF output capacitance. In multi-master mode when connected to another MSC8101 device, the frequency is determined by adding the input and output longest timing values, which results in a frequency of 75 MHz for 30 pF output capacitance.
  - Certain bus modes, such as non-extra cycle (EXDD = 1), non-pipelined, and ECC/Parity modes, result in slower bus frequencies.
  - In single-master mode, the frequency depends on the timing of the devices connected to the MSC8101.
- 2. Output specifications are measured from the 50% level of the rising edge of REFCLK to the 50% level of the signal. Timings are measured at the pin.

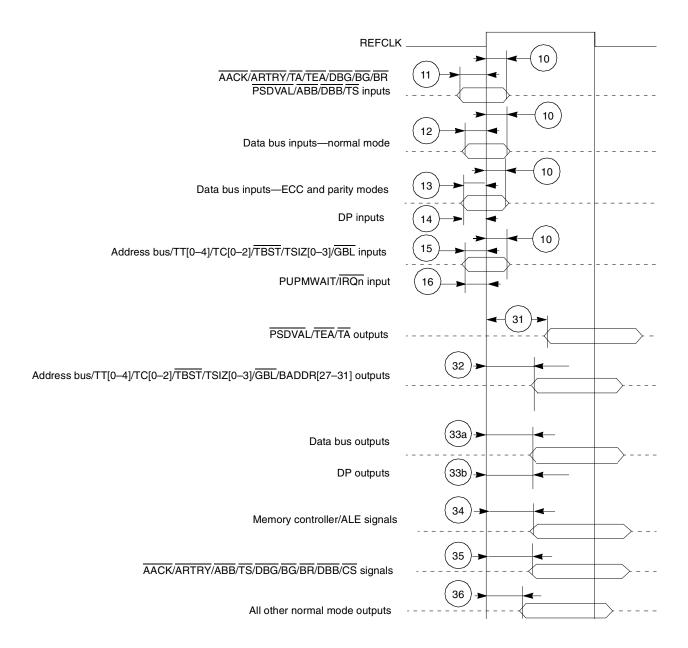


Figure 2-6. Bus Signal Timing

#### 2.7.4.2 DMA Data Transfers

Table 2-18 describes the DMA signal timing.

Table 2-18. DMA Signals

Number	Characteristic	Minimum	Maximum	Units
72	DREQ setup time before REFCLK falling edge	6	_	ns
73	DREQ hold time after REFCLK falling edge	0.5		ns
74	DONE setup time before REFCLK rising edge	9	1	ns
75	DONE hold time after REFCLK rising edge	0.5		ns
76	DACK/DRACK/DONE delay after REFCLK rising edge	0.5	9	ns

The DREQ signal is synchronized with the falling edge of REFCLK. DONE timing is relative to the rising edge of REFCLK. To achieve fast response, a synchronized peripheral should assert DREQ according to the timings in **Table 2-18**. **Figure 2-7** shows synchronous peripheral interaction.

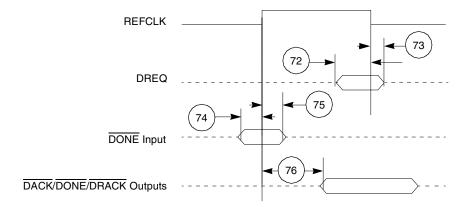


Figure 2-7. DMA Signals

## 2.7.5 HDI16 Signals

Table 2-19. Host Interface (HDI16) Timing 1, 2

Number	Characteristics <sup>3</sup>	Expression	Value	Unit
44a	Read data strobe minimum assertion width <sup>4</sup> HACK read minimum assertion width	$(1.5 \times T_{\rm C}) + 5.0$	Note 11	ns
44b	Read data strobe minimum deassertion width <sup>4</sup> HACK read minimum deassertion width	T <sub>C</sub> + 5.0	Note 11	ns
44c	Read data strobe minimum deassertion width <sup>4</sup> after "Last Data Register" reads <sup>5,6</sup> , or between two consecutive CVR, ICR, or ISR reads <sup>7</sup> HACK minimum deassertion width after "Last Data Register" reads <sup>5,6</sup>	$(2.5 \times T_{C}) + 5.0$	Note 11	ns
45	Write data strobe minimum assertion width <sup>8</sup> HACK write minimum assertion width	$(1.5 \times T_{\rm C}) + 5.0$	Note 11	ns
46	Write data strobe minimum deassertion width <sup>8</sup> HACK write minimum deassertion width after ICR, CVR and Data Register writes <sup>5</sup>	(2.5 × T <sub>C</sub> ) + 5.0	Note 11	ns

Table 2-19. Host Interface (HDI16) Timing<sup>1, 2</sup> (Continued)

Number	Characteristics <sup>3</sup>	Expression	Value	Unit
47	Host data input minimum setup time before write data strobe deassertion <sup>8</sup> Host data input minimum setup time before HACK write deassertion	-	5.0	ns
48	Host data input minimum hold time after write data strobe deassertion <sup>8</sup> Host data input minimum hold time after HACK write deassertion		5.0	ns
49	Read data strobe minimum assertion to output data active from high impedance <sup>4</sup> HACK read minimum assertion to output data active from high impedance	-	5.0	ns
50	Read data strobe maximum assertion to output data valid <sup>4</sup> HACK read maximum assertion to output data valid	$(2.0 \times T_{\rm C}) + 5.0$	Note 11	ns
51	Read data strobe maximum deassertion to output data high impedance <sup>4</sup> HACK read maximum deassertion to output data high impedance	_	5.0	ns
52	Output data minimum hold time after read data strobe deassertion <sup>4</sup> Output data minimum hold time after HACK read deassertion	_	5.0	ns
53	HCS[1-2] minimum assertion to read data strobe assertion <sup>4</sup>	_	5.0	ns
54	HCS[1-2] minimum assertion to write data strobe assertion <sup>8</sup>	_	5.0	ns
55	HCS[1-2] maximum assertion to output data valid	T <sub>C</sub> + 5.0	Note 11	ns
56	HCS[1-2] minimum hold time after data strobe deassertion <sup>9</sup>	_	0.0	ns
57	HA[0-3], HRW minimum setup time before data strobe assertion <sup>9</sup> Read  Write	_	0 5.0	ns ns
58	HA[0-3], HRW minimum hold time after data strobe deassertion <sup>9</sup>	_	5.0	ns
61	Maximum delay from read data strobe deassertion to host request deassertion for "Last Data Register" read <sup>4, 5, 10</sup>	$(3.5 \times T_{C}) + 5.0$	Note 11	ns
62	Maximum delay from write data strobe deassertion to host request deassertion for "Last Data Register" write <sup>5,8,10</sup>	(3.0 × T <sub>C</sub> ) + 5	Note 11	ns
63	Minimum delay from DMA HACK (OAD=0) or Read/Write data strobe(OAD=1) deassertion to HREQ assertion.	$(5.0 \times T_{\rm C}) + 5.0$	Note 11	ns
64	Maximum delay from DMA HACK (OAD=0) or Read/Write data strobe(OAD=1) assertion to HREQ deassertion	$(3.5 \times T_{\rm C}) + 5.0$	Note 11	ns

#### Notes:

- 1.  $T_C = 1/DSPCLK$ . At 300 MHz,  $T_C = 3.3$  ns
- In the timing diagrams below, the controls pins are drawn as active low. The pin polarity is programmable.
- 3.  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ;  $T_J = -40^{\circ}\text{C}$  to  $+100^{\circ}\text{C}$ ,  $C_L = 50 \text{ pF}$
- 4. The read data strobe is HRD/HRD in the dual data strobe mode and HDS/HDS in the single data strobe mode.
- 5. In 64-bit mode, The "last data register" is the register at address \$7, which is the last location to be read or written in data transfers. This is RX0/TX0 in the little endian mode (HBE = 0), or RX3/TX3 in the big endian mode (HBE = 1).
- 6. This timing is applicable only if a read from the "last data register" is followed by a read from the RXL, RXM, or RXH registers without first polling RXDF or HREQ bits, or waiting for the assertion of the HREQ/HREQ signal.
- $\textbf{7.} \quad \text{This timing is applicable only if two consecutive reads from one of these registers are executed.}$
- 8. The write data strobe is HWR in the dual data strobe mode and HDS in the single data strobe mode.
- 9. The data strobe is host read (HRD/HRD) or host write (HWR/HWR) in the dual data strobe mode and host data strobe (HDS/HDS) in the single data strobe mode.
- 10. The host request is HREQ/HREQ in the single host request mode and HRRQ/HRRQ and HTRQ/HTRQ in the double host request mode. HRRQ/HRRQ is deasserted only when HOTX fifo is empty, HTRQ/HTRQ is deasserted only if HORX fifo is full (treat as level Host Request).
- 11. Compute the value using the expression.

**Figure 2-8** and **Figure 2-9** show HDI16 read signal timing. **Figure 2-10** and **Figure 2-11** show HDI16 write signal timing.

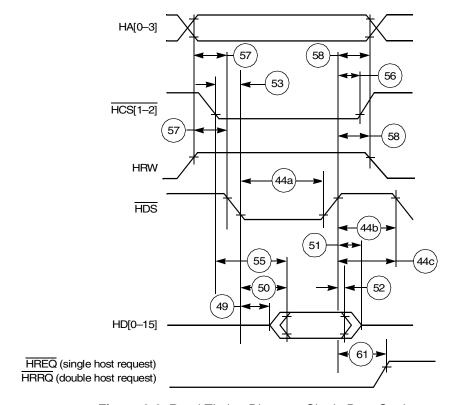


Figure 2-8. Read Timing Diagram, Single Data Strobe

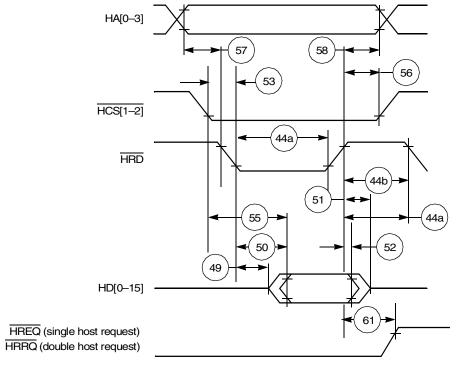


Figure 2-9. Read Timing Diagram, Double Data Strobe

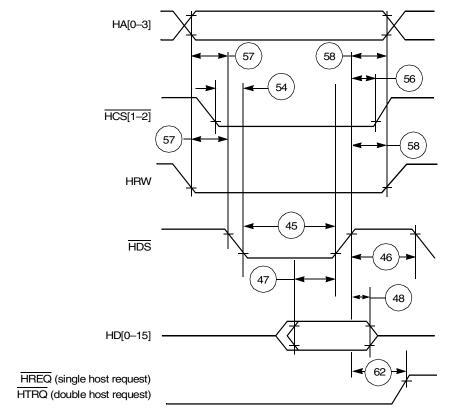


Figure 2-10. Write Timing Diagram, Single Data Strobe

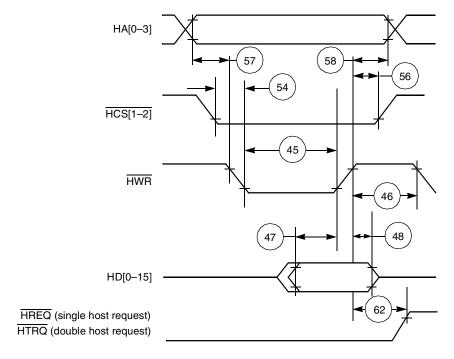


Figure 2-11. Write Timing Diagram, Double Data Strobe

Figure 2-12 shows Host DMA read timing.

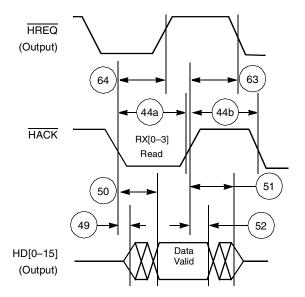


Figure 2-12. Host DMA Read Timing Diagram, HPCR[OAD] = 0

Figure 2-13 shows Host DMA write timing.

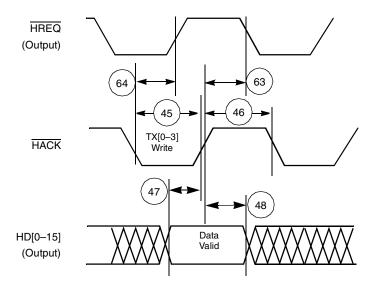


Figure 2-13. Host DMA Write Timing Diagram, HPCR[OAD] = 0

## 2.7.6 CPM Timings

Table 2-20. CPM Input Characteristics

No.	Characteristic	Typical	Unit
39	FCC input setup time before low-to-high clock transition a. internal clock (BRGxO) b. external clock (serial clock input)	10 5	ns ns
17	FCC input hold time after low-to-high clock transition a. internal clock (BRGxO) b. external clock (serial clock input)	0 3	ns ns
18	SCC/SMC/SPI/I <sup>2</sup> C input setup time before low-to-high clock transition a. internal clock (BRGxO) b. external clock (serial clock input)	20 5	ns ns
19	SCC/SMC/SPI/I <sup>2</sup> C input hold time after low-to-high clock transition a. internal clock (BRGxO) b. external clock (serial clock input)	0 5	ns ns
20	TDM input setup time before low-to-high serial clock transition	5	ns
21	TDM input hold time after low-to-high serial transition	5	ns
22	PIO/TIMER/DMA input setup time before low-to-high serial clock transition	10	ns
23	PIO/TIMER/DMA input hold time after low-to-high serial clock transition	3	ns
Note:	FCC, SCC, SMC, SPI, I <sup>2</sup> C are Non-Multiplexed Serial Interface signals.	•	

Table 2-21. CPM Output Characteristics

No.	Characteristic	Min	Max	Unit
41	FCC output delay after low-to-high clock transition a. internal clock (BRGxO) b. external clock (serial input clock)	0 2	6 18	ns ns
38	SCC/SMC/SPI/I <sup>2</sup> C output delay after low-to-high clock transition a. internal clock (BRGxO) b. external clock (serial input clock)	0	20 30	ns ns
40	TDM output delay after low-to-high serial clock transition	5	15	ns
42	PIO/TIMER/DMA output delay after low-to-high serial clock transition	1	14	ns
Note:	FCC, SCC, SMC, SPI, I <sup>2</sup> C are Non-Multiplexed Serial Interface signals.			

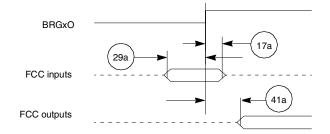


Figure 2-14. FCC Internal Clock Diagram

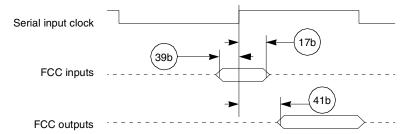


Figure 2-15. FCC External Clock Diagram

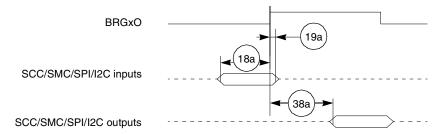


Figure 2-16. SCC/SMC/SPI/I<sup>2</sup>C Internal Clock Diagram

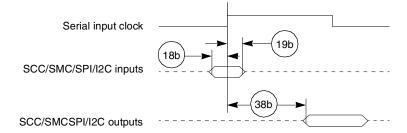


Figure 2-17. SCC/SMC/SPI/I<sup>2</sup>C External Clock Diagram

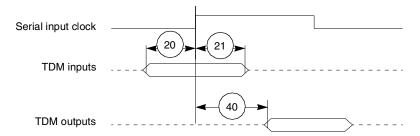


Figure 2-18. TDM Signal Diagram

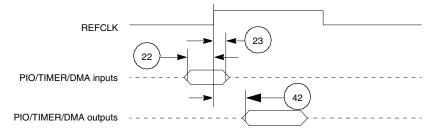


Figure 2-19. PIO, Timer, and DMA Signal Diagram

Note: The timing values refer to minimum system timing requirements. Actual implementation requires conformance to the specific protocol requirements. Refer to **Chapter 1** to identify the specific input and output signals associated with the referenced internal controllers and supported communication protocols. For example, FCC1 supports ATM/Utopia operation in slave mode, multi-PHY master direct polling mode, and multi-PHY master multiplexed polling mode and each of these modes supports its own set of signals; the direction (input or output) of some of the shared signal names depends on the selected mode.

### 2.7.7 JTAG Signals

Table 2-22. JTAG Timing

N-	Oh averatori di e	All frequen	All frequencies		
NO.	No. Characteristics	Min	Max	Unit	
500	TCK frequency of operation	0.0	40.0	MHz	
501	TCK cycle time	25.0	I	ns	
502	TCK clock pulse width measured at 1.6 V	12.5		ns	
503	TCK rise and fall times	0.0	3.0	ns	
508	TMS, TDI data set-up time	6.0		ns	
509	TMS, TDI data hold time	3.0		ns	
510	TCK low to TDO data valid	0.0	15.0	ns	
511	TCK low to TDO high impedance	0.0	20.0	ns	
512	TRST assert time	100.0		ns	
513	TRST set-up time to TCK low	40.0	_	ns	

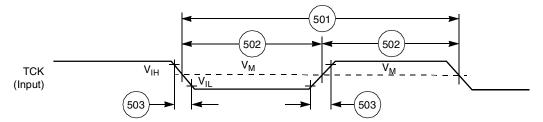


Figure 2-20. Test Clock Input Timing Diagram

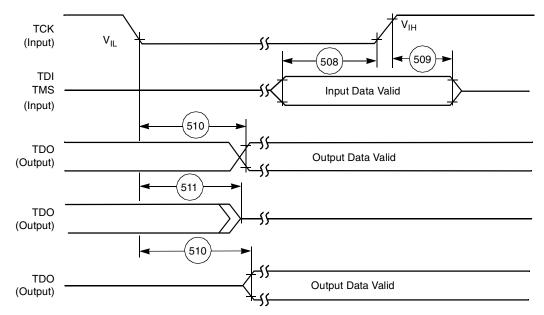


Figure 2-21. Test Access Port Timing Diagram

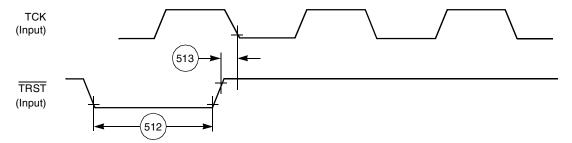


Figure 2-22. TRST Timing Diagram

### Chapter 3

Packaging

### 3.1 Pin-Out and Package Information

This sections provides information about the MSC8101 package, including diagrams of the package pinouts and tables showing how the signals discussed in **Chapter 1** are allocated. The MSC8101 is available in a 332-pin lidded Flip Chip-Plastic Ball Grid Array (FC-PBGA).

## 3.2 FC-PBGA Package Description

**Figure 3-1** and **Figure 3-2** show top and bottom views of the FC-PBGA package, including pinouts. **Table 3-1** lists the MSC8101 signals alphabetically by signal name. Connections with multiple names are listed individually by each name. Signals with programmable polarity are shown both as signals which are asserted low (default) and high (i.e., NAME/NAME). **Table 3-2** lists the signals numerically by pin number. Each pin number is listed once with the various signals that are multiplexed to it. For simplicity, signals with programmable polarity are shown in this table only with their default name (asserted low).

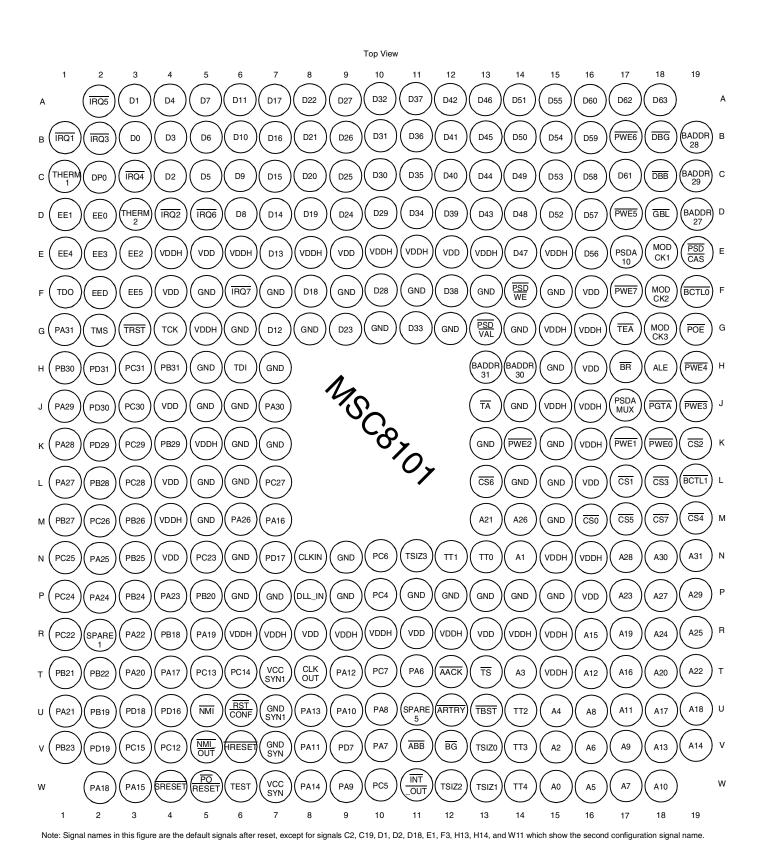
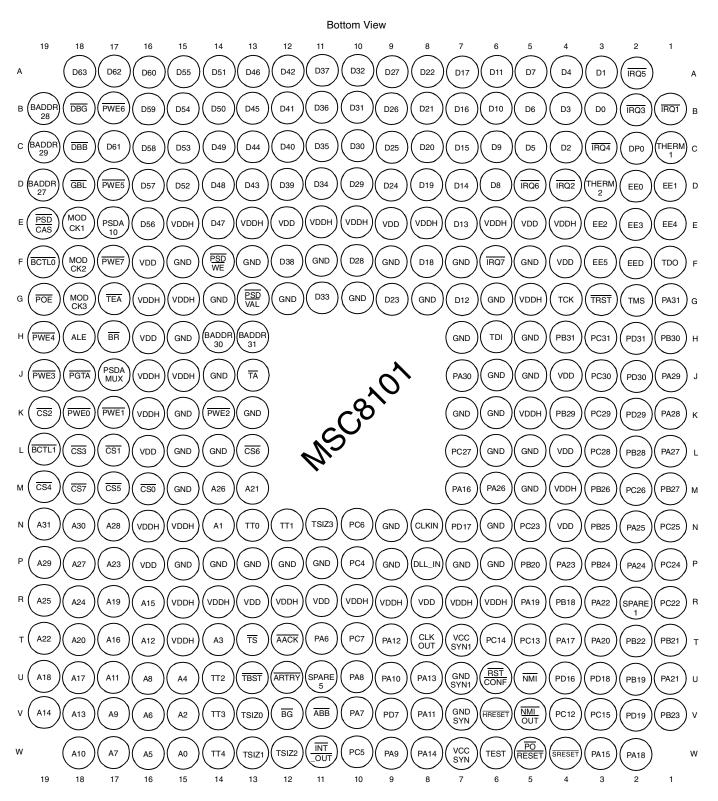


Figure 3-1. MSC8101 Flip Chip Plastic Ball Grid Array (FC-PBGA), Top View



Note: Signal names in this figure are the default signals after reset, except for signals C2, C19, D1, D2, D18, E1, F3, H13, H14, and W11 which show the second configuration signal name.

Figure 3-2. MSC8101 Flip Chip Plastic Ball Grid Array (FC-PBGA), Bottom Vie

Table 3-1. MSC8101 Signal Listing By Name

Signal Name	Number
A0	W15
A1	N14
A2	V15
A3	T14
A4	U15
A5	W16
A6	V16
A7	W17
A8	U16
A9	V17
A10	W18
A11	U17
A12	T16
A13	V18
A14	V19
A15	R16
A16	T17
A17	U18
A18	U19
A19	R17
A20	T18
A21	M13
A22	T19
A23	P17
A24	R18
A25	R19
A26	M14
A27	P18
A28	N17
A29	P19
A30	N18
A31	N19
AACK	T12

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
ABB	V11
ALE	H18
ARTRY	U12
BADDR27	D19
BADDR28	B19
BADDR29	C19
BADDR30	H14
BADDR31	H13
BCTL0	F19
BCTL1	L19
BG	V12
BNKSEL0	E18
BNKSEL1	F18
BNKSEL2	G18
BR	H17
BRG10	НЗ
BRG10	V2
BRG2O	J3
BRG2O	N7
BRG3O	КЗ
BRG40	L3
BRG5O	L7
BRG6O	M2
BRG7O	N1
BRG8O	P1
BTM0	E1
BTM1	F3
CD for FCC1	N10
CD for FCC2	P10
CD/RENA for SCC1	Т6
CD/RENA for SCC2	V4
CLK1	НЗ
CLK2	J3

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
CLK3	К3
CLK4	L3
CLK5	L7
CLK6	M2
CLK7	N1
CLK8	P1
CLK9	N5
CLK10	R1
CLKIN	N8
CLKOUT	Т8
COL for FCC1	G1
COL for FCC2	M1
CRS for FCC1	J7
CRS for FCC2	M3
CS0	M16
CS1	L17
CS2	K19
CS3	L18
CS4	M19
CS5	M17
CS6	L13
CS7	M18
CTS for FCC1	T10
CTS for FCC2	W10
CTS/CLSN for SCC1	К3
CTS/CLSN for SCC1	V3
CTS/CLSN for SCC2	L3
CTS/CLSN for SCC2	T5
D0	В3
D1	A3
D2	C4
D3	B4
D4	A4

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
D5	C5
D6	B5
D7	A5
D8	D6
D9	C6
D10	В6
D11	A6
D12	G7
D13	E7
D14	D7
D15	C7
D16	В7
D17	A7
D18	F8
D19	D8
D20	C8
D21	B8
D22	A8
D23	G9
D24	D9
D25	C9
D26	В9
D27	A9
D28	F10
D29	D10
D30	C10
D31	B10
D32	A10
D33	G11
D34	D11
D35	C11
D36	B11
D37	A11

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
D38	F12
D39	D12
D40	C12
D41	B12
D42	A12
D43	D13
D44	C13
D45	B13
D46	A13
D47	E14
D48	D14
D49	C14
D50	B14
D51	A14
D52	D15
D53	C15
D54	B15
D55	A15
D56	E16
D57	D16
D58	C16
D59	B16
D60	A16
D61	C17
D62	A17
D63	A18
DACK1	N5
DACK2	N1
DACK3	D5
DACK4	F6
DBB	C18
DBG	B18
DBREQ	D2

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
DLLIN	P8
DP0	C2
DP1	B1
DP2	D4
DP3	B2
DP4	C3
DP5	A2
DP6	D5
DP7	F6
DRACK1/DONE1	H2
DRACK2/DONE2	J2
DREQ1	R1
DREQ2	P1
DREQ3	С3
DREQ4	A2
EE0	D2
EE1	D1
EE2	E3
EE3	E2
EE4	E1
EE5	F3
EED	F2
EXT_BG2	B1
EXT_BG3	С3
EXT_BR2	C2
EXT_BR3	B2
EXT_DBG2	D4
EXT_DBG3	A2
EXT1	НЗ
EXT2	N5
GBL	D18
GND	F11
GND	F13

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
GND	F15
GND	F5
GND	F7
GND	F9
GND	G10
GND	G12
GND	G14
GND	G6
GND	G8
GND	H15
GND	H5
GND	H7
GND	J14
GND	J5
GND	J6
GND	K13
GND	K15
GND	K6
GND	K7
GND	L14
GND	L15
GND	L5
GND	L6
GND	M15
GND	M5
GND	N6
GND	N9
GND	P11
GND	P12
GND	P13
GND	P14
GND	P15
GND	P6

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
GND	P7
GND	P9
GND <sub>SYN</sub>	V7
GND <sub>SYN1</sub>	U7
H8BIT	B16
HA0	D14
HA1	C14
HA2	B14
НАЗ	A14
HACK/HACK	E16
HCS1/HCS1	D15
HCS2/HCS2	A16
HD0	A10
HD1	G11
HD2	D11
HD3	C11
HD4	B11
HD5	A11
HD6	F12
HD7	D12
HD8	C12
HD9	B12
HD10	A12
HD11	D13
HD12	C13
HD13	B13
HD14	A13
HD15	E14
HDDS	C16
HDS/HDS	B15
HDSP	D16
HPE	D1
HRD/HRD	C15

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
HREQ/HREQ	A15
HRESET	V6
HRRQ/HRRQ	E16
HRW	C15
HTRQ/HTRQ	A15
HWR/HWR	B15
ĪNT_OUT	W11
ĪRQ1	B1
ĪRQ1	D18
ĪRQ2	C19
ĪRQ2	D4
ĪRQ2	V11
ĪRQ3	B2
ĪRQ3	C18
ĪRQ3	H14
ĪRQ4	C3
ĪRQ5	A2
ĪRQ5	H13
ĪRQ6	D5
ĪRQ7	F6
ĪRQ7	W11
L1RSYNC for SI1 TDMA1	T11
L1RSYNC for SI2 TDMB2	K4
L1RSYNC for SI2 TDMC2	P3
L1RSYNC for SI2 TDMD2	P5
L1RXD for SI1 TDMA1 Serial	U10
L1RXD for SI2 TDMB2	H1
L1RXD for SI2 TDMC2	M3
L1RXD for SI2 TDMD2	T2
L1RXD0 for SI1 TDMA1 Nibble	U10
L1RXD1 for SI1 TDMA1 Nibble	T2
L1RXD2 for SI1 TDMA1 Nibble	V1
L1RXD3 for SI1 TDMA1 Nibble	P3

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
L1TSYNC for SI1 TDMA1	V10
L1TSYNC for SI2 TDMB2	L2
L1TSYNC for SI2 TDMC2	N3
L1TSYNC for SI2 TDMD2	T1
L1TXD for SI1 TDMA1 Serial	W9
L1TXD for SI2 TDMB2	H4
L1TXD for SI2 TDMC2	M1
L1TXD for SI2 TDMD2	V1
L1TXD0 for SI1 TDMA1 Nibble	W9
L1TXD1 for SI1 TDMA1 Nibble	P5
L1TXD2 for SI1 TDMA1 Nibble	T1
L1TXD3 for SI1 TDMA1 Nibble	N3
LIST1 for SI1	R1
LIST1 for SI2	T10
LIST2 for SI1	T6
LIST2 for SI2	N10
LIST3 for SI1	V4
LIST3 for SI2	W10
LIST4 for SI1	T5
LIST4 for SI2	P10
MODCK1	E18
MODCK2	F18
морскз	G18
MSNUM0	N2
MSNUM1	P2
MSNUM2	U8
мѕиимз	Т9
MSNUM4	V8
MSNUM5	U9
NMI	U5
NMI_OUT	V5
PA6	T11
PA7	V10

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
PA8	U10
PA9	W9
PA10	U9
PA11	V8
PA12	Т9
PA13	U8
PA14	W8
PA15	W3
PA16	M7
PA17	T4
PA18	W2
PA19	R5
PA20	Т3
PA21	U1
PA22	R3
PA23	P4
PA24	P2
PA25	N2
PA26	M6
PA27	L1
PA28	K1
PA29	J1
PA30	J7
PA31	G1
PB18	R4
PB19	U2
PB20	P5
PB21	T1
PB22	T2
PB23	V1
PB24	P3
PB25	N3
PB26	M3

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
PB27	M1
PB28	L2
PB29	K4
PB30	H1
PB31	H4
PBS0	K18
PBS1	K17
PBS2	K14
PBS3	J19
PBS4	H19
PBS5	D17
PBS6	B17
PBS7	F17
PC4	P10
PC5	W10
PC6	N10
PC7	T10
PC12	V4
PC13	T5
PC14	T6
PC15	V3
PC22	R1
PC23	N5
PC24	P1
PC25	N1
PC26	M2
PC27	L7
PC28	L3
PC29	К3
PC30	J3
PC31	НЗ
PD7	V9
PD16	U4

Table 3-1. MSC8101 Signal Listing By Name (Continued)

PD17 N7 PD18 U3 PD19 V2 PD29 K2 PD29 K2 PD30 J2 PD31 H2 PGPL0 E17 PGPL1 F14 PGPL2 G19 PGPL3 E19 PGPL4 J18 PGPL5 J17 PGTA J18 POE G19 PORESET W5 PPBS J18 PSDAMUX J17 PSDCAS E19 PSDDOM0 K18 PSDDOM0 K18 PSDDOM1 K17 PSDDOM5 D17 PSDDOM6 B17 PSDDOM6 B17 PSDDAM5 G19 PSDVAL G13 PSDWE F14 PWE0 K18	Signal Name	Number
PD18 U3 PD19 V2 PD29 K2 PD29 K2 PD30 J2 PD31 H2 PGPL0 E17 PGPL1 F14 PGPL2 G19 PGPL3 E19 PGPL4 J18 PGPL5 J17 PGTA J18 POE G19 PORESET W5 PPBS J18 PSDDAMUX J17 PSDDAMO K18 PSDDOM1 K17 PSDDOM5 D17 PSDDOM6 B17 PSDDOM6 B17 PSDDAM5 G19 PSDWE F14 PUPMWAIT J18 PD2 K2 PD30 J2 PSDOW6 K18 PSDOW6 F14		
PD19 V2 PD29 K2 PD30 J2 PD31 H2 PB31 H2 PGPL0 E17 PGPL1 F14 PGPL2 G19 PGPL3 E19 PGPL4 J18 PGPL5 J17 PGTA J18 POE G19 PORESET W5 PPBS J18 PSDDAMUX J17 PSDDAM2 K14 PSDDAM5 D17 PSDDAM5 D17 PSDDAM6 B17 PSDDAM6 B17 PSDWE F14 PUPMWAIT J18 PD2 PD31 PD31 PSDOM6 P14 PSDOWE F14 PWE0 K18		
PD29 PD30 J2 PD31 PD31 H2 PGPL0 E17 PGPL0 E17 PGPL1 F14 PGPL2 G19 PGPL3 PGPL3 PGPL4 J18 PGPL5 J17 PGTA J18 POE G19 PORESET W5 PPBS J18 PSDA10 PSDDQM0 K18 PSDDQM1 K17 PSDDQM2 K14 PSDDQM3 J19 PSDDQM4 H19 PSDDQM4 H19 PSDDQM6 B17 PSDDQM7 PSDVAL G13 PSDWE F14 PWE0 K18	PD18	
PD30 PD31 PD31 PD31 PGPL0 E17 PGPL0 E17 PGPL1 F14 PGPL2 G19 PGPL3 E19 PGPL4 J18 PGPL5 J17 PGTA J18 POE G19 PORESET W5 PPBS J18 PSDAMUX J17 PSDAMUX J17 PSDDQM0 K18 PSDDQM1 K17 PSDDQM3 J19 PSDDQM4 H19 PSDDQM6 B17 PSDDQM6 B17 PSDDQM7 F17 PSDVAL G13 PSDWE F14 PUPMWAIT J18 PME0  E17 PME0 K18	PD19	V2
PD31	PD29	K2
PGPL0 E17 PGPL1 F14 PGPL2 G19 PGPL3 E19 PGPL4 J18 PGPL5 J17 PGTA J18 POE G19 PORESET W5 PPBS J18 PSDAMUX J17 PSDCAS E19 PSDDQM0 K18 PSDDQM1 K17 PSDDQM2 K14 PSDDQM3 J19 PSDDQM4 H19 PSDDQM6 B17 PSDDQM6 B17 PSDRAS G19 PSDRAS G19 PSDDQM7 F17 PSDRAS G19 PSDDQM7 F17 PSDRAS G19 PSDDQM7 F17 PSDRAS G19 PSDDQM7 F17 PSDRAS G19 PSDVAL G13 PSDWE F14 PUPMWAIT J18	PD30	J2
PGPL1       F14         PGPL2       G19         PGPL3       E19         PGPL4       J18         PGPL5       J17         PGTA       J18         POE       G19         PORESET       W5         PPBS       J18         PSDA10       E17         PSDAMUX       J17         PSDCAS       E19         PSDDQM0       K18         PSDDQM0       K18         PSDDQM1       K17         PSDDQM2       K14         PSDDQM3       J19         PSDDQM4       H19         PSDDQM5       D17         PSDDQM6       B17         PSDDQM7       F17         PSDRAS       G19         PSDVAL       G13         PSDWE       F14         PUPMWAIT       J18         PWE0       K18	PD31	H2
PGPL2         G19           PGPL3         E19           PGPL4         J18           PGPL5         J17           PGTA         J18           POE         G19           PORESET         W5           PPBS         J18           PSDA10         E17           PSDAMUX         J17           PSDCAS         E19           PSDDQM0         K18           PSDDQM1         K17           PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PGPL0	E17
PGPL3         E19           PGPL4         J18           PGPL5         J17           PGTA         J18           POE         G19           PORESET         W5           PPBS         J18           PSDA10         E17           PSDAMUX         J17           PSDCAS         E19           PSDDQM0         K18           PSDDQM0         K18           PSDDQM1         K17           PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PGPL1	F14
PGPL4       J18         PGPL5       J17         PGTA       J18         POE       G19         PORESET       W5         PPBS       J18         PSDA10       E17         PSDAMUX       J17         PSDAMUX       J17         PSDCAS       E19         PSDDQM0       K18         PSDDQM1       K17         PSDDQM2       K14         PSDDQM3       J19         PSDDQM4       H19         PSDDQM5       D17         PSDDQM6       B17         PSDDQM7       F17         PSDDQM6       B17         PSDVAL       G13         PSDVAL       G13         PSDWE       F14         PUPMWAIT       J18         PWE0       K18	PGPL2	G19
PGPL5         J17           PGTA         J18           POE         G19           PORESET         W5           PPBS         J18           PSDA10         E17           PSDAMUX         J17           PSDAMUX         J17           PSDCAS         E19           PSDDQM0         K18           PSDDQM1         K17           PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PGPL3	E19
PGTA         J18           POE         G19           PORESET         W5           PPBS         J18           PSDA10         E17           PSDAMUX         J17           PSDCAS         E19           PSDCAS         E19           PSDDQM0         K18           PSDDQM1         K17           PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PGPL4	J18
POE         G19           PORESET         W5           PPBS         J18           PSDA10         E17           PSDAMUX         J17           PSDCAS         E19           PSDDQM0         K18           PSDDQM1         K17           PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PGPL5	J17
PORESET         W5           PPBS         J18           PSDA10         E17           PSDAMUX         J17           PSDCAS         E19           PSDDQM0         K18           PSDDQM1         K17           PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PGTA	J18
PPBS         J18           PSDA10         E17           PSDAMUX         J17           PSDCAS         E19           PSDDQM0         K18           PSDDQM1         K17           PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	POE	G19
PSDA10         E17           PSDAMUX         J17           PSDCAS         E19           PSDDQM0         K18           PSDDQM1         K17           PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PORESET	W5
PSDAMUX         J17           PSDCAS         E19           PSDDQM0         K18           PSDDQM1         K17           PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PPBS	J18
PSDCAS         E19           PSDDQM0         K18           PSDDQM1         K17           PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PSDA10	E17
PSDDQM0         K18           PSDDQM1         K17           PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PSDAMUX	J17
PSDDQM1         K17           PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PSDCAS	E19
PSDDQM2         K14           PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PSDDQM0	K18
PSDDQM3         J19           PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PSDDQM1	K17
PSDDQM4         H19           PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PSDDQM2	K14
PSDDQM5         D17           PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PSDDQM3	J19
PSDDQM6         B17           PSDDQM7         F17           PSDRAS         G19           PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PSDDQM4	H19
PSDDQM7 F17 PSDRAS G19 PSDVAL G13 PSDWE F14 PUPMWAIT J18 PWE0 K18	PSDDQM5	D17
PSDRAS G19 PSDVAL G13 PSDWE F14 PUPMWAIT J18 PWE0 K18	PSDDQM6	B17
PSDVAL         G13           PSDWE         F14           PUPMWAIT         J18           PWE0         K18	PSDDQM7	F17
PSDWE F14  PUPMWAIT J18  PWE0 K18	PSDRAS	G19
PUPMWAIT J18  PWE0 K18	PSDVAL	G13
PWE0 K18	PSDWE	F14
	PUPMWAIT	J18
PWE1 K17	PWE0	K18
1 ''''	PWE1	K17

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
PWE2	K14
PWE3	J19
PWE4	H19
PWE5	D17
PWE6	B17
PWE7	F17
Reserved	A17
Reserved	A18
Reserved	C2
Reserved	C17
Reserved	C19
Reserved	H14
Reserved	H13
RSTCONF	U6
RTS for FCC1	J7
RTS for FCC2	L2
RTS/TENA for SCC1	K2
RTS/TENA for SCC2	L2
RX_DV for FCC1	L1
RX_DV for FCC2	H1
RX_ER for FCC1	M6
RX_ER for FCC2	L2
RXADDR0 for FCC1 UTOPIA 8	T6
RXADDR1 for FCC1 UTOPIA 8	V4
RXADDR2 for FCC1 UTOPIA 8	N10
RXADDR2/RXCLAV1 for FCC1 UTOPIA 8	N10
RXADDR3 for FCC1 UTOPIA 8	K2
RXADDR4 for FCC1 UTOPIA 8	U3
RXCLAV for FCC1 UTOPIA 8	M6
RXCLAV0 for FCC1 UTOPIA 8	M6
RXCLAV2 for FCC1 UTOPIA 8	K2
RXCLAV3 for FCC1 UTOPIA 8	V4
RXD for FCC1 transparent/HDLC serial	T4

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
RXD for FCC2 transparent/HDLC serial	T1
RXD for SCC1	H2
RXD for SCC2	H4
RXD0 for FCC1 MII/HDLC nibble	T4
RXD0 for FCC1 UTOPIA 8	U9
RXD0 for FCC2 MII/HDLC nibble	T1
RXD1 for FCC1 MII/HDLC nibble	M7
RXD1 for FCC1 UTOPIA 8	V8
RXD1 for FCC2 MII/HDLC nibble	P5
RXD2 for FCC1 MII/HDLC nibble	W3
RXD2 for FCC1 UTOPIA 8	Т9
RXD2 for FCC2 MII/HDLC nibble	U2
RXD3 for FCC1 MII/HDLC nibble	W8
RXD3 for FCC1 UTOPIA 8	U8
RXD3 for FCC2 MII/HDLC nibble	R4
RXD4 for FCC1 UTOPIA 8	W8
RXD5 for FCC1 UTOPIA 8	W3
RXD6 for FCC1 UTOPIA 8	M7
RXD7 for FCC1 UTOPIA 8	T4
RXENB for FCC1	K1
RXPRTY for FCC1 UTOPIA 8	N7
RXSOC for FCC1	L1
SCL	R4
SDA	U2
SMRXD for SMC1	P10
SMRXD for SMC2	U10
SMSYN for SMC1	V9
SMSYN for SMC2	V10
SMTXD for SMC1	W10
SMTXD for SMC2	W9
SMTXD for SMC2	V3
SPARE1	R2
SPARE5	U11

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
SPICLK	U3
SPIMISO	U4
SPIMOSI	N7
SPISEL	V2
SRESET	W4
TA	J13
TBST	U13
TC0	E18
TC1	F18
TC2	G18
TCK	G4
TDI	H6
TDO	F1
TEA	G17
TEST	W6
TGATE1	H3
TGATE2	L7
THERM1	C1
THERM2	D3
TIN1/TOUT2	L3
TIN2	К3
TIN3/TOUT4	P1
TIN4	N1
TMCLK	M2
TMS	G2
TOUT1	J3
TOUT3	M2
TRST	G3
TS	T13
TSIZ0	V13
TSIZ1	W13
TSIZ2	W12
TSIZ3	N11

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
ТТО	N13
TT1	N12
TT2	U14
ТТ3	V14
TT4	W14
TX_EN for FCC1 MII	K1
TX_EN for FCC2 MII	K4
TX_ER for FCC1 MII	J1
TX_ER for FCC2 MII	H4
TXADDR0 for FCC1 UTOPIA 8	V3
TXADDR1 for FCC1 UTOPIA 8	T5
TXADDR2 for FCC1 UTOPIA 8	T10
TXADDR2 for FCC1 UTOPIA 8	T10
TXADDR3 for FCC1 UTOPIA 8	V9
TXADDR4 for FCC1 UTOPIA 8	V2
TXCLAV for FCC1 UTOPIA 8	J7
TXCLAV0 for FCC1 UTOPIA 8	J7
TXCLAV1 for FCC1 UTOPIA 8	T10
TXCLAV2 for FCC1 UTOPIA 8	V9
TXCLAV3 for FCC1 UTOPIA 8	V2
TXD for FCC1 transparent/HDLC serial	W2
TXD for FCC2 transparent/HDLC serial	T2
TXD for SCC1	J2
TXD for SCC2	H1
TXD0 for FCC1 MII/HDLC nibble	W2
TXD0 for FCC1 UTOPIA 8	N2
TXD0 for FCC2 MII/HDLC nibble	T2
TXD1 for FCC1 MII/HDLC nibble	R5
TXD1 for FCC1 UTOPIA 8	P2
TXD1 for FCC2 MII/HDLC nibble	V1
TXD2 for FCC1 MII/HDLC nibble	Т3
TXD2 for FCC1 UTOPIA 8	P4
TXD2 for FCC2 MII/HDLC nibble	Р3

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
TXD3 for FCC1 MII/HDLC nibble	U1
TXD3 for FCC1 UTOPIA 8	R3
TXD3 for FCC2 MII/HDLC nibble	N3
TXD4 for FCC1 UTOPIA 8	U1
TXD5 for FCC1 UTOPIA 8	T3
TXD6 for FCC1 UTOPIA 8	R5
TXD7 for FCC1 UTOPIA 8	W2
TXENB for FCC1	G1
TXPRTY for FCC1 UTOPIA 8	U4
TXSOC for FCC1	J1
V <sub>CCSYN</sub>	W7
V <sub>CCSYN1</sub>	T7
V <sub>DD</sub>	E12
$V_{DD}$	E5
$V_{DD}$	E9
$V_{DD}$	F16
$V_{DD}$	F4
$V_{DD}$	H16
V <sub>DD</sub>	J4
$V_{DD}$	L16
$V_{DD}$	L4
$V_{DD}$	N4
V <sub>DD</sub>	P16
V <sub>DD</sub>	R11
$V_{DD}$	R13
$V_{DD}$	R8
$V_{DDH}$	E10
$V_{DDH}$	E11
$V_{DDH}$	E13
$V_{DDH}$	E15
$V_{DDH}$	E4
$V_{DDH}$	E6
$V_{DDH}$	E8

Table 3-1. MSC8101 Signal Listing By Name (Continued)

Signal Name	Number
V <sub>DDH</sub>	G15
$V_{DDH}$	G16
$V_{DDH}$	G5
$V_{DDH}$	J15
$V_{DDH}$	J16
$V_{DDH}$	K16
$V_{DDH}$	K5
$V_{DDH}$	M4
$V_{DDH}$	N15
$V_{DDH}$	N16
$V_{DDH}$	R10
$V_{DDH}$	R12
$V_{DDH}$	R14
$V_{DDH}$	R15
$V_{DDH}$	R6
$V_{DDH}$	R7
$V_{DDH}$	R9
$V_{\mathrm{DDH}}$	T15

Table 3-2. MSC8101 Signal Listing by Pin Designator

Number	Signal Name
A2	IRQ5 / DP5 / DREQ4 / EXT_DBG3
А3	D1
A4	D4
A5	D7
A6	D11
A7	D17
A8	D22
A9	D27
A10	D32 / HD0
A11	D37 / HD5
A12	D42 / HD10
A13	D46 / HD14
A14	D51 / HA3

Table 3-2. MSC8101 Signal Listing by Pin Designator (Continued)

A15  A16  D60 / HCS2  A17  D62 / Reserved  A18  D63 / Reserved  B1  IRQ1 / DP1 / EXT_BG2  B2  IRQ3 / DP3 / EXT_BR3  B3  D0  B4  D3  B5  D6  B6  D10  B7  D16  B8  D21  B9  D26  B10  D31  B11  D36 / HD4  B12  D41 / HD9  B13  D45 / HD13  B14  D50 / HA2  B15  D59 / HBBIT  B16  D59 / HBBIT  PWE6 / PSDDQM6 / PBS6	
A17       D62 / Reserved         A18       D63 / Reserved         B1       IRQ1 / DP1 / EXT_BG2         B2       IRQ3 / DP3 / EXT_BR3         B3       D0         B4       D3         B5       D6         B6       D10         B7       D16         B8       D21         B9       D26         B10       D31         B11       D36 / HD4         B12       D41 / HD9         B13       D45 / HD13         B14       D50 / HA2         B15       D54 / HDS / HWR         B16       D59 / H8BIT	
A18     D63 / Reserved       B1     IRQ1 / DP1 / EXT_BG2       B2     IRQ3 / DP3 / EXT_BR3       B3     D0       B4     D3       B5     D6       B6     D10       B7     D16       B8     D21       B9     D26       B10     D31       B11     D36 / HD4       B12     D41 / HD9       B13     D45 / HD13       B14     D50 / HA2       B15     D54 / HDS / HWR       B16     D59 / H8BIT	
B1     IRQ1 / DP1 / EXT_BG2       B2     IRQ3 / DP3 / EXT_BR3       B3     D0       B4     D3       B5     D6       B6     D10       B7     D16       B8     D21       B9     D26       B10     D31       B11     D36 / HD4       B12     D41 / HD9       B13     D45 / HD13       B14     D50 / HA2       B15     D54 / HDS / HWR       B16     D59 / H8BIT	
B2     IRQ3 / DP3 / EXT_BR3       B3     D0       B4     D3       B5     D6       B6     D10       B7     D16       B8     D21       B9     D26       B10     D31       B11     D36 / HD4       B12     D41 / HD9       B13     D45 / HD13       B14     D50 / HA2       B15     D54 / HDS / HWR       B16     D59 / H8BIT	
B3       D0         B4       D3         B5       D6         B6       D10         B7       D16         B8       D21         B9       D26         B10       D31         B11       D36 / HD4         B12       D41 / HD9         B13       D45 / HD13         B14       D50 / HA2         B15       D54 / HDS / HWR         B16       D59 / H8BIT	
B4       D3         B5       D6         B6       D10         B7       D16         B8       D21         B9       D26         B10       D31         B11       D36 / HD4         B12       D41 / HD9         B13       D45 / HD13         B14       D50 / HA2         B15       D54 / HDS / HWR         B16       D59 / H8BIT	
B5       D6         B6       D10         B7       D16         B8       D21         B9       D26         B10       D31         B11       D36 / HD4         B12       D41 / HD9         B13       D45 / HD13         B14       D50 / HA2         B15       D54 / HDS / HWR         B16       D59 / H8BIT	
B6       D10         B7       D16         B8       D21         B9       D26         B10       D31         B11       D36 / HD4         B12       D41 / HD9         B13       D45 / HD13         B14       D50 / HA2         B15       D54 / HDS / HWR         B16       D59 / H8BIT	
B7       D16         B8       D21         B9       D26         B10       D31         B11       D36 / HD4         B12       D41 / HD9         B13       D45 / HD13         B14       D50 / HA2         B15       D54 / HDS / HWR         B16       D59 / H8BIT	
B8       D21         B9       D26         B10       D31         B11       D36 / HD4         B12       D41 / HD9         B13       D45 / HD13         B14       D50 / HA2         B15       D54 / HDS / HWR         B16       D59 / H8BIT	
B9       D26         B10       D31         B11       D36 / HD4         B12       D41 / HD9         B13       D45 / HD13         B14       D50 / HA2         B15       D54 / HDS / HWR         B16       D59 / H8BIT	
B10     D31       B11     D36 / HD4       B12     D41 / HD9       B13     D45 / HD13       B14     D50 / HA2       B15     D54 / HDS / HWR       B16     D59 / H8BIT	
B11       D36 / HD4         B12       D41 / HD9         B13       D45 / HD13         B14       D50 / HA2         B15       D54 / HDS / HWR         B16       D59 / H8BIT	
B12     D41 / HD9       B13     D45 / HD13       B14     D50 / HA2       B15     D54 / HDS / HWR       B16     D59 / H8BIT	
B13         D45 / HD13           B14         D50 / HA2           B15         D54 / HDS / HWR           B16         D59 / H8BIT	
B14         D50 / HA2           B15         D54 / HDS / HWR           B16         D59 / H8BIT	
B15         D54 / HDS / HWR           B16         D59 / H8BIT	
B16 D59 / H8BIT	
B17 PWE6 / PSDDQM6 / PBS6	
B18 DBG	
B19 BADDR28	
C1 THERM1	
C2 Reserved / DP0 / EXT_BR2	
C3	
C4 D2	
C5 D5	
C6 D9	
C7 D15	
C8 D20	
C9 D25	
C10 D30	
C11 D35 / HD3	
C12 D40 / HD8	
C13 D44 / HD12	
C14 D49 / HA1	
C15 D53 / HRW / HRD	

Table 3-2. MSC8101 Signal Listing by Pin Designator (Continued)

C16         DS8 / HDDS           C17         D61           C18         DBB / IRQ3           C19         BADDR29 / IRQ2           D1         HPE / EE1           D2         DBREQ / EE0           D3         THERM2           D4         IRQ2 / DP2 / EXT_DBG2           D5         IRQ6 / DP6 / DACK3           D6         D8           D7         D14           D8         D19           D9         D24           D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD1           D14         D48 / HA0           D15         D57 / HDSP           D16         D57 / HDSP           D17         PWE5 / PSDDQM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         Y <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub>	Number	Signal Name
C17         D61           C18         DBB / IRQ3           C19         BADDR29 / IRQ2           D1         HPE / EE1           D2         DBREQ / EE0           D3         THERM2           D4         IRQ2 / DP2 / EXT_DBG2           D5         IRQ6 / DP6 / DACK3           D6         D8           D7         D14           D8         D19           D9         D24           D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD1           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDQM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DD</sub>		
C18         DBB / IRQ3           C19         BADDR29 / IRQ2           D1         HPE / EE1           D2         DBREQ / EE0           D3         THERM2           D4         IRQ2 / DP2 / EXT_DBG2           D5         IRG6 / DP6 / DACK3           D6         D8           D7         D14           D8         D19           D9         D24           D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD1           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDOM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         VDDH           E5         VDD           E6         VDH           E5         VDD           E6         VDH           E9         VDD           E10         VDH           E11		
C19         BADDR29/IRO2           D1         HPE / EE1           D2         DBREQ / EE0           D3         THERM2           D4         IROZ / DP2 / EXT_DBG2           D5         IROĞ / DP6 / DACK3           D6         D8           D7         D14           D8         D19           D9         D24           D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD11           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDOM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>ODH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DD</sub> E10         V <sub>DDH</sub> E11         V <sub>DDH</sub> <		
D1         HPE / EE1           D2         DBREQ / EE0           D3         THERM2           D4         IRQ2 / DP2 / EXT_DBG2           D5         IRQ6 / DP6 / DACK3           D6         D8           D7         D14           D8         D19           D9         D24           D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD11           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDOM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DD</sub> E10         V <sub>DDH</sub> E11         V <sub>DDH</sub> E12         V <sub>DD</sub> E13<		
D2         DBREQ / EE0           D3         THERM2           D4         IROZ / DP2 / EXT_DBG2           D5         IRO6 / DP6 / DACK3           D6         D8           D7         D14           D8         D19           D9         D24           D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD11           D14         D48 / HA0           D15         D52 / HGS1           D16         D57 / HDSP           D17         PWE5 / PSDDOM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DD</sub> E10         V <sub>DDH</sub> E11         V <sub>DDH</sub> E12         V <sub>DD</sub> E13         V <sub>DD</sub> E14 <td></td> <td></td>		
D3         THERM2           D4         IRQ2 / DP2 / EXT_DBG2           D5         IRQ6 / DP6 / DACK3           D6         D8           D7         D14           D8         D19           D9         D24           D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD11           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDQM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DD</sub> E10         V <sub>DDH</sub> E11         V <sub>DDH</sub> E12         V <sub>DD</sub> E13         V <sub>DDH</sub> E14         D47 / HD15		
D4         IROZ / DP2 / EXT_DBG2           D5         IRO6 / DP6 / DACK3           D6         D8           D7         D14           D8         D19           D9         D24           D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD11           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDOM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DD</sub> E10         V <sub>DDH</sub> E11         V <sub>DDH</sub> E12         V <sub>DD</sub> E13         V <sub>DDH</sub> E14         D47 / HD15		
D5         IRO6 / DACK3           D6         D8           D7         D14           D8         D19           D9         D24           D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD11           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDQM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DD</sub> E10         V <sub>DDH</sub> E11         V <sub>DDH</sub> E12         V <sub>DDH</sub> E13         V <sub>DDH</sub> E14         D47 / HD15		
D6         D8           D7         D14           D8         D19           D9         D24           D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD11           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDOM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DDH</sub> E10         V <sub>DDH</sub> E11         V <sub>DDH</sub> E12         V <sub>DD</sub> E13         V <sub>DDH</sub> E14         D47 / HD15	D4	
D7         D14           D8         D19           D9         D24           D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD11           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDQM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DD</sub> E10         V <sub>DDH</sub> E11         V <sub>DDH</sub> E12         V <sub>DD</sub> E13         V <sub>DDH</sub> E14         D47 / HD15	D5	IRQ6 / DP6 / DACK3
D8 D19 D9 D24 D10 D29 D11 D34 / HD2 D12 D39 / HD7 D13 D43 / HD11 D14 D48 / HA0 D15 D52 / HCS1 D16 D57 / HDSP D17 PWE5 / PSDDQM5 / PBS5 D18 IRQ1 / GBL D19 BADDR27 E1 BTM0 / EE4 E2 EE3 E3 EE2 E4 VDDH E5 VDDH E7 D13 E8 VDDH E9 VDDH E11 VDDH E11 VDDH E12 VDD E13 VDDH E11 VDDH E12 VDD E13 VDDH E11 VDDH E12 VDDH E13 VDDH E13 VDDH E14 D47 / HD15	D6	D8
D9         D24           D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD11           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDQM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DDH</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DD</sub> E10         V <sub>DDH</sub> E11         V <sub>DDH</sub> E12         V <sub>DD</sub> E13         V <sub>DDH</sub> E14         D47 / HD15	D7	D14
D10         D29           D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD11           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDQM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DD</sub> E10         V <sub>DD</sub> E11         V <sub>DD</sub> E12         V <sub>DD</sub> E13         V <sub>DD</sub> E14         D47 / HD15	D8	D19
D11         D34 / HD2           D12         D39 / HD7           D13         D43 / HD11           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWES / PSDDQMS / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DD</sub> E10         V <sub>DDH</sub> E11         V <sub>DD</sub> E12         V <sub>DD</sub> E13         V <sub>DD</sub> E14         D47 / HD15	D9	D24
D12         D39 / HD7           D13         D43 / HD11           D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDQM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DDH</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DD</sub> E10         V <sub>DDH</sub> E11         V <sub>DDH</sub> E12         V <sub>DD</sub> E13         V <sub>DDH</sub> E14         D47 / HD15	D10	D29
D13	D11	D34 / HD2
D14         D48 / HA0           D15         D52 / HCS1           D16         D57 / HDSP           D17         PWE5 / PSDDQM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         VDDH           E5         VDD           E6         VDH           E7         D13           E8         VDH           E9         VDH           E11         VDH           E11         VDH           E12         VDD           E13         VDH           E14         D47 / HD15	D12	D39 / HD7
D15       D52 / HCS1         D16       D57 / HDSP         D17       PWE5 / PSDQM5 / PBS5         D18       IRQ1 / GBL         D19       BADDR27         E1       BTM0 / EE4         E2       EE3         E3       EE2         E4       V <sub>DDH</sub> E5       V <sub>DD</sub> E6       V <sub>DDH</sub> E7       D13         E8       V <sub>DDH</sub> E9       V <sub>DD</sub> E10       V <sub>DDH</sub> E11       V <sub>DDH</sub> E12       V <sub>DD</sub> E13       V <sub>DDH</sub> E14       D47 / HD15	D13	D43 / HD11
D16         D57 / HDSP           D17         PWE5 / PSDDQM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         VDDH           E5         VDD           E6         VDH           E7         D13           E8         VDH           E9         VDH           E10         VDH           E11         VDH           E12         VDD           E13         VDH           E14         D47 / HD15	D14	D48 / HA0
D17         PWES / PSDDQM5 / PBS5           D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DD</sub> E10         V <sub>DDH</sub> E11         V <sub>DDH</sub> E12         V <sub>DD</sub> E13         V <sub>DDH</sub> E14         D47 / HD15	D15	D52 / HCS1
D18         IRQ1 / GBL           D19         BADDR27           E1         BTM0 / EE4           E2         EE3           E3         EE2           E4         V <sub>DDH</sub> E5         V <sub>DD</sub> E6         V <sub>DDH</sub> E7         D13           E8         V <sub>DDH</sub> E9         V <sub>DD</sub> E10         V <sub>DDH</sub> E11         V <sub>DDH</sub> E12         V <sub>DD</sub> E13         V <sub>DDH</sub> E14         D47 / HD15	D16	D57 / HDSP
D19       BADDR27         E1       BTM0 / EE4         E2       EE3         E3       EE2         E4       V <sub>DDH</sub> E5       V <sub>DD</sub> E6       V <sub>DDH</sub> E7       D13         E8       V <sub>DDH</sub> E9       V <sub>DD</sub> E10       V <sub>DDH</sub> E11       V <sub>DDH</sub> E12       V <sub>DD</sub> E13       V <sub>DDH</sub> E14       D47 / HD15	D17	PWE5 / PSDDQM5 / PBS5
E1 BTM0 / EE4  E2 EE3  E3 EE2  E4 V <sub>DDH</sub> E5 V <sub>DD</sub> E6 V <sub>DDH</sub> E7 D13  E8 V <sub>DDH</sub> E9 V <sub>DD</sub> E10 V <sub>DDH</sub> E11 V <sub>DDH</sub> E12 V <sub>DD</sub> E13 V <sub>DDH</sub> E14 D47 / HD15	D18	ĪRQĪ / GBL
E2 EE3 E3 EE2 E4 V <sub>DDH</sub> E5 V <sub>DD</sub> E6 V <sub>DDH</sub> E7 D13 E8 V <sub>DDH</sub> E9 V <sub>DD</sub> E10 V <sub>DDH</sub> E11 V <sub>DDH</sub> E12 V <sub>DD</sub> E13 V <sub>DDH</sub> E14 D47 / HD15	D19	BADDR27
E3 EE2  E4 V <sub>DDH</sub> E5 V <sub>DD</sub> E6 V <sub>DDH</sub> E7 D13  E8 V <sub>DDH</sub> E9 V <sub>DD</sub> E10 V <sub>DDH</sub> E11 V <sub>DDH</sub> E12 V <sub>DD</sub> E13 V <sub>DDH</sub>	E1	BTM0 / EE4
E4       V <sub>DDH</sub> E5       V <sub>DD</sub> E6       V <sub>DDH</sub> E7       D13         E8       V <sub>DDH</sub> E9       V <sub>DD</sub> E10       V <sub>DDH</sub> E11       V <sub>DDH</sub> E12       V <sub>DD</sub> E13       V <sub>DDH</sub> E14       D47 / HD15	E2	EE3
E5 V <sub>DD</sub> E6 V <sub>DDH</sub> E7 D13  E8 V <sub>DDH</sub> E9 V <sub>DD</sub> E10 V <sub>DDH</sub> E11 V <sub>DDH</sub> E12 V <sub>DD</sub> E13 V <sub>DDH</sub>	E3	EE2
E6       V <sub>DDH</sub> E7       D13         E8       V <sub>DDH</sub> E9       V <sub>DD</sub> E10       V <sub>DDH</sub> E11       V <sub>DDH</sub> E12       V <sub>DD</sub> E13       V <sub>DDH</sub> E14       D47 / HD15	E4	$V_{DDH}$
E7 D13  E8 V <sub>DDH</sub> E9 V <sub>DD</sub> E10 V <sub>DDH</sub> E11 V <sub>DDH</sub> E12 V <sub>DD</sub> E13 V <sub>DDH</sub> E14 D47 / HD15	E5	$V_{DD}$
E7     D13       E8     V <sub>DDH</sub> E9     V <sub>DD</sub> E10     V <sub>DDH</sub> E11     V <sub>DDH</sub> E12     V <sub>DD</sub> E13     V <sub>DDH</sub> E14     D47 / HD15	E6	$V_{DDH}$
E9 V <sub>DD</sub> E10 V <sub>DDH</sub> E11 V <sub>DDH</sub> E12 V <sub>DD</sub> E13 V <sub>DDH</sub> E14 D47 / HD15	E7	
E9     V <sub>DD</sub> E10     V <sub>DDH</sub> E11     V <sub>DDH</sub> E12     V <sub>DD</sub> E13     V <sub>DDH</sub> E14     D47 / HD15	E8	V <sub>DDH</sub>
E10     V <sub>DDH</sub> E11     V <sub>DDH</sub> E12     V <sub>DD</sub> E13     V <sub>DDH</sub> E14     D47 / HD15	E9	
E11 V <sub>DDH</sub> E12 V <sub>DD</sub> E13 V <sub>DDH</sub> E14 D47 / HD15	E10	
E12 V <sub>DD</sub> E13 V <sub>DDH</sub> E14 D47 / HD15	E11	
E13 V <sub>DDH</sub> E14 D47 / HD15	E12	
E14 D47 / HD15		
E13   ADDH	E15	$V_{DDH}$

Table 3-2. MSC8101 Signal Listing by Pin Designator (Continued)

Number	Signal Name
E16	D56 / HACK / HRRQ
E17	PSDA10 / PGPL0
E18	MODCK1 / TC0 / BNKSEL0
E19	PSDCAS / PGPL3
F1	TDO
F2	EED
F3	BTM1 / EE5
F4	$V_{DD}$
F5	GND
F6	ĪRQ7 / DP7 / DACK4
F7	GND
F8	D18
F9	GND
F10	D28
F11	GND
F12	D38 / HD6
F13	GND
F14	PSDWE / PGPL1
F15	GND
F16	$V_{DD}$
F17	PWE7 / PSDDQM7 / PBS7
F18	MODCK2 / TC1 / BNKSEL1
F19	BCTL0
G1	PA31 / FCC1:UTOPIA8:TXENB / FCC1:MII:COL
G2	TMS
G3	TRST
G4	TCK
G5	$V_{DDH}$
G6	GND
G7	D12
G8	GND
G9	D23
G10	GND
G11	D33 / HD1
G12	GND
G13	PSDVAL
G14	GND
G15	V <sub>DDH</sub>

Table 3-2. MSC8101 Signal Listing by Pin Designator (Continued)

Number   G16   G17   G18	Signal Name  V <sub>DDH</sub>			
G17				
G18	TEA MODOVO (TOO (DNIVOTIO			
	MODCK3 / TC2 / BNKSEL2			
G19	POE / PSDRAS / PGPL2			
H1	PB30 / FCC2:MII:RX_DV / SCC2:TXD / TDBM2:L1RXD			
H2	PD31 / SCC1:RXD / DRACK1 / DONE1			
H3	PC31 / BRG10 / CLK1 / TGATE1			
H4	PB31 / FCC2:MII:TX_ER / SCC2:RXD / TDMB2:L1TXD			
H5	GND			
H6	TDI			
H7	GND			
H13	Reserved / BADDR31 / IRQ5			
H14	Reserved / BADDR30 / IRQ3			
H15	GND			
H16	$V_{DD}$			
H17	BR			
H18	ALE			
H19	PWE4 / PSDDQM4 / PBS4			
J1	PA29 / FCC1:UTOPIA8:TXSOC / FCC1:MII:TX_ER			
J2	PD30 / SCC1:TXD / DMA:DRACK2/DONE2			
J3	PC30 / EXT1 / BRG2O / CLK2 / TOUT1			
J4	V <sub>DD</sub>			
J5	GND			
J6	GND			
J7	PA30 / FCC1:UTOPIA8:TXCLAV / FCC1:UTOPIA8:TXCLAV0 / FCC1:MII:CRS / FCC1:HDLC and transparent: RTS			
J13	TA			
J14	GND			
J15	V <sub>DDH</sub>			
J16	V <sub>DDH</sub>			
J17	PSDAMUX / PGPL5			
J18	PGTA / PUPMWAIT / PPBS / PGPL4			
J19	PWE3 / PSDDQM3 / PBS3			
K1	PA28 / FCC1:UTOPIA8:RXENB / FCC1:MII:TX_EN			
K2	PD29 / FCC1:UTOPIA8:RXADDR3 / FCC1:UTOPIA8:RXCLAV2 / SCC1:RTS/TENA			
К3	PC29 / SCC1:CTS / SCC1:CLSN / BRG3O / CLK3 / TIN2			
K4	PB29 / FCC2:MII:TX_EN / TDMB2:L1RSYNC			

 Table 3-2.
 MSC8101 Signal Listing by Pin Designator (Continued)

Number	Signal Name					
K5	$V_{\mathrm{DDH}}$					
K6	GND					
K7	GND					
K13	GND					
K14	PWE2 / PSDDQM2 / PBS2					
K15	GND					
K16	$V_{\mathrm{DDH}}$					
K17	PWE1 / PSDDQM1 / PBS1					
K18	PWE0 / PSDDQM0 / PBS0					
K19	CS2					
L1	PA27 / FCC1:UTOPIA8:RXSOC / FCC1:MII:RX_DV					
L2	PB28 / FCC2:RX_ER / FCC2:HDLC:RTS / SCC2:RTS/TENA / TDMB2:L1TSYNC					
L3	PC28 / SCC2: CTS/CLSN / BRG4O / CLK4 / TIN1/TOUT2					
L4	$V_{DD}$					
L5	GND					
L6	GND					
L7	PC27 / CLK5 / BRG50 / TGATE2					
L13	CS6					
L14	GND					
L15	GND					
L16	$V_{DD}$					
L17	CS1					
L18	CS3					
L19	BCTL1					
M1	PB27 / FCC2:MII:COL / TDMC2:L1TXD					
M2	PC26 / TMCLK / BRG6O / CLK6 / TOUT3					
М3	PB26 / FCC2:MII:CRS / TDMC2:L1RXD					
M4	$V_{DDH}$					
M5	GND					
M6	PA26 / FCC1:UTOPIA8:RXCLAV / FCC1:UTOPIA8:RXCLAV0 / FCC1:MII:RX_ER					
M7	PA16 / FCC1:UTOPIA8:RXD6 / FCC1:MII and HDLC nibble:RXD1					
M13	A21					
M14	A26					
M15	GND					
M16	CS0					
M17	CS5					
M18	CS7					

Table 3-2. MSC8101 Signal Listing by Pin Designator (Continued)

Number Signal Name						
M19	CS4					
N1	PC25 / DMA:DACK2 / BRG7O / CLK7 / TIN4					
N2	PA25 / FCC1:UTOPIA8:TXD0 / SDMA:MSNUM0					
N3	PB25 / FCC2:MII and HDLC nibble:TXD3 / TDMA1:nibble:L1TXD3 / TDMC2:L1TSYNC					
N4	$V_{DD}$					
N5	PC23 / EXT2 / DMA:DACK1 / CLK9					
N6	GND					
N7	PD17 / FCC1:UTOPIA8:RXPRTY / SPI:SPIMOSI / BRG2O					
N8	CLKIN					
N9	GND					
N10	PC6 / FCC1:UTOPIA8:RXADDR2 / FCC1:UTOPIA8:RXADDR2/RXCLAV1 / FCC1:CD / SI2:LIST2					
N11	TSIZ3					
N12	π1					
N13	тто					
N14	A1					
N15	$V_{DDH}$					
N16	V <sub>DDH</sub>					
N17	A28					
N18	A30					
N19	A31					
P1	PC24 / DMA:DREQ2 / BRG8O / CLK8 / TIN3/TOUT4					
P2	PA24 / FCC1:UTOPIA8:TXD1 / SDMA:MSNUM1					
P3	PB24 / FCC2:MII and HDLC nibble:TXD2 / TDMA1:nibble:L1RXD3 / TDMC2:L1RSYNC					
P4	PA23 / FCC1:UTOPIA8:TXD2					
P5	PB20 / FCC2:MII and HDLC nibble:RXD1 / TDMA1:nibble:L1TXD1 / TDMD2:L1RSYNC					
P6	GND					
P7	GND					
P8	DLLIN					
P9	GND					
P10	PC4 / FCC2: CD / SMC1:SMRXD / SI2:LIST4					
P11	GND					
P12	GND					
P13	GND					
P14	GND					
P15	GND					

Table 3-2. MSC8101 Signal Listing by Pin Designator (Continued)

Number	Signal Name					
P16	$V_{\mathrm{DD}}$					
P17	A23					
P18	A27					
P19	A29					
R1	PC22 / SI1:LIST1 / DREQ1 / CLK10					
R2	SPARE1					
R3	PA22 / FCC1:UTOPIA8:TXD3					
R4	PB18 / FCC2:MII and HDLC nibble:RXD3 / I <sup>2</sup> C:SCL					
R5	PA19 / FCC1:UTOPIA8:TXD6 / FCC1:MII and HDLC nibble:TXD1					
R6	V <sub>DDH</sub>					
R7	$V_{DDH}$					
R8	$V_{DD}$					
R9	V <sub>DDH</sub>					
R10	$V_{DDH}$					
R11	$V_{DD}$					
R12	V <sub>DDH</sub>					
R13	$V_{DD}$					
R14	$V_{DDH}$					
R15	V <sub>DDH</sub>					
R16	A15					
R17	A19					
R18	A24					
R19	A25					
T1	PB21 / FCC2:MII and HDLC nibble:RXD0 / FCC2:transparent and HDLC serial:RXD /TDMA1:nibble:L1TXD2 / TDMD2:L1TSYNC					
T2	PB22 / FCC2:MII and HDLC nibble TXD0 / FCC2:transparent and HDLC serial TXD /TDMA1:nibble L1RXD1 / TDMD2:L1RXD					
Т3	PA20 / FCC1:UTOPIA8 TXD5 / FCC1:MII and HDLC nibble TXD2					
T4	PA17 / FCC1:UTOPIA8 RXD7 / FCC1:MII and HDLC nibble RXD0 / FCC1:transparent and HDLC serial RXD					
T5	PC13 / FCC1:UTOPIA8:TXADDR1 / SCC2:CTS/CLSN / SI1:LIST4					
T6	PC14 / FCC1:UTOPIA8:RXADDR0 / SCC1:CD/RENA / SI1:LIST2					
T7	V <sub>CCSYN1</sub>					
Т8	CLKOUT					
Т9	PA12 / FCC1:UTOPIA8:RXD2 / SDMA:MSNUM3					
T10	PC7 / FCC1:UTOPIA8:TXADDR2 / FCC1:UTOPIA8:TXADDR2/TXCLAV1 / FCC1:CTS / SI1:LIST1					
T11	PA6 / TDMA1:L1RSYNC					

Table 3-2. MSC8101 Signal Listing by Pin Designator (Continued)

Number	Signal Name				
T12	AACK				
T13	TS				
T14	A3				
T15	V <sub>DDH</sub>				
T16	A12				
T17	A16				
T18	A20				
T19	A22				
U1	PA21 / FCC1:TXD4 / FCC1:MII and HDLC nibble TXD3				
U2	PB19 / FCC2:MII and HDLC nibble RXD2 / I <sup>2</sup> C:SDA				
U3	PD18 / FCC1:UTOPIA8:RXADDR4 / FCC1:UTOPIA8:RXCLAV3 / SPI:SPICLK				
U4	PD16 / FCC1:UTOPIA8:TXPRTY / SPI:SPIMISO				
U5	NMI				
U6	RSTCONF				
U7	GND <sub>SYN1</sub>				
U8	PA13 / FCC1:UTOPIA8:RXD3 / SDMA:MSNUM2				
U9	PA10 / FCC1:UTOPIA8:RXD0 / SDMA:MSNUM5				
U10	PA8 / SMC2:SMRXD / TDMA1:serial L1RXD / TDMA1:nibble L1RXD0				
U11	SPARE5				
U12	ARTRY				
U13	TBST				
U14	TT2				
U15	A4				
U16	A8				
U17	A11				
U18	A17				
U19	A18				
V1	PB23 / FCC2:MII and HDLC nibble:TXD1 / TDMA1:nibble:L1RXD2 / TDMD2:L1TXD				
V2	PD19 / FCC1:UTOPIA8:TXADDR4 / FCC1:UTOPIA:TXCLAV3 / SPI:SPISEL / BRG10				
V3	PC15 / FCC1:UTOPIA8:TXADDR0 / SCC1:CTS/CLSN / SMC2:SMTXD				
V4	PC12 / FCC1:UTOPIA8:RXADDR1 / SCC2:CD/RENA / SI1:LIST3				
V5	NMI_OUT				
V6	HRESET				
V7	GND <sub>SYN</sub>				
V8	PA11 / FCC1:UTOPIA8:RXD1 / SDMA:MSNUM4				
V9	PD7 / FCC1:UTOPIA8:TXADDR3 / FCC1:UTOPIA8:TXCLAV2 / SMC1:SMSYN				

Table 3-2. MSC8101 Signal Listing by Pin Designator (Continued)

Number	Signal Name				
V10	PA7 / SMC2: SMSYN / TDMA1:L1TSYNC				
V11	ABB / IRQ2				
V12	BG				
V13	TSIZ0				
V14	TT3				
V15	A2				
V16	A6				
V17	A9				
V18	A13				
V19	A14				
W2	PA18 / FCC1:UTOPIA8:TXD7 / FCC1:MII and HDLC nibble:TXD0 / FCC1:transparent and HDLC serial:TXD				
W3	PA15 / FCC1:UTOPIA8:RXD5 / FCC1:MII and HDLC nibble:RXD2				
W4	SRESET				
W5	PORESET				
W6	TEST				
W7	V <sub>CCSYN</sub>				
W8	PA14 / FCC1:UTOPIA8 RXD4 / FCC1:MII and HDLC nibble:RXD3				
W9	PA9 / SMC2:SMTXD / TDMA1:serial:L1TXD /TDMA1:nibble:L1TXD0				
W10	PC5 / FCC2:CTS / SMC1:SMTXD / SI2:LIST3				
W11	IRQ7 / INT_OUT				
W12	TSIZ2				
W13	TSIZ1				
W14	TT4				
W15	A0				
W16	A5				
W17	A7				
W18	A10				

# 3.3 Lidded FC-PBGA Package Mechanical Drawing

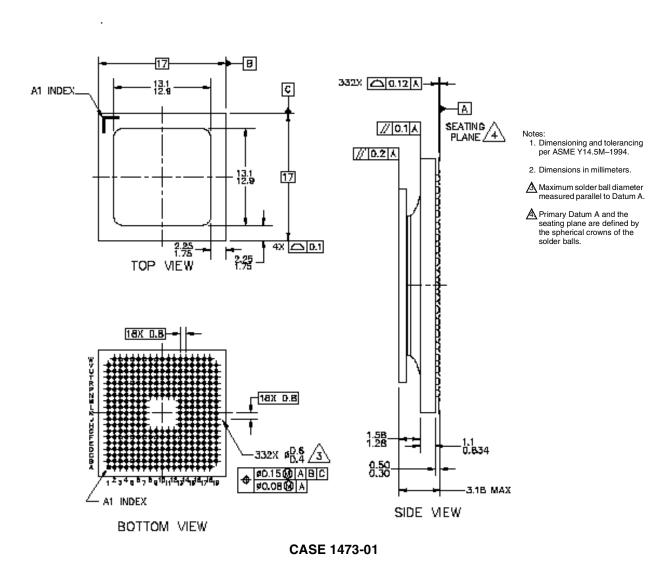


Figure 3-3. Case 1473-01 Mechanical Information, 332-pin Lidded FC-PBGA Package

### Chapter 4

Design Considerations

# 4.1 Thermal Design Considerations

The average chip-junction temperature, T<sub>J</sub>, in °C can be obtained from the following:

Equation 1: 
$$T_J = T_A + (P_D \bullet \theta_{JA})$$

where

 $T_A$  = ambient temperature  $^{\circ}C$ 

 $\theta_{\mathrm{JA}}$  = package thermal resistance, junction to ambient, °C/W

 $P_D = P_{INT} + P_{I/O} in W$ 

 $P_{INT} = I_{DD} \times V_{DD}$  in W—chip internal power

P<sub>I/O</sub> = power dissipation on output pins in W—user determined

The user should set  $T_A$  and  $P_D$  such that  $T_J$  does not exceed the maximum operating conditions. In case  $T_J$  is too high, the user should either lower the ambient temperature or the power dissipation of the chip.

### 4.2 Electrical Design Considerations

The input voltage must not exceed the I/O supply  $V_{DDH}$  by more than 2.5 V at any time, including during power-on reset. In turn,  $V_{DDH}$  can exceed  $V_{DD}/V_{CCSYN}$  by more than 3.3 V during power-on reset, but for no more than 100 ms.  $V_{DDH}$  should not exceed  $V_{DD}/V_{CCSYN}$  by more than 2.1 V during normal operation.  $V_{DD}/V_{CCSYN}$  must not exceed  $V_{DDH}$  by more than 0.4 V at any time, including during power-on reset. Therefore the recommendation is to use "bootstrap" diodes between the power rails, as shown in **Figure 4-1.** 

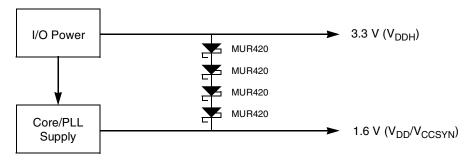


Figure 4-1. Bootstrap Diodes for Power-Up Sequencing

Select the bootstrap diodes such that a nominal  $V_{DD}/V_{CCSYN}$  is sourced from the  $V_{DDH}$  power supply until the  $V_{DD}/V_{CCSYN}$  power supply becomes active. In **Figure 4-1.**, four MUR420 Schottky barrier diodes are connected in series; each has a forward voltage ( $V_F$ ) of 0.6 V at high currents, so these diodes provide a 2.4 V drop, maintaining 0.9 V on the 1.6 V power line. Once the core/PLL power supply stabilizes at 1.6 V, the bootstrap diodes will be reverse biased with negligible leakage current. The  $V_F$  should be effective at the current levels required by the processor. Do not use diodes with a nominal  $V_F$  that drops too low at high current.

### 4.3 Power Considerations

The internal power dissipation consists of three components:

$$P_{INT} = P_{CORE} + P_{SIU} + P_{CPM}$$

Power dissipation depends on the operating frequency of the different portions of the chip. **Table 2-5** provides typical power values at the specified operating frequencies. To determine the typical power dissipation for a given set of frequencies, use the following equations:

$$\begin{split} &P_{CORE}\left(f\right) = ((P_{CORE} - P_{LCO})/f_{CORE}) \times f_{COREA} + P_{LCO} \\ &P_{CPM}\left(f\right) = ((P_{CPM} - P_{LCP})/f_{CPM}) \times f_{CPMA} + P_{LCP} \\ &P_{SIU}\left(f\right) = ((P_{SIU} - P_{LSI})/f_{SIU}) \times f_{SIUA} + P_{LSI} \end{split}$$

- f<sub>CORE</sub> is the core frequency, f<sub>SIU</sub> is the SIU frequency, and f<sub>CPM</sub> is the CPM frequency specified in Table 2-5 in MHz
- f<sub>COREA</sub> is the actual core frequency, F<sub>SIUA</sub> is the actual SIU frequency, and F<sub>CPMA</sub> is the actual CPM frequency in MHz
- P<sub>LCO</sub>, P<sub>LSI</sub>, and P<sub>LCP</sub> are the leakage power values specified in Table 2-5
- All power numbers are in mW
- Power consumption is assumed to be linear with frequency. The first part of each equation computes a mw/MHz value that is then scaled based on the actual frequency used.

To determine a total power dissipation in a specific application, you must add the power values derived from the above set of equations to the value derived for I/O power consumption using the following equation for each output pin:

Equation 2: 
$$P = C \times V_{DDH}^2 \times f \times 10^{-3}$$

Where: P = power in mW, C = load capacitance in pF, f = output switching frequency in MHz.

For an application in which external data memory is used in a 32-bit single bus mode and no other outputs are active, the core runs at 200 MHz, the CPM runs at 100 MHz and the SIU runs at 50 MHz, power dissipation is calculated as follows:

#### Assumptions:

- External data memory is accessed every second cycle with 10% of address pins switching.
- External data memory writes occurs once every eight cycles with 50% of data pins switching.
- Each address and data pin has a 30 pF total load at the pin.
- The application operates at  $V_{DDH} = 3.3 \text{ V}$ .

Since the address pins switch once at every second cycle, the address pins frequency is a quarter of the bus frequency (that is, 25 MHz).

For the same reason the data pins frequency is 3.125 MHz.

Table 4-1. Power Dissipation

Pins	# of pins switching	× C	$\times V_{DDH}^2$	$\times$ f $\times$ 10 <sup>-3</sup>	Power in mW
Address Data, HRD, HRW CLKOUT	4 34 1	× 30 × 30 × 30	×3.3 <sup>2</sup> ×3.3 <sup>2</sup> ×3.3 <sup>2</sup>	$\times$ 12.5 $\times$ 10 <sup>-3</sup> $\times$ 3. 125 $\times$ 10 <sup>-3</sup> $\times$ 50 $\times$ 10 <sup>-3</sup>	16.25 34.75 16
Total P <sub>I/O</sub>					67

Calculating internal power (from **Table 2-5** values):

$$\begin{split} &P_{CORE}\left(200\right) = \left(\left(P_{CORE} - P_{LCO}\right)/300\right) \times 200 + P_{LCO} = \left(\left(450 - 3\right) / 300 \times 200 + 3 = 301\right) \\ &P_{CPM}\left(100\right) = \left(\left(P_{CPM} - P_{LCP}\right) / 200\right) \times 100 + P_{LCP} = \left(\left(320 - 6\right) / 200\right) \times 100 + 6 = 163\\ &P_{SIU}\left(50\right) = \left(\left(P_{SIU} - P_{LSI}\right) / 100\right) \times 50 + P_{LSI} = \left(\left(80 - 2\right) / 100\right) \times 50 + 2 = 41\\ &P_{INT} = P_{CORE}(200) + P_{CPM}(100) + P_{SIU}(50) = 301 + 163 + 41 = 505\\ &P_{D} = P_{INT} + P_{I/O} = 505 + 67 = 572 \end{split}$$

Maximum allowed ambient temperature is:

$$T_A = T_J - (PD \times \theta_{JA})$$

### 4.4 Layout Practices

Each  $V_{CC}$  and  $V_{DD}$  pin on the MSC8101 should be provided with a low-impedance path to the board's power supply. Similarly, each GND pin should be provided with a low-impedance path to ground. The power supply pins drive distinct groups of logic on the chip. The  $V_{CC}$  power supply should be bypassed to ground using at least four 0.1  $\mu$ F by-pass capacitors located as closely as possible to the four sides of the package. The capacitor leads and associated printed circuit traces connecting to chip  $V_{CC}$ ,  $V_{DD}$ , and GND should be kept to less than half an inch per capacitor lead. A four-layer board is recommended, employing two inner layers as  $V_{CC}$  and GND planes.

All output pins on the MSC8101 have fast rise and fall times. Printed circuit board (PCB) trace interconnection length should be minimized in order to minimize undershoot and reflections caused by these fast output switching times. This recommendation particularly applies to the address and data busses. Maximum PCB trace lengths of six inches are recommended. Capacitance calculations should consider all device loads as well as parasitic capacitances due to the PCB traces. Attention to proper PCB layout and bypassing becomes especially critical in systems with higher capacitive loads because these loads create higher transient currents in the  $V_{CC}$ ,  $V_{DD}$ , and GND circuits. Pull up all unused inputs or signals that will be inputs during reset. Special care should be taken to minimize the noise levels on the PLL supply pins.

There are 2 pairs of PLL supply pins:  $V_{CCSYN}$ -GND<sub>SYN</sub> and  $V_{CCSYN1}$ -GND<sub>SYN1</sub>. Each pair supplies one PLL. To ensure internal clock stability, filter the power to the  $V_{CCSYN}$  and  $V_{CCSYN1}$  inputs with a circuit similar to the one in **Figure 4-2.**. To filter as much noise as possible, place the circuit as close as possible to  $V_{CCSYN}$  and  $V_{CCSYN1}$ . The 0.01- $\mu$ F capacitor should be closest to  $V_{CCSYN}$  and  $V_{CCSYN1}$ , followed by the 10- $\mu$ F capacitor, the 10-nH inductor, and finally the 10- $\Omega$  resistor to  $V_{DD}$ . These traces should be kept short and direct.

GND<sub>SYN</sub> and GND<sub>SYN1</sub> should be provided with an extremely low impedance path to ground and should be bypassed to  $V_{CCSYN}$  and  $V_{CCSYN1}$ , respectively, by a 0.01- $\mu$ F capacitor located as close as possible to the chip package. The user should also bypass GND<sub>SYN</sub> and GND<sub>SYN1</sub> to  $V_{CCSYN}$  and  $V_{CCSYN1}$  with a 0.01- $\mu$ F capacitor as closely as possible to the chip package

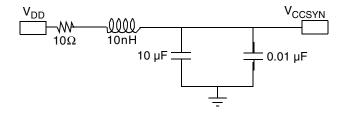


Figure 4-2. VCCSYN and VCCSYN1 Bypass

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### **Ordering Information**

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Part	Supply Voltage	Package Type	Pin Count	Mask Set	Core Frequency (MHz)	Order Number
MSC8101	1.6 V core 3.3 V I/O	Lidded Flip Chip Plastic Ball Grid Array (FC-PBGA)	332	2K87M	250	MSC8101M1250F
	0.0 1 1/0	(I O-FBGA)			275	MSC8101M1375F
					300	MSC8101M1500F

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